

Dec. 11, 2011

This document uses the "old" format of IBIS to combine IBIS 5.0 with the approved BIRDS listed below.

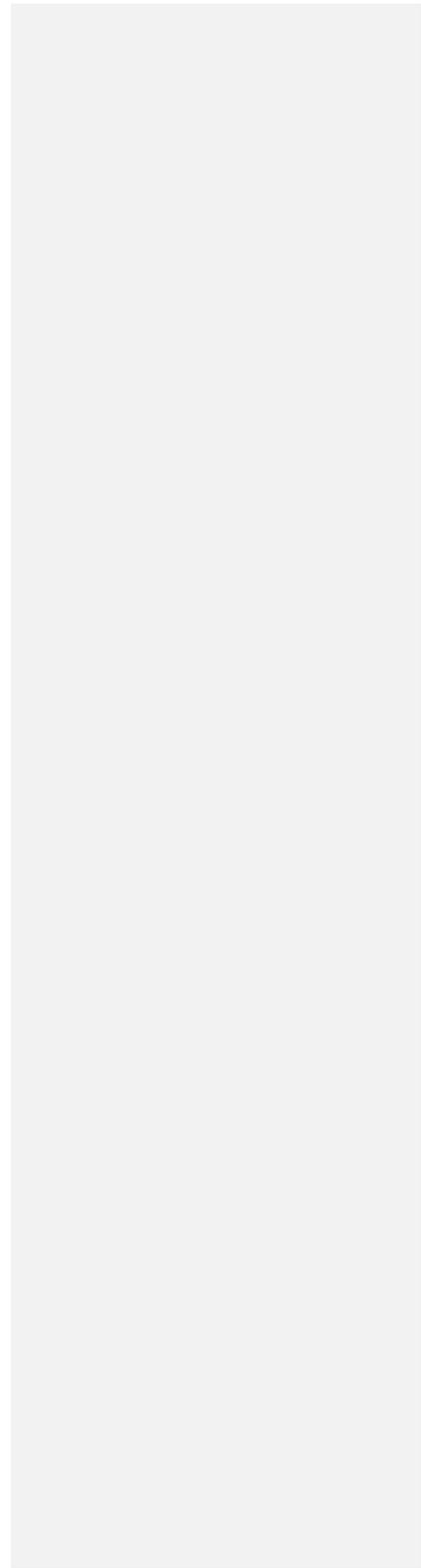
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BIRD112
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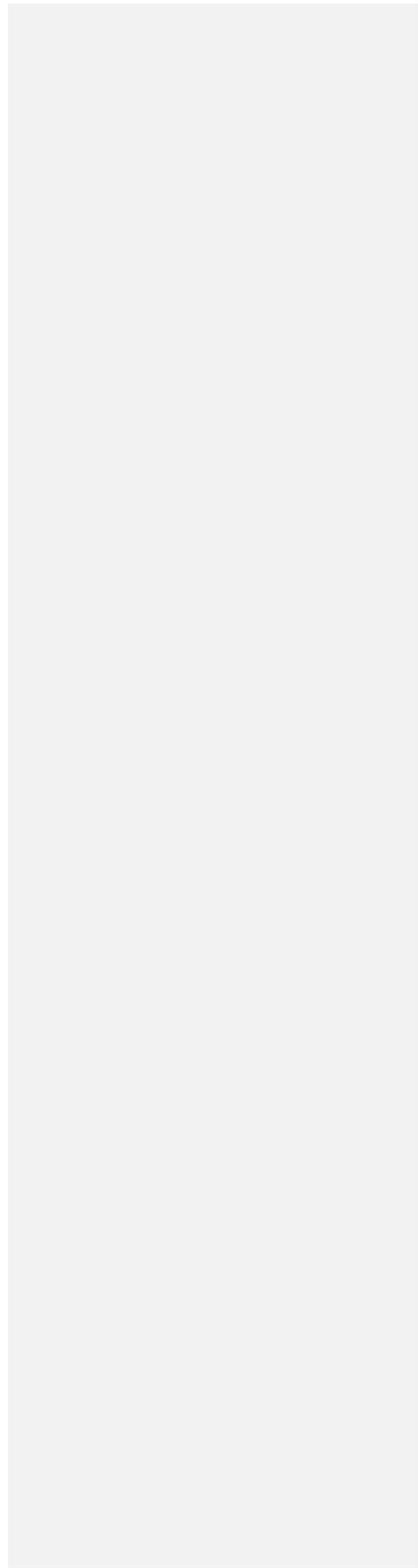
IBIS

(I/O Buffer Information Specification)

Version 5.0

Ratified August 29, 2008





I/O Buffer Information Specification (IBIS) Version 5.0 (August 29, 2008)

IBIS is a standard for electronic behavioral specifications of integrated circuit input/output analog characteristics.

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Section 1

GENERAL INTRODUCTION
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This section gives a general overview of the remainder of this document.

Sections 2 and 3 contain general information about the IBIS versions and the general rules and guidelines. Several progressions of IBIS documents are referenced in Section 2 and in the discussion below. They are IBIS Version 1.1 (ratified August 1993), IBIS Version 2.1 (ratified as ANSI/EIA-656 in December 1995), IBIS Version 3.2 (ratified as ANSI/EIA-656-A in October 1999 and renewed on August 17, 2005), IBIS Version 4.2 (ratified as ANSI/EIA-656-B on March 1, 2007), and IBIS Version 5.0 (ratified on August 29, 2008)

The functionality of IBIS follows in Sections 4 through 8. Sections 4 through 6 describe the format of the core functionality of IBIS Version 1.1 and the extensions in later versions. The data in these sections are contained in .ibs files. Section 7 describes the package model format of IBIS Version 2.1 and a subsequent extension. Package models can be formatted within .ibs files or can be formatted (along with the Section 4 file header keywords) as .pkg files. Section 8 contains the Electrical Board Description format of IBIS Version 3.2. Along with Section 4 header information, electrical board descriptions must be contained in separate .ebd files.

Sections 6c, 10, and 11 are new in IBIS Version 5.0 and contain reference and modeling information related to the algorithmic modeling interface support, and EMI parameters

Section 9 contains some notes regarding the extraction conditions and data requirements for IBIS files. This section focuses on implementation conditions based on measurement or simulation for gathering the IBIS compliant data.

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Section 2

S T A T E M E N T O F I N T E N T
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In order to enable an industry standard method to electronically transport IBIS modeling data between semiconductor vendors, EDA tool vendors, and end customers, this template is proposed. The intention of this template is to specify a consistent format that can be parsed by software, allowing EDA tool vendors to derive models compatible with their own products.

One goal of this template is to represent the current state of IBIS data, while allowing a growth path to more complex models / methods (when deemed appropriate). This would be accomplished by a revision of the base template, and possibly the addition of new keywords or categories.

Another goal of this template is to ensure that it is simple enough for

semiconductor vendors and customers to use and modify, while ensuring that it is rigid enough for EDA tool vendors to write reliable parsers.

Finally, this template is meant to contain a complete description of the I/O elements on an entire component. Consequently, several models will need to be defined in each file, as well as a table that equates the appropriate buffer to the correct pin and signal name.

Version 5.0 of this electronic template was finalized by an industry-wide

group of experts representing various companies and interests. Regular "EIA IBIS Open Forum" meetings were held to accomplish this task.

Commitment to Backward Compatibility. Version 1.0 is the first valid IBIS ASCII file format. It represents the minimum amount of I/O buffer information required to create an accurate IBIS model of common CMOS and bipolar I/O structures. Future revisions of the ASCII file will add items considered to be "enhancements" to Version 1.0 to allow accurate modeling of new, or other I/O buffer structures. Consequently, all future revisions will be considered supersets of Version 1.0, allowing backward compatibility. In addition, as modeling platforms develop support for revisions of the IBIS ASCII template, all previous revisions of the template must also be supported.

Version 1.1 update. The file "ver1_1.ibs" is conceptually the same as the 1.0 version of the IBIS ASCII format (ver1_0.ibs). However, various comments have been added for further clarification.

Version 2.0 update. The file "ver2_0.ibs" maintains backward compatibility with Versions 1.0 and 1.1. All new keywords and elements added in Version 2.0 are optional. A complete list of changes to the specification is in the IBIS Version 2.0 Release Notes document ("ver2_0.rn.txt").

Version 2.1 update. The file "ver2_1.ibs" contains clarification text changes, corrections, and two additional waveform parameters beyond Version 2.0.

Version 3.0 update. The file "ver3_0.ibs" adds a number of new keywords and functionality. A complete list of functions can be found on eda.org under /pub/ibis/birds/birddir.txt showing the approved Buffer Issue Resolution Documents (BIRDS) that have been approved for Version 3.0.

Version 3.1 update. The file "ver3_1.ibs" contains a major reformatting of the document and a simplification of the wording. It also contains some new technical enhancements that were unresolved when Version 3.0 was approved.

Version 3.2 update. The file "ver3_2.ibs" adds more technical advances and also a number of editorial changes documented in 12 BIRDS and also in responses to public letter ballot comments.

Version 4.0 update. This file "ver4_0.ibs" adds more technical advances and a few editorial changes documented in 11 BIRDS.

Version 4.1 update. This file "ver4_1.ibs" adds more technical advances and a few editorial changes documented in 10 BIRDS.

Version 4.2 Update. This file "ver4_2.ibs" adds more technical advances and some editorial changes documented in 13 BIRDS.

Version 5.0 Update. This file "ver5_0.ibs" adds more technical advances and some editorial changes documented in 10 BIRDS.

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Section 3

GENERAL SYNTAX RULES AND GUIDELINES
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This section contains general syntax rules and guidelines for ASCII IBIS files:

- 1) The content of the files is case sensitive, except for reserved words and keywords.
- 2) The following words are reserved words and must not be used for any other purposes in the document:
 - POWER - reserved model name, used with power supply pins,
 - GND - reserved model name, used with ground pins,
 - NC - reserved model name, used with no-connect pins,
 - NA - used where data not available,
 - CIRCUITCALL - used for circuit call references in Section 6b.
- 3) To facilitate portability between operating systems, file names used in the IBIS file must only have lower case characters. File names should have a basename of no more than forty (40) characters followed by a period ('.'), followed by a file name extension of no more than three characters. The file name and extension must use characters from the set (space, ' ', 0x20 is not included):

a b c d e f g h i j k l m n o p q r s t u v w x y z
0 1 2 3 4 5 6 7 8 9 _ ^ \$ ~ ! # % & - { }) (@ ' `

The file name and extension are recommended to be lower case on systems that support such names.

- 4) A line of the file may have at most 120 characters, followed by a line termination sequence. The line termination sequence must be one of the following two sequences: a linefeed character, or a carriage return followed by linefeed character.
- 5) Anything following the comment character is ignored and considered a comment on that line. The default "|" (pipe) character can be changed by the keyword [Comment Char] to any other character. The [Comment Char] keyword can be used anywhere in the file as desired.
- 6) Keywords must be enclosed in square brackets, [], and must start in column 1 of the line. No space or tab is allowed immediately after the opening bracket '[' or immediately before the closing bracket ']'. If used, only one space (' ') or underscore ('_') character separates the parts of a multi-word keyword.
- 7) Underscores and spaces are equivalent in keywords. Spaces are not allowed in subparameter names.

8) Valid scaling factors are:

T = tera	k = kilo	n = nano
G = giga	m = milli	p = pico
M = mega	u = micro	f = femto

When no scaling factors are specified, the appropriate base units are assumed. (These are volts, amperes, ohms, farads, henries, and seconds.) The parser looks at only one alphabetic character after a numerical entry, therefore it is enough to use only the prefixes to scale the parameters. However, for clarity, it is allowed to use full abbreviations for the units, (e.g., pF, nH, mA, mOhm). In addition, scientific notation IS allowed (e.g., 1.2345e-12).

- 9) The I-V data tables should use enough data points around sharply curved areas of the I-V curves to describe the curvature accurately. In linear regions there is no need to define unnecessary data points.
- 10) The use of tab characters is legal, but they should be avoided as much as possible. This is to eliminate possible complications that might arise in situations when tab characters are automatically converted to multiple spaces by text editing, file transferring and similar software. In cases like that, lines might become longer than 120 characters, which is illegal in IBIS files.
- 11) Currents are considered positive when their direction is into the component.
- 12) All temperatures are represented in degrees Celsius.
- 13) Important supplemental information is contained in the last section, "NOTES ON DATA DERIVATION METHOD", concerning how data values are derived.
- 14) Only ASCII characters, as defined in ANSI Standard X3.4-1986, may be used in an IBIS file. The use of characters with codes greater than hexadecimal 07E is not allowed. Also, ASCII control characters (those numerically less than hexadecimal 20) are not allowed, except for tabs or in a line termination sequence. As mentioned in item 10 above, the use of tab characters is discouraged.

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Section 3a
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KEYWORD HIERARCHY
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.ibs FILE

```
-----  
|-- File Header Section  
-----  
|-- [IBIS Ver]  
|-- [Comment Char]  
|-- [File Name]  
|-- [File Rev]  
|-- [Date]  
|-- [Source]  
|-- [Notes]  
|-- [Disclaimer]  
|-- [Copyright]  
  
|-- [Component]                               Si_location, Timing_location  
-----  
|-- [Manufacturer]  
|-- [Package]                               R_pkg, L_pkg, C_pkg  
|-- [Pin]                                   signal_name, model_name, R_pin,  
                                           L_pin, C_pin  
  
|-- [Package Model]  
-----  
|-- [Alternate Package Models]  
-----  
|-- [End Alternate Package Models]  
  
|-- [Pin Mapping]                           pulldown_ref, pullup_ref,  
                                           gnd_clamp_ref, power_clamp_ref,  
                                           ext_ref  
|-- [Diff Pin]                             inv_pin, vdiff, tdelay_typ,  
                                           tdelay_min, tdelay_max  
|-- [Series Pin Mapping]                   pin_2, model_name,  
                                           function_table_group  
|-- [Series Switch Groups]                 On, Off  
  
|-- [Node Declarations]  
-----  
|-- [End Node Declarations]  
  
|-- [Circuit Call]                         Signal_pin, Diff_signal_pins,  
                                           Series_pins, Port_map  
-----  
|-- [End Circuit Call]
```

```

|-- [Begin EMI Component]      Domain, Cpd, C_Heatsink_gnd,
    -----                  C_Heatsink_float
    |-- [Pin EMI]              domain_name, clock_div
    |-- [Pin Domain EMI]      percentage
    |-- [End EMI Component]

-- [Model Selector]

-- [Model]                    Model_type, Polarity, Enable,
    -----                  Vinl, Vinh, C_comp, C_comp_pullup,
                              C_comp_pulldown,
                              C_comp_power_clamp,
                              C_comp_gnd_clamp
                              Vmeas, Cref, Rref, Vref
                              Rref_diff, Cref_diff

    -- [Model Spec]           Vinh, Vinl, Vinh+, Vinh-, Vinl+,
                              Vinl-, S_overshoot_high,
                              S_overshoot_low, D_overshoot_high,
                              D_overshoot_low, D_overshoot_time,
                              D_overshoot_area_h,
                              D_overshoot_area_l,
                              D_overshoot_ampl_h,
                              D_overshoot_ampl_l,
                              Pulse_high, Pulse_low, Pulse_time,
                              Vmeas, Vref, Cref, Rref, Cref_rising,
                              Cref_falling, Rref_rising,
                              Rref_falling, Vref_rising,
                              Vref_falling, Vmeas_rising,
                              Vmeas_falling, Weak_R, Weak_I, Weak_V
                              Rref_diff, Cref_diff

    -- [Receiver Thresholds]  Vth, Vth_min, Vth_max, Vinh_ac,
                              Vinh_dc, Vinl_ac, Vinl_dc,
                              Threshold_sensitivity,
                              Reference_supply, Vcross_low,
                              Vcross_high, Vdiff_ac, Vdiff_dc,
                              Tslew_ac, Tdiffslew_ac

    -- [Add Submodel]
    -- [Driver Schedule]
    -- [Temperature Range]
    -- [Voltage Range]
    -- [Pullup Reference]
    -- [Pulldown Reference]
    -- [POWER Clamp Reference]
    -- [GND Clamp Reference]
    -- [External Reference]
    -- [TTgnd]
    -- [TTpower]
    -- [Pulldown]
    -- [Pullup]
    -- [GND Clamp]
    -- [POWER Clamp]
    -- [ISSO PU]
    -- [ISSO PD]
    -- [Rgnd]
    -- [Rpower]
    -- [Rac]
    -- [Cac]
    -- [On]
    -- [Off]
    -- [R Series]
    -- [L Series]

```



```

-- [Submodel]                               Submodel_type
-----
  -- [Submodel Spec]                       V_trigger_r, V_trigger_f,
                                           Off_delay

  -- [POWER Pulse Table]
  -- [GND Pulse Table]
  -- [Pulldown]
  -- [Pullup]
  -- [GND Clamp]
  -- [POWER Clamp]
  -- [Ramp]                                 dV/dt_r, dV/dt_f, R_load
  -- [Rising Waveform]                     R_fixture, V_fixture,
                                           V_fixture_min, V_fixture_max,
                                           C_fixture, L_fixture, R_dut, L_dut,
                                           C_dut
  -- [Falling Waveform]                   R_fixture, V_fixture,
                                           V_fixture_min, V_fixture_max,
                                           C_fixture, L_fixture, R_dut, L_dut,
                                           C_dut

-- [External Circuit]                       Language, Corner, Parameters,
-----
  | -- [End External Circuit]               Ports, D_to_A, A_to_D

-- [Test Data]                             Test_data_type, Driver_model,
-----
  | -- [Rising Waveform Near]              Driver_model_inv, Test_load
  | -- [Falling Waveform Near]
  | -- [Rising Waveform Far]
  | -- [Falling Waveform Far]
  | -- [Diff Rising Waveform Near]
  | -- [Diff Falling Waveform Near]
  | -- [Diff Rising Waveform Far]
  | -- [Diff Falling Waveform Far]
  | -- [Test Load]                         Test_load_type, C1_near, Rs_near,
  |                                         Ls_near, C2_near, Rpl_near,
  |                                         Rp2_near, Td, Zo, Rpl_far,
  |                                         Rp2_far, C2_far, Ls_far, Rs_far,
  |                                         C1_far, V_term1, V_term2,
  |                                         Receiver_model,
  |                                         Receiver_model_inv, R_diff_near,
  |                                         R_diff_far

-- [Define Package Model]
-----
  | -- [Manufacturer]
  | -- [OEM]
  | -- [Description]
  | -- [Number Of Sections]
  | -- [Number Of Pins]
  | -- [Pin Numbers]                       Len, L, R, C, Fork, Endfork
  | -- [Model Data]
  | -----
  | | -- [Resistance Matrix]               Banded_matrix, Sparse_matrix,
  | |                                     Full_matrix
  | | -----
  | | | -- [Bandwidth]
  | | | -- [Row]
  | | -----
  | | -- [Inductance Matrix]              Banded_matrix, Sparse_matrix,
  | |                                     Full_matrix
  | | -----
  | | | -- [Bandwidth]
  | | | -- [Row]

```



```

.pkg FILE
-----
|-- File Header Section
-----
|-- [IBIS Ver]
|-- [Comment Char]
|-- [File Name]
|-- [File Rev]
|-- [Date]
|-- [Source]
|-- [Notes]
|-- [Disclaimer]
|-- [Copyright]

|-- [Define Package Model]
-----
|-- [Manufacturer]
|-- [OEM]
|-- [Description]
|-- [Number Of Sections]
|-- [Number Of Pins]
|-- [Pin Numbers]           Len, L, R, C, Fork, Endfork
|-- [Model Data]
-----
|-- [Resistance Matrix]     Banded_matrix, Sparse_matrix,
    -----                Full_matrix
    |-- [Bandwidth]
    |-- [Row]

|-- [Inductance Matrix]     Banded_matrix, Sparse_matrix,
    -----                Full_matrix
    |-- [Bandwidth]
    |-- [Row]

|-- [Capacitance Matrix]    Banded_matrix, Sparse_matrix,
    -----                Full_matrix
    |-- [Bandwidth]
    |-- [Row]

|-- [End Model Data]

|-- [End Package Model]

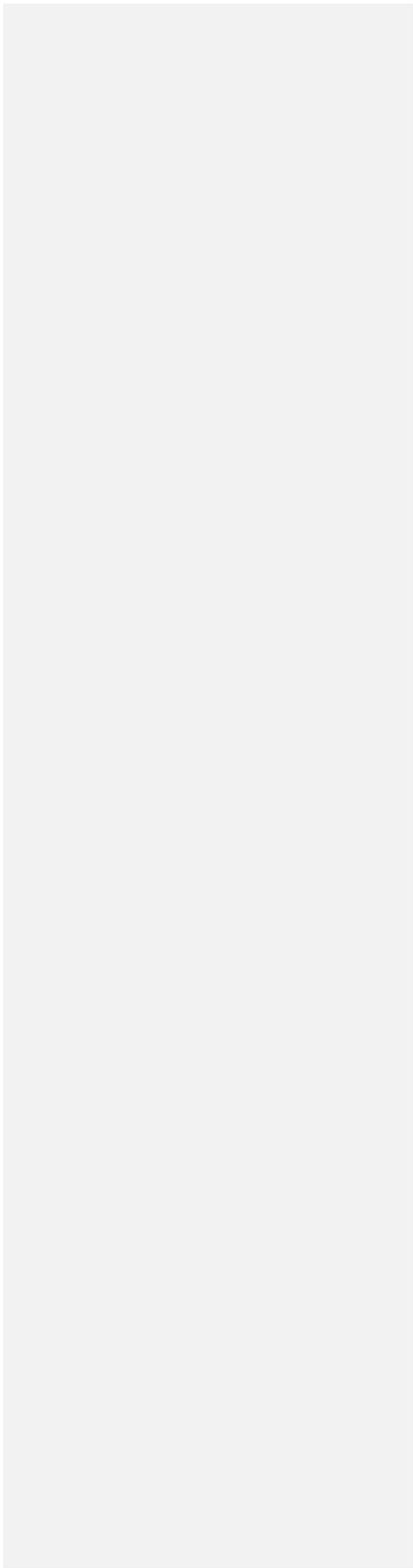
|-- [End]

```

```

| .ebd FILE
|-----
|  -- File Header Section
|  -----
|  |  -- [IBIS Ver]
|  |  -- [Comment Char]
|  |  -- [File Name]
|  |  -- [File Rev]
|  |  -- [Date]
|  |  -- [Source]
|  |  -- [Notes]
|  |  -- [Disclaimer]
|  |  -- [Copyright]
|  |
|  |  -- [Begin Board Description]
|  |  -----
|  |  |  -- [Manufacturer]
|  |  |  -- [Number of Pins]
|  |  |  -- [Pin List]
|  |  |  -- [Path Description]
|  |  |  -- [Reference Designator Map]
|  |  |  -- [End Board Description]
|  |
|  |  signal_name
|  |  Len, L, R, C, Fork, Endfork, Pin,
|  |  Node
|  |
|  |  -- [End]
|  -----
|  =====
|  =====

```



=====
=====
Section 4

FILE HEADER INFORMATION
=====

Keyword: [IBIS Ver]

Required: Yes

Description: Specifies the IBIS template version. This keyword informs electronic parsers of the kinds of data types that are present in the file.

Usage Rules: [IBIS Ver] must be the first keyword in any IBIS file. It is normally on the first line of the file, but can be preceded by comment lines that must begin with a "|".

[IBIS Ver] 5.0 | Used for template variations
=====

Keyword: [Comment Char]

Required: No

Description: Defines a new comment character to replace the default "|" (pipe) character, if desired.

Usage Rules: The new comment character to be defined must be followed by the underscore character and the letters "char". For example: "|_char" redundantly redefines the comment character to be the pipe character. The new comment character is in effect only following the [Comment Char] keyword. The following characters MAY be used:

! " # \$ % & ' () * , : ; < > ? @ \ ^ ` { | } ~

Other Notes: The [Comment Char] keyword can be used anywhere in the file, as desired.

[Comment Char] |_char
=====

Keyword: [File Name]

Required: Yes

Description: Specifies the name of the IBIS file.

Usage Rules: The file name must conform to the rules in paragraph 3 of Section 3, GENERAL SYNTAX RULES AND GUIDELINES. In addition, the file name must use the extension ".ibs", ".pkg", or ".ebd". The file name must be the actual name of the file.

[File Name] ver5_0.ibs
=====

```

=====
Keyword: [File Rev]
Required: Yes
Description: Tracks the revision level of a particular .ibs file.
Usage Rules: Revision level is set at the discretion of the engineer
              defining the file. The following guidelines are recommended:
              0.x    silicon and file in development
              1.x    pre-silicon file data from silicon model only
              2.x    file correlated to actual silicon measurements
              3.x    mature product, no more changes likely
=====
[File Rev]    1.0                | Used for .ibs file variations
=====
Keywords: [Date], [Source], [Notes], [Disclaimer], [Copyright]
Required: No
Description: Optionally clarifies the file.
Usage Rules: The keyword arguments can contain blanks, and be of any
              format. The [Date] keyword argument is limited to a maximum
              of 40 characters, and the month should be spelled out for
              clarity.

              Because IBIS model writers may consider the information in
              these keywords essential to users, and sometimes legally
              required, design automation tools should make this information
              available. Derivative models should include this text
              verbatim. Any text following the [Copyright] keyword must be
              included in any derivative models verbatim.
=====
[Date]        August 29, 2008    | The latest file revision date
[Source]      Put originator and the source of information here. For
              example:

              From silicon level SPICE model at Intel.
              From lab measurement at IEI.
              Compiled from manufacturer's data book at Quad Design, etc.
[Notes]      Use this section for any special notes related to the file.
[Disclaimer]  This information is for modeling purposes only, and is not
              guaranteed.          | May vary by component
[Copyright]  Copyright 2008, XYZ Corp., All Rights Reserved
=====
=====

```

Section 5

COMPONENT DESCRIPTION

Keyword: [Component]

Required: Yes

Description: Marks the beginning of the IBIS description of the integrated circuit named after the keyword.

Sub-Params: Si_location, Timing_location

Usage Rules: If the .ibs file contains data for more than one component, each section must begin with a new [Component] keyword. The length of the component name must not exceed 40 characters, and blank characters are allowed.

NOTE: Blank characters are not recommended due to usability issues.

Si_location and Timing_location are optional and specify where the Signal Integrity and Timing measurements are made for the component. Allowed values for either subparameter are 'Die' or 'Pin'. The default location is at the 'Pin'.

[Component] 7403398 MC452

Si_location Pin | Optional subparameters to give measurement
Timing_location Die | location positions

Keyword: [Manufacturer]

Required: Yes

Description: Specifies the name of the component's manufacturer.

Usage Rules: The length of the manufacturer's name must not exceed 40 characters (blank characters are allowed, e.g., Texas Instruments). In addition, each manufacturer must use a consistent name in all .ibs files.

[Manufacturer] Intel Corp.

Keyword: [Package]

Required: Yes

Description: Defines a range of values for the default packaging resistance, inductance, and capacitance of the component pins.

Sub-Params: R_pkg, L_pkg, C_pkg

Usage Rules: The typical (typ) column must be specified. If data for the other columns are not available, they must be noted with "NA".

Other Notes: If RLC parameters are available for individual pins, they can be listed in columns 4-6 under keyword [Pin]. The values listed in the [Pin] description section override the default values defined here. Use the [Package Model] keyword for more complex package descriptions. If defined, the [Package Model] data overrides the values in the [Package] keyword. Regardless, the data listed under the [Package] keyword must still contain valid data.

[Package]
| variable typ min max

```

R_pkg      250.0m      225.0m      275.0m
L_pkg      15.0nH        12.0nH        18.0nH
C_pkg      18.0pF        15.0pF        20.0pF

```

```
=====
```

Keyword: [Pin]

Required: Yes

Description: Associates the component's I/O models to its various external pin names and signal names.

Sub-Params: signal_name, model_name, R_pin, L_pin, C_pin

Usage Rules: All pins on a component must be specified. The first column must contain the pin name. The second column, signal_name, gives the data book name for the signal on that pin. The third column, model_name, maps a pin to a specific I/O buffer model or model selector name. Each model_name must have a corresponding model or model selector name listed in a [Model] or [Model Selector] keyword below, unless it is a reserved model name (POWER, GND, or NC).

The model_name column cannot be used for model or model selector names that reference Series and Series_switch models.

Each line must contain either three or six columns. A pin line with three columns only associates the pin's signal and model. Six columns can be used to override the default package values (specified under [Package]) FOR THAT PIN ONLY. When using six columns, the headers R_pin, L_pin, and C_pin must be listed. If "NA" is in columns 4 through 6, the default packaging values must be used. The headers R_pin, L_pin, and C_pin may be listed in any order.

Column length limits are:

```

[Pin]      5 characters max
model_name 40 characters max
signal_name 40 characters max
R_pin      9 characters max
L_pin      9 characters max
C_pin      9 characters max

```

```
-----
```

[Pin]	signal_name	model_name	R_pin	L_pin	C_pin
1	RAS0#	Buffer1	200.0m	5.0nH	2.0pF
2	RAS1#	Buffer2	209.0m	NA	2.5pF
3	EN1#	Input1	NA	6.3nH	NA
4	A0	3-state			
5	D0	I/O1			
6	RD#	Input2	310.0m	3.0nH	2.0pF
7	WR#	Input2			
8	A1	I/O2			
9	D1	I/O2			
10	GND	GND	297.0m	6.7nH	3.4pF
11	RDY#	Input2			
12	GND	GND	270.0m	5.3nH	4.0pF
.					
.					
.					
18	Vcc3	POWER			
19	NC	NC			
20	Vcc5	POWER	226.0m	NA	1.0pF
21	BAD1	Series_switch1			Illegal assignment
22	BAD2	Series_selector1			Illegal assignment

```

=====
Keyword: [Package Model]
Required: No
Description: Indicates the name of the package model to be used for the
component.
Usage Rules: The package model name is limited to 40 characters. Spaces
are allowed in the name. The name should include the company
name or initials to help ensure uniqueness. The EDA tool
will search for a matching package model name as an argument
to a [Define Package Model] keyword in the current IBIS file
first. If a match is not found, the EDA tool will next look
for a match in an external .pkg file. If the matching package
model is in an external .pkg file, it must be located in the
same directory as the .ibs file. The file names of .pkg files
must follow the rules for file names given in Section 3,
GENERAL SYNTAX RULES AND GUIDELINES.
Other Notes: Use the [Package Model] keyword within a [Component] to
indicate which package model should be used for that
component. The specification permits .ibs files to contain
[Define Package Model] keywords as well. These are described
in the "Package Modeling" section near the end of this
specification. When package model definitions occur within a
.ibs file, their scope is "local", i.e., they are known only
within that .ibs file and no other. In addition, within that
.ibs file, they override any globally defined package models
that have the same name.
=====

```

```

[Package Model]    QS-SMT-cer-8-pin-pkgs
=====

```

```

=====
Keywords: [Alternate Package Models], [End Alternate Package Models]
Required: No
Description: Used to select a package model from a list of package models.
Usage Rules: The [Alternate Package Models] keyword can be used in addition
to the [Package Model] keyword. [Alternate Package Models]
shall be used only for components that use the [Package Model]
keyword.

Each [Alternate Package Models] keyword specifies a set of
alternate package model names for only one component, which
is given by the previous [Component] keyword. The [Alternate
Package Models] keyword shall not appear before the first
[Component] keyword in an IBIS file. The [Alternate Package
Models] keyword applies only to the [Component] section in
which it appears, and must be followed by an [End Alternate
Package Models] keyword.

All alternate package model names must appear below the
[Alternate Package Models] keyword, and above the following
[End Alternate Package Models] keyword. The package model
names listed under the [Alternate Package Models] must follow
the rules of the package model names associated with the
[Package Model] keyword. The package model names correspond
to the names of package models defined by [Define Package
Model] keywords. EDA tools may offer users a facility
for choosing between the default package model and any of the
alternate package models, when analyzing occurrences of the
[Component].

The package model named by [Package Model] can be optionally
repeated in the [Alternate Package Models] list of names.
=====

```

[Alternate Package Models]

208-pin_plastic_PQFP_package-even_mode | Descriptive names are shown
208-pin_plastic_PQFP_package-odd_mode
208-pin_ceramic_PQFP_package-even_mode
208-pin_ceramic_PQFP_package-odd_mode

[End Alternate Package Models]

=====
Keyword: [Pin Mapping]
Required: No
Description: Used to indicate the power and/or ground buses to which a given driver, receiver or terminator is connected.
Sub-Params: pulldown_ref, pullup_ref, gnd_clamp_ref, power_clamp_ref, ext_ref
Usage Rules: The [Pin Mapping] keyword names the connections between POWER and/or GND pins and buffer and/or terminator voltage supply references using unique bus labels. All buses with identical labels are assumed to be connected with an ideal short. Each label must be associated with at least one pin whose model_name is POWER or GND. Bus labels must not exceed 15 characters.

Each line must contain either three, five or six entries. Use the reserved word NC where an entry is required but a bus connection is not made (see below).

The first column contains a pin name. Each pin name must match one of the pin names declared in the [Pin] section of the [Component].

For buffers and terminators, the remaining columns correspond to the voltage supply references for the named pin. Each [Model] supply reference is connected to a particular bus through a bus label in the corresponding column.

The second column, pulldown_ref, designates the ground bus connections for the buffer or termination associated with that pin. The bus named under pulldown_ref is associated with the [Pulldown] I-V table for non-ECL [Model]s. This is also the bus associated with the [GND Clamp] I-V table and the [Rgnd] model unless overridden by a label in the gnd_clamp_ref column.

The third column, pullup_ref, designates the power bus connection for the buffer or termination. The bus named under pullup_ref is associated with the [Pullup] table for non-ECL [Model]s (for ECL models, this bus is associated with the [Pulldown] table). This is also the bus label associated with the [POWER Clamp] I-V table and the [Rpower] model unless overridden by a label in the power_clamp_ref column.

The fourth and fifth columns, gnd_clamp_ref and power_clamp_ref, contain entries, if needed, to specify additional ground bus and power bus connections for clamps. Finally, the sixth column, ext_ref, contains entries to specify external reference supply bus connections.

The usage of the columns changes for GND and POWER pins. For GND pins, the pulldown_ref column contains the name of the bus

to which the pin connects; the pullup_ref column in this case must contain the reserved word NC. Similarly, for POWER (including external reference) pins, the pullup_ref column contains the name of the bus to which the pin connects; the pulldown_ref column in this case must contain the reserved word NC.

If the [Pin Mapping] keyword is present, then the bus connections for EVERY pin listed under the [Pin] keyword must be given.

If a pin has no connection, then both the pulldown_ref and pullup_ref subparameters for it will be NC.

The column length limits are:

[Pin Mapping]	5 characters max
pulldown_ref	15 characters max
pullup_ref	15 characters max
gnd_clamp_ref	15 characters max
power_clamp_ref	15 characters max
ext_ref	15 characters max

For compatibility with models developed under previous IBIS versions, [Pin Mapping] lines which contain ext_ref column entries must also explicitly include entries for the pulldown_ref, pullup_ref, gnd_clamp_ref and power_clamp_ref columns. These entries can be NC, as explained above.

When six columns of data are specified, the headings gnd_clamp_ref, power_clamp_ref and ext_ref must be used on the line containing the [Pin Mapping] keyword. Otherwise, these headings can be omitted.

[Pin Mapping]	pulldown_ref	pullup_ref	gnd_clamp_ref	power_clamp_ref	ext_ref
1	GNDBUS1	PWRBUS1			
2	GNDBUS2	PWRBUS2			
3	GNDBUS1	PWRBUS1	GNDCOMP	PWRCLAMP	
4	GNDBUS2	PWRBUS2	GNDCOMP	PWRCLAMP	
5	GNDBUS2	PWRBUS2	NC	PWRCLAMP	REFBUS1
6	GNDBUS2	PWRBUS2	GNDCOMP	NC	
7	GNDBUS2	PWRBUS2	GNDCOMP	NC	REFBUS2
Some possible clamping connections are shown above for illustration purposes					
11	GNDBUS1	NC			
12	GNDBUS1	NC			
13	GNDBUS1	NC			
21	GNDBUS2	NC			
22	GNDBUS2	NC			
23	GNDBUS2	NC			
31	NC	PWRBUS1			
32	NC	PWRBUS1			
33	NC	PWRBUS1			
41	NC	PWRBUS2			
42	NC	PWRBUS2			
43	NC	PWRBUS2			
51	GNDCOMP	NC			
52	NC	PWRCLAMP			
71	NC	REFBUS1			
72	NC	REFBUS2			

The following [Pin] list corresponds to the [Pin Mapping] shown above.

[Pin]	signal_name	model_name	R_pin	L_pin	C_pin
1	OUT1	output_buffer1			
2	OUT2	output_buffer2			
3	IO3	io_buffer1			
4	IO4	io_buffer2			
5	SPECIAL1	ref_buffer1			
6	SPECIAL2	io_buffer_term1			
7	SPECIAL3	ref_buffer2			
11	VSS1	GND			
12	VSS1	GND			
13	VSS1	GND			
21	VSS2	GND			
22	VSS2	GND			
23	VSS2	GND			
31	VCC1	POWER			
32	VCC1	POWER			
33	VCC1	POWER			
41	VCC2	POWER			
42	VCC2	POWER			
43	VCC2	POWER			
51	VSSCLAMP	GND			
52	VCCCLAMP	POWER			

```

71 V_EXTREF1 POWER | External reference voltage pins
72 V_EXTREF2 POWER |

```

```

=====
Keyword: [Diff Pin]
Required: No
Description: Associates differential pins and defines their differential
receiver threshold voltage and differential driver timing
delays.
Sub-Params: inv_pin, vdiff, tdelay_typ, tdelay_min, tdelay_max
Usage Rules: Enter only differential pin pairs. The first column, [Diff
Pin], contains a non-inverting pin name. The second column,
inv_pin, contains the corresponding inverting pin name for
I/O output. Each pin name must match the pin names declared
previously in the [Pin] section of the IBIS file. The third
column, vdiff, contains the specified differential receiver
threshold voltage between the inverting and non-inverting
pins for Input or I/O model types. The fourth, fifth, and
sixth columns, tdelay_typ, tdelay_min, and tdelay_max,
contain launch delays of the non-inverting pins relative to
the inverting pins. All of the numerical entries may be a
positive, zero, or negative number.

For differential Input or I/O model types, the differential
input threshold (vdiff) overrides and supersedes the need
for Vinh and Vinl.

Other Notes: The output pin polarity specification in the table overrides
the [Model] Polarity specification such that the pin in the
[Diff Pin] column is Non-Inverting and the pin in the inv_pin
column is Inverting. This convention enables one [Model] to
be used for both pins.

The column length limits are:
[Diff Pin] 5 characters max
inv_pin 5 characters max
vdiff 9 characters max
tdelay_typ 9 characters max
tdelay_min 9 characters max
tdelay_max 9 characters max

Each line must contain either four or six columns. Using
four columns is an equivalent of entering "NA"s in the fifth
and sixth columns. An "NA" in the vdiff column will be
interpreted as a 200 mV default differential receiver
threshold. "NA"s in the tdelay_typ, or tdelay_min columns
are interpreted as 0 ns. If "NA" appears in the
tdelay_max column, its value is interpreted as the tdelay_typ
value. When using six columns, the headers tdelay_min and
tdelay_max must be listed. Entries for the tdelay_min column
are based on minimum magnitudes; and tdelay_max column,
maximum magnitudes. One entry of vdiff, regardless of its
polarity, is used for difference magnitudes.

The positioning of numerical entries and/or "NA" must not be
used as an indication for the model type. The model type is
determined by the model type parameter inside the [Model]s
referenced by the [Diff Pin] keyword, regardless of what the
[Diff Pin]'s entries are. The simulator may ignore the
vdiff or the tdelay_*** parameters if not needed by the
model type of the [Model], or use the default values defined
above if they are needed but not provided in the [Diff Pin]

```

keyword. For example, an "NA" in the third column (vdiff) does not imply that the model type is Output, or three "NA"-s in the tdelay columns does not mean that the model type is Input.

Note that the starting point of the flight time measurements will occur when the differential driver's output waveforms are crossing, i.e. when the differential output voltage is zero, and consequently Vmeas, if defined will be ignored.

```
-----
[Diff Pin] inv_pin vdiff tdelay_typ tdelay_min tdelay_max
3          4          150mV  -1ns      0ns      -2ns
| For Input,  tdelay_typ/min/max ignored
| For Output, vdiff ignored
7          8           0V     1ns      NA       NA
16         15         200mV  1ns
| For Input,  tdelay_typ ignored
| For Output, vdiff ignored and tdelay_min = 0ns and tdelay_max = 1ns
| For I/O,    tdelay_min = 0ns and tdelay_max = 1ns
9          10         NA      NA      NA      NA
22         21         NA      NA
| For Input,  vdiff = 200 mV
| For Output, tdelay_typ/min/max = 0ns
| For I/O,    vdiff = 200 mV and tdelay_typ/min/max = 0ns
20         19         0V     NA
| For Output, vdiff ignored and tdelay_typ/min/max = 0ns
| For I/O,    tdelay_typ/min/max = 0ns
-----
```

Keyword: [Series Pin Mapping]

Required: No
Description: Used to associate two pins joined by a series model.
Sub-Params: pin_2, model_name, function_table_group
Usage Rules: Enter only series pin pairs. The first column, [Series Pin Mapping], contains the series pin for which input impedances are measured. The second column, pin_2, contains the other connection of the series model. Each pin must match the pin names declared previously in the [Pin] section of the IBIS file. The third column, model_name, associates models of type Series or Series_switch, or model selectors containing references to models of type Series or Series_switch for the pair of pins in the first two columns. Each model_name must have a corresponding model or model selector name listed in a [Model] or [Model Selector] keyword below. The usage of reserved model names (POWER, GND, or NC) within the [Series Pin Mapping] keyword is not allowed. The fourth column, function_table_group, contains an alphanumeric designator string to associate those sets of Series_switch pins that are switched together.

Each line must contain either three or four columns. When using four columns, the header function_table_group must be listed.

One possible application is to model crossbar switches where the straight through On paths are indicated by one designator and the cross over On paths are indicated by

another designator. If the model referenced is a Series model, then the function_table_group entry is omitted.

The column length limits are:

[Series Pin Mapping]	5 characters max
pin_2	5 characters max
model_name	40 characters max
function_table_group	20 characters max

Other Notes: If the model_name is for a non-symmetrical series model, then the order of the pins is important. The [Series Pin Mapping] and pin_2 entries must be in the columns that correspond with Pin 1 and Pin 2 of the referenced model.

This mapping covers only the series paths between pins. The package parasitics and any other elements such as additional capacitance or clamping circuitry are defined by the model_name that is referenced in the [Pin] keyword. The model_names under the [Pin] keyword that are also referenced by the [Series Pin Mapping] keyword may include any legal model or reserved model except for Series and Series_switch models. Normally the pins will reference a [Model] whose Model_type is 'Terminator'. For example, a Series_switch model may contain Terminator models on EACH of the pins to describe both the capacitance on each pin and some clamping circuitry that may exist on each pin. In a similar manner, Input, I/O or Output models may exist on each pin of a Series model that is serving as a differential termination.

Also, a pin name may appear on more than one entry under the [Series Pin Mapping] keyword. This allows for multiple and perhaps different models or model selectors to be placed between the same, or any arbitrary pin pair combinations.

[Series Pin Mapping]	pin_2	model_name	function_table_group
2	3	CBTSeries	1 Four independent groups
5	6	CBTSeries	2
9	8	CBTSeries	3
12	11	CBTSeries	4
22	23	CBTSeries	5 Straight through path
25	26	CBTSeries	5
22	26	CBTSeries	6 Cross over path
25	23	CBTSeries	6
32	33	Fixed_series	No group needed

```

=====
Keyword: [Series Switch Groups]
Required: Yes, if function_table_group column data is present under
[Series Pin Mapping]
Description: Used to define allowable switching combinations of series
switches described using the names of the groups in the
[Series Pin Mapping] keyword function_table_group column.
Sub-Params: On, Off
Usage Rules: Each state line contains an allowable configuration. A
typical state line will start with 'On' followed by all of the
on-state group names or an 'Off' followed by all of the
off-state group names. Only one of 'On' or 'Off' is required
since the undefined states are presumed to be opposite of the
explicitly defined states. The state line is terminated with
the slash '/', even if it extends over several lines to fit
within the 120 character column width restriction.

The group names in the function_table_group are used to
associate switches whose switching action is synchronized by
a common control function. The first line defines the assumed
(default) state of the set of series switches. Other sets of
states are listed and can be selected through a user interface
or through automatic control.
=====

```

```

[Series Switch Groups]
| Function Group States
On 1 2 3 4 / | Default setting is all switched On
|
Off 1 2 3 4 / | All Off setting
On 1 / | Other possible combinations below
On 2 /
On 3 /
On 4 /
On 1 2 /
On 1 3 /
On 1 4 /
On 2 3 /
On 2 4 /
On 3 4 /
On 1 2 3 /
On 1 2 4 /
On 1 3 4 /
On 2 3 4 /
| Off 4 / | The last four lines above could have been replaced
| Off 3 / | with these four lines with the same meaning.
| Off 2 /
| Off 1 /

```

```
On 5 /           | Crossbar switch straight through connection
On 6 /           | Crossbar cross over connection
Off 5 6 /        | Crossbar open switches
```

```
=====
Keyword: [Model Selector]
Required: No
Description: Used to pick a [Model] from a list of [Model]s for a pin which
                uses a programmable buffer.
Usage Rules: A programmable buffer must have an individual [Model] section
```

for each one of its modes used in the .ibs file. The names of these [Model]s must be unique and can be listed under the [Model Selector] keyword and/or pin list. The name of the [Model Selector] keyword must match the corresponding model name listed under the [Pin] or [Series Pin Mapping] keyword and must not contain more than 40 characters. A .ibs file must contain enough [Model Selector] keywords to cover all of the model selector names specified under the [Pin] and [Series Pin Mapping] keywords.

The section under the [Model Selector] keyword must have two fields. The two fields must be separated by at least one white space. The first field lists the [Model] name (up to 40 characters long). The second field contains a short description of the [Model] shown in the first field. The contents and format of this description is not standardized, however it shall be limited in length so that none of the descriptions exceed the 120-character length of the line that it started on. The purpose of the descriptions is to aid the user of the EDA tool in making intelligent buffer mode selections and it can be used by the EDA tool in a user interface dialog box as the basis of an interactive buffer selection mechanism.

The first entry under the [Model Selector] keyword shall be considered the default by the EDA tool for all those pins which call this [Model Selector].

The operation of this selection mechanism implies that a group of pins which use the same programmable buffer (i.e., model selector name) will be switched together from one [Model] to another. Therefore, if two groups of pins, for example an address bus and a data bus, use the same programmable buffer, and the user must have the capability to configure them independently, one can use two [Model Selector] keywords with unique names and the same list of [Model] keywords; however, the usage of the [Model Selector] is not limited to these examples. Many other combinations are possible.

```

[Pin]   signal_name   model_name   R_pin   L_pin   C_pin
|
| 1   RAS0#           Progbuffer1  200.0m  5.0nH  2.0pF
| 2   EN1#           Input1      NA       6.3nH  NA
| 3   A0             3-state
| 4   D0             Progbuffer2
| 5   D1             Progbuffer2  320.0m  3.1nH  2.2pF
| 6   D2             Progbuffer2
| 7   RD#           Input2      310.0m  3.0nH  2.0pF
|
| .
| .
| .
| 18  Vcc3           POWER
|
[Model Selector]   Progbuffer1
|
OUT_2      2 mA buffer without slew rate control
OUT_4      4 mA buffer without slew rate control
OUT_6      6 mA buffer without slew rate control
OUT_4S     4 mA buffer with slew rate control
OUT_6S     6 mA buffer with slew rate control
|
[Model Selector]   Progbuffer2
|
OUT_2      2 mA buffer without slew rate control
OUT_6      6 mA buffer without slew rate control
OUT_6S     6 mA buffer with slew rate control
OUT_8S     8 mA buffer with slew rate control
OUT_10S    10 mA buffer with slew rate control
|
=====
|=====

```

=====
=====
Section 6

MODEL STATEMENT
=====

Keyword: [Model]
Required: Yes
Description: Used to define a model, and its attributes.
Sub-Params: Model_type, Polarity, Enable, Vinl, Vinh, C_comp, C_comp_pullup, C_comp_pulldown, C_comp_power_clamp, C_comp_gnd_clamp, Vmeas, Cref, Rref, Vref
Usage Rules: Each model type must begin with the keyword [Model]. The model name must match the one that is listed under a [Pin], [Model Selector] or [Series Pin Mapping] keyword and must not contain more than 40 characters. A .libs file must contain enough [Model] keywords to cover all of the model names specified under the [Pin], [Model Selector] and [Series Pin Mapping] keywords, except for those model names that use reserved words (POWER, GND and NC).

Model_type must be one of the following:

Input, Output, I/O, 3-state, Open_drain, I/O_open_drain, Open_sink, I/O_open_sink, Open_source, I/O_open_source, Input_ECL, Output_ECL, I/O_ECL, 3-state_ECL, Terminator, Series, and Series_switch.

For true differential models documented under Section 6b, Model_type must be one of the following:

Input_diff, Output_diff, I/O_diff, and 3-state_diff

Special usage rules apply to the following. Some definitions are included for clarification:

Input I/O I/O_open_drain I/O_open_sink I/O_open_source These model types must have Vinl and Vinh defined. If they are not defined, the parser issues a warning and the default values of Vinl = 0.8 V and Vinh = 2.0 V are assumed.

Input_ECL I/O_ECL These model types must have Vinl and Vinh defined. If they are not defined, the parser issues a warning and the default values of Vinl = -1.475 V and Vinh = -1.165 V are assumed.

Terminator This model type is an input-only model that can have analog loading effects on the circuit being simulated but has no digital logic thresholds. Examples of terminators are: capacitors, termination diodes, and pullup resistors.

Output This model type indicates that an output always sources and/or sinks current and cannot be disabled.

3-state This model type indicates that an output

can be disabled, i.e., put into a high impedance state.

Open_sink
Open_drain These model types indicate that the output has an OPEN side (do not use the [Pullup] keyword, or if it must be used, set I = 0 mA for all voltages specified) and the output SINKS current. Open_drain model type is retained for backward compatibility.

Open_source This model type indicates that the output has an OPEN side (do not use the [Pulldown] keyword, or if it must be used, set I = 0 mA for all voltages specified) and the output SOURCES current.

Input_ECL
Output_ECL
I/O_ECL
3-state_ECL These model types specify that the model represents an ECL type logic that follows different conventions for the [Pulldown] keyword.

Series This model type is for series models that can be described by [R Series], [L Series], [Rl Series], [C Series], [Lc Series], [Rc Series], [Series Current] and [Series MOSFET] keywords.

Series_switch This model type is for series switch models that can be described by [On], [Off], [R Series], [L Series], [Rl Series], [C Series], [Lc Series], [Rc Series], [Series Current] and [Series MOSFET] keywords.

Input_diff
Output_diff
I/O_diff
3-state_diff These model types specify that the model defines a true differential model available directly through the [External Model] keyword documented in Section 6b.

The Model_type subparameter is required.

The C_comp subparameter is required only when C_comp_pullup, C_comp_pulldown, C_comp_power_clamp, and C_comp_gnd_clamp are not present. If the C_comp subparameter is not present, at least one of the C_comp_pullup, C_comp_pulldown, C_comp_power_clamp, or C_comp_gnd_clamp subparameters is required. It is not illegal to include the C_comp subparameter together with one or more of the remaining C_comp_* subparameters, but in that case the simulator will have to make a decision whether to use C_comp or the C_comp_pullup, C_comp_pulldown, C_comp_power_clamp, and C_comp_gnd_clamp subparameters. Under no circumstances should the simulator use the value of C_comp simultaneously with the values of the other C_comp_* subparameters.

C_comp_pullup, C_comp_pulldown, C_comp_power_clamp, and C_comp_gnd_clamp are intended to represent the parasitic capacitances of those structures whose I-V characteristics are described by the [Pullup], [Pulldown], [POWER Clamp] and [GND Clamp] I-V tables. For this reason, the simulator should generate a circuit netlist so that, if defined, each of

the C_comp_* capacitors are connected in parallel with their corresponding I-V tables, whether or not the I-V table exists. That is, the C_comp_* capacitors are positioned between the signal pad and the nodes defined by the [Pullup Reference], [Pulldown Reference], [POWER Clamp Reference] and [GND Clamp Reference] keywords, or the [Voltage Range] keyword and GND.

The C_comp and C_comp_* subparameters define die capacitance. These values should not include the capacitance of the package. C_comp and C_comp_* are allowed to use "NA" for the min and max values only.

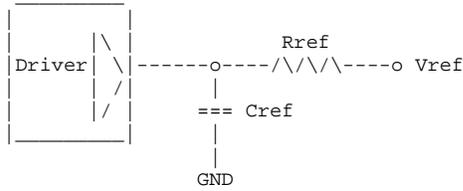
The Polarity, Enable, Vinl, Vinh, Vmeas, Cref, Rref, and Vref subparameters are optional.

Also, optional Rref_diff and Cref_diff subparameters discussed further in Section 6b support the true differential buffer timing test loads. They are used only when the [Diff Pin] keyword connects two models, and each buffer references the same model. The Rref_diff and Cref_diff subparameters can be used with the Rref, Cref, and Vref subparameters for a combined differential and signal-ended timing test load. Single-ended test loads are permitted for differential applications.

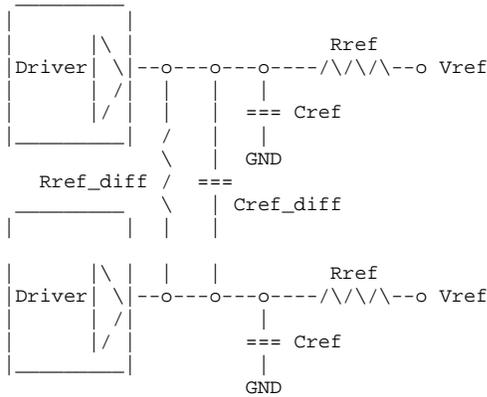
The Rref_diff and Cref_diff are recognized only when the [Diff Pin] keyword connects the models. This applies for the true differential buffers in Section 6b and also for differential buffers using identical single-ended models.

The Polarity subparameter can be defined as either Non-Inverting or Inverting, and the Enable subparameter can be defined as either Active-High or Active-Low.

The Cref and Rref subparameters correspond to the test load that the semiconductor vendor uses when specifying the propagation delay and/or output switching time of the model. The Vmeas subparameter is the timing reference voltage level that the semiconductor vendor uses for the model. Include Cref, Rref, Vref, and Vmeas information to facilitate board-level timing simulation. The assumed connections for Cref, Rref, and Vref are shown in the following diagram:



A single-ended or true differential buffer can have Rref_diff and Cref_diff.:



Other Notes: A complete [Model] description normally contains the following keywords: [Voltage Range], [Pullup], [Pulldown], [GND Clamp], [POWER Clamp], and [Ramp]. A Terminator model may use the [Rgnd], [Rpower], [Rac], and [Cac] keywords. However, some models may have only a subset of these keywords. For example, an input structure normally only needs the [Voltage Range], [GND Clamp], and possibly the [POWER Clamp] keywords. If any of [Rgnd], [Rpower], [Rac], and [Cac] keywords is used, then the Model_type must be Terminator.

Signals	CLK1, CLK2,...	Optional signal list, if desired	
[Model]	Clockbuffer		
Model_type	I/O		
Polarity	Non-Inverting		
Enable	Active-High		
Vinl = 0.8V		Input logic "low" DC voltage, if any	
Vinh = 2.0V		Input logic "high" DC voltage, if any	
Vmeas = 1.5V		Reference voltage for timing measurements	
Cref = 50pF		Timing specification test load capacitance value	
Rref = 500		Timing specification test load resistance value	
Vref = 0		Timing specification test load voltage	
variable	typ	min	max
C_comp	7.0pF	5.0pF	9.0pF
C_comp_pullup	3.0pF	2.5pF	3.5pF
C_comp_pulldown	2.0pF	1.5pF	2.5pF
C_comp_power_clamp	1.0pF	0.5pF	1.5pF
C_comp_gnd_clamp	1.0pF	0.5pF	1.5pF
These four can be used instead of C_comp			

```

| For a single-ended or true differential buffer (in Section 6b)
|
[Model]          External_Model_Diff
Model_type      I/O_diff          | Requires [External Model]
Polarity        Non-Inverting
Enable          Active-High
| The [Diff Pin] vdiff value overrides the thresholds below
Vinl = 0.8V     | Input logic "low" DC voltage, if any
Vinh = 2.0V     | Input logic "high" DC voltage, if any
|
| The true differential measurement point is at
| the crossover voltage
| The Vmeas value is overridden
Vmeas = 1.5V   | Reference voltage for timing measurements
| Single-ended timing test load is still permitted
Cref = 5pF     | Timing specification test load capacitance value
Rref = 500     | Timing specification test load resistance value
Vref = 0       | Timing specification test load voltage
| These new subparameters are permitted for
| single-ended differential operation based on the
| [Diff Pin] keyword
Rref_diff = 100 | Timing specification differential resistance value
Cref_diff = 5pF | Timing specification differential capacitance value

```

```

=====
Keyword: [Model Spec]
Required:   No
Sub-Params: Vinh, Vinl, Vinh+, Vinh-, Vinl+, Vinl-, S_overshoot_high,
             S_overshoot_low, D_overshoot_high, D_overshoot_low,
             D_overshoot_time, D_overshoot_area_h, D_overshoot_area_l,
             D_overshoot_ampl_h, D_overshoot_ampl_l, Pulse_high, Pulse_low,
             Pulse_time, Vmeas, Vref, Cref, Rref, Cref_rising,
             C_ref_falling, Rref_rising, Rref_falling, Vref_rising,
             Vref_falling, Vmeas_rising, Vmeas_falling, Rref_diff,
             Cref_diff, Weak_R, Weak_I, Weak_V
Description: The [Model Spec] keyword defines four columns under which
             specification subparameters are defined.

             The following subparameters are defined:
             Vinh      Input voltage threshold high
             Vinl      Input voltage threshold low
             Vinh+     Hysteresis threshold high max Vt+
             Vinh-     Hysteresis threshold high min Vt+
             Vinl+     Hysteresis threshold low max Vt-
             Vinl-     Hysteresis threshold low min Vt-
             S_overshoot_high  Static overshoot high voltage
             S_overshoot_low   Static overshoot low voltage
             D_overshoot_high  Dynamic overshoot high voltage
             D_overshoot_low   Dynamic overshoot low voltage
             D_overshoot_time  Dynamic overshoot time
             D_overshoot_area_h Dynamic overshoot high area (in V-s)
             D_overshoot_area_l Dynamic overshoot low area (in V-s)
             D_overshoot_ampl_h Dynamic overshoot high max amplitude
             D_overshoot_ampl_l Dynamic overshoot low max amplitude
             Pulse_high      Pulse immunity high voltage
             Pulse_low       Pulse immunity low voltage
             Pulse_time      Pulse immunity time
             Vmeas           Measurement voltage for timing measurements
             Vref            Timing specification test load voltage
             Cref            Timing specification capacitive load
             Rref            Timing specification resistance load
             Cref_rising     Timing specification capacitive load for

```

	rising edges
Cref_falling	Timing specification capacitive load for falling edges
Rref_rising	Timing specification resistance load for rising edges
Rref_falling	Timing specification resistance load for falling edges
Vref_rising	Timing specification test load voltage for rising edges
Vref_falling	Timing specification test load voltage for falling edges
Vmeas_rising	Measurement voltage for rising edge timing measurements
Vmeas_falling	Measurement voltage for falling edge timing measurements
Rref_diff	Timing specification differential resistance load
Cref_diff	Timing specification differential capacitive load
<u>Weak_R</u>	<u>Weak tie-up or tie-down resistance</u>
<u>Weak_I</u>	<u>Weak tie-up or tie-down current</u>
<u>Weak_V</u>	<u>Weak tie-up or tie-down voltage</u>

Usage Rules: [Model Spec] must follow all other subparameters under the [Model] keyword.

For each subparameter contained in the first column, the remaining three hold its typical, minimum and maximum values. The entries of typical, minimum and maximum must be placed on a single line and must be separated by at least one white space. All four columns are required under the [Model Spec] keyword. However, data is required only in the typical column. If minimum and/or maximum values are not available, the reserved word "NA" must be used indicating the typical value by default.

The minimum and maximum values are used for specifications subparameter values that may track the min and max operation conditions of the [Model]. Usually it is related to the Voltage Range settings.

Unless noted below, no subparameter requires having present any other subparameter.

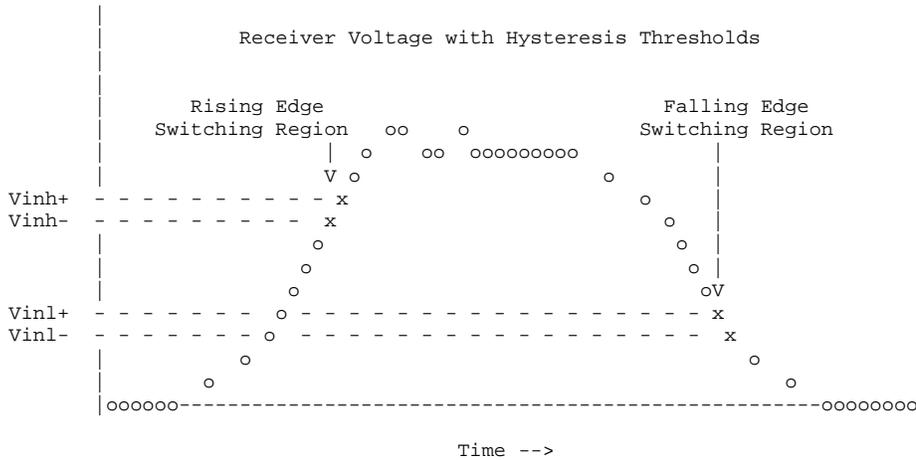
Vinh, Vinl rules:

The threshold subparameter lines provide additional min and max column values, if needed. The typ column values are still required and would be expected to override the Vinh and Vinl subparameter values specified elsewhere. Note: the syntax rule that require inserting Vinh and Vinl under models remains unchanged even if the values are defined under the [Model Spec] keyword.

Vinh+, Vinh-, Vinl+, Vinl- rules:

The four hysteresis subparameters (used for Schmitt trigger inputs for defining two thresholds for the rising edges and two thresholds for falling edges) must all be defined before independent input thresholds for rising and falling edges of the hysteresis threshold rules become effective. Otherwise the standard threshold subparameters remain in effect. The

hysteresis thresholds shall be at the V_{inh+} and V_{inh-} values for a low-to-high transition, and at the V_{inl+} and V_{inl-} values for a high-to-low transition.



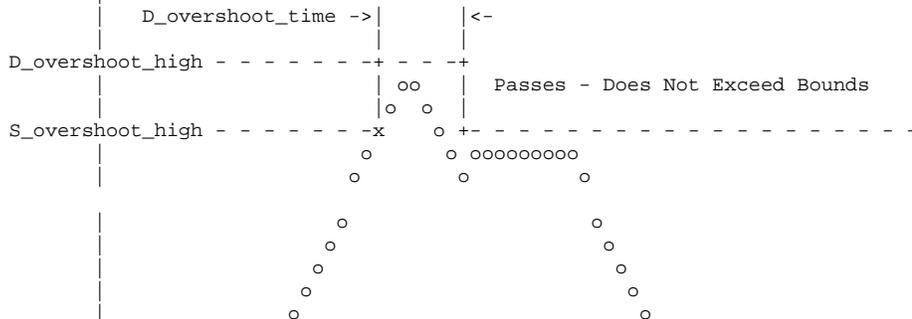
$S_{overshoot_high}$, $S_{overshoot_low}$ rules:

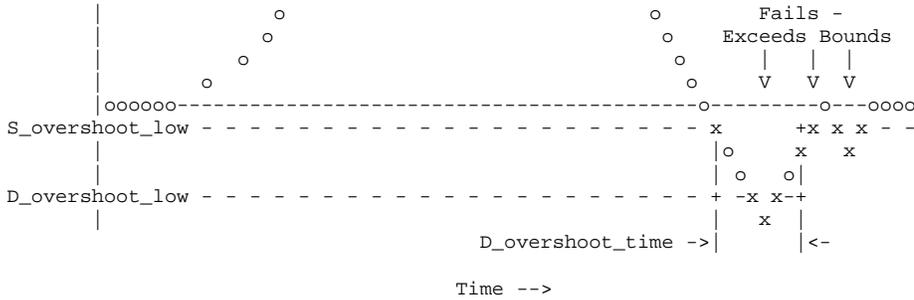
The static overshoot subparameters provide the DC voltage values for which the model is no longer guaranteed to function correctly. Often these voltages are given as absolute maximum ratings. However, if any lower $*_{overshoot_high}$ or higher $*_{overshoot_low}$ limit for functional specification compliance exists, that limit should be used.

$D_{overshoot_high}$, $D_{overshoot_low}$, $D_{overshoot_time}$ rules:

The dynamic overshoot values provide a time window during which the overshoot may exceed the static overshoot limits but be below the dynamic overshoot limits and still guarantee functional specification compliance. $D_{overshoot_time}$ is required for dynamic overshoot testing. In addition, if $D_{overshoot_high}$ is specified, then $S_{overshoot_high}$ is necessary for testing beyond the static limit. Similarly, if $D_{overshoot_low}$ is specified, then $S_{overshoot_low}$ is necessary for testing beyond the static limit.

Receiver Voltage with Static and Dynamic Overshoot Limits

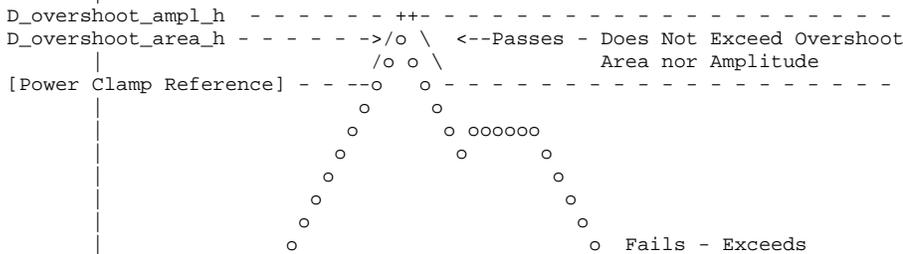


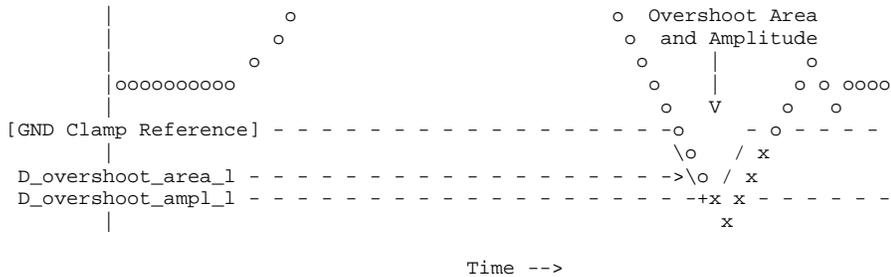


D_overshoot_area_h, D_overshoot_area_l, D_overshoot_ampl_h,
D_overshoot_ampl_l rules:

The dynamic overshoot area values define a maximum V-s area that an overshooting signal must not exceed. The high area is calculated from the point that a signal overshoots above the voltage defined by the [Power Clamp Reference] keyword until the point that the signal crosses back through this same voltage. Note that the area is defined as the complete area-under-the-curve as bounded by the limits defined above and not a "triangular" area as shown in the example drawing below. If [Power Clamp Reference] is not defined, then this crossing voltage is assumed to be defined by the [Voltage Range] keyword. The low area is calculated from the point that a signal overshoots below the voltage defined by the [GND Clamp Reference] keyword until the point that the signal crosses back through this same voltage. If [GND Clamp Reference] is not defined, then this crossing voltage is assumed to be 0.0 V. If D_overshoot_area_h is specified, then D_overshoot_ampl_h must also be specified. D_overshoot_ampl_h provides a maximum amplitude allowed for the overshoot area and is measured as voltage above the [Power Clamp Reference] voltage. Similarly, if D_overshoot_area_l is specified, then D_overshoot_ampl_l must also be specified. D_overshoot_ampl_l is measured as voltage below the [GND Clamp Reference] voltage. Both amplitude parameters should be listed as absolute (non-negative) values. Also, if D_overshoot_area_h, D_overshoot_area_l, D_overshoot_ampl_h, and D_overshoot_ampl_l are specified, then other static and dynamic overshoot parameters are optional.

Receiver Voltage with Dynamic Area Overshoot Limits





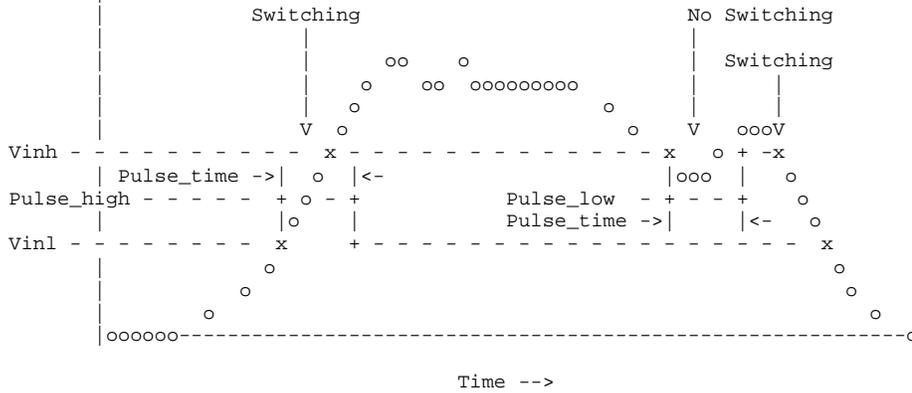
Pulse_high, Pulse_low, Pulse_time rules:

The pulse immunity values provide a time window during which a rising pulse may exceed the nearest threshold value but

be below the pulse voltage value and still not cause the input to switch. Pulse_time is required for pulse immunity testing. A rising response is tested only if Pulse_high is specified. Similarly, a falling response is tested only if Pulse_low is specified. The rising response may exceed the Vinl value, but remain below the Pulse_high value.

Similarly, the falling response may drop below the Vinh value, but remain above the Pulse_low value. In either case the input is regarded as immune to switching if the responses are within these extended windows. If the hysteresis thresholds are defined, then the rising response shall use Vinh- as the reference voltage, and the falling response shall use Vinl+ as the reference voltage.

Receiver Voltage with Pulse Immunity Thresholds



Vmeas, Vref, Cref, Rref rules:

The Vmeas, Vref, Cref and Rref values under the [Model Spec] keyword override their respective values entered elsewhere. Note that a Vmeas, Vref, Cref or Rref subparameters may not be used if its edge specific version (*_rising or *_falling) is used.

Cref_rising, Cref_falling, Rref_rising, Rref_falling, Vref_rising, Vref_falling, Vmeas_rising, Vmeas_falling rules:

Use these subparameters when specifying separate timing test loads and voltages for rising and falling edges. If one 'rising' or 'falling' subparameter is used, then the corresponding 'rising' or 'falling' subparameter must be present. The values listed in these subparameters override any corresponding Cref, Vref, Rref or Vmeas values entered elsewhere.

Rref_diff, Cref_diff rules:

The Rref_diff and Cref_diff values under the [Model Spec] keyword override their respective values entered elsewhere. These subparameters are used only when the model is referenced by the [Diff Pin] keyword. These follow the same rules as the corresponding subparameters documented under the [Model] keyword. See Section 6b for more discussion on true and single-ended differential operation.

Weak_R, Weak_I, and Weak_V rules:

If an IO circuit uses a simple weak tie-up or tie-down device (resistor or transistor) between the chip IO pad and a power supply, Weak_R stores the resistance of this device and Weak_V stores the voltage of the power supply to which the device is connected. A Weak_I stores the approximate current into the device and Weak_V stores the voltage of the power supply. They apply to both static and configurable tie-up and tie-down devices.

The Weak_R, Weak_I, and Weak_V subparameters are optional and separate from the current-voltage table keywords, e.g., [Pullup], [GND Clamp], etc. They do not affect how the current-voltage tables are extracted.

(Weak_R and Weak_V) or (Weak_I and Weak_V) must always be used as a pair. Weak_R and Weak_I must not be used together.

The current flow convention for Weak_I is similar to that of [GND Clamp] and [POWER Clamp] tables. A positive sign documents a weak tie-down current. A negative sign documents a weak tie-up current.

[Model Spec]				
Subparameter	typ	min	max	
Thresholds				
Vinh	3.5	3.15	3.85	70% of Vcc
Vinl	1.5	1.35	1.65	30% of Vcc
Vinh	3.835	3.335	4.335	Offset from Vcc
Vinl	3.525	3.025	4.025	for PECL
Hysteresis				
Vinh+	2.0	NA	NA	Overrides the
Vinh-	1.6	NA	NA	thresholds
Vinl+	1.1	NA	NA	
Vinl-	0.6	NA	NA	All 4 are required
Overshoot				
S_overshoot_high	5.5	5.0	6.0	Static overshoot
S_overshoot_low	-0.5	NA	NA	
D_overshoot_high	6.0	5.5	6.5	Dynamic overshoot
D_overshoot_low	-1.0	-1.0	-1.0	requires
D_overshoot_time	20n	20n	20n	D_overshoot_time
				& static overshoot
Overshoot defined by area in V-s (Values from DDR2 specification)				
D_overshoot_ampl_h	0.9	NA	NA	Dynamic overshoot
D_overshoot_ampl_l	0.9	NA	NA	requires area
D_overshoot_area_h	0.38n	NA	NA	and amplitude
D_overshoot_area_l	0.38n	NA	NA	parameters
Pulse Immunity				
Pulse_high	3V	NA	NA	Pulse immunity
Pulse_low	0	NA	NA	requires
Pulse_time	3n	NA	NA	Pulse_time
Timing Thresholds				
Vmeas	3.68	3.18	4.68	A 5 volt PECL
				example
Timing test load voltage reference example				
Vref	1.25	1.15	1.35	An SSTL-2 example
Rising and falling timing test load example (values from PCI-X specification)				
Cref_falling	10p	10p	10p	
Cref_rising	10p	10p	10p	
Rref_rising	25	500	25	typ value not specified
Rref_falling	25	500	25	typ value not specified
Vref_rising	0	1.5	0	
Vref_falling	3.3	1.5	3.6	
Vmeas_rising	0.941	0.885	1.026	vmeas = 0.285(vcc)
Vmeas_falling	2.0295	1.845	2.214	vmeas = 0.615(vcc)

Differential timing test load for true or single-ended differential model

Rref_diff	100	90	110
Cref_diff	5pF	NA	NA

Weak tie-up examples:

Weak_R	10k	NA	NA
Weak_V	1.5V	NA	NA

Weak_I	-10u	NA	NA	negative sign for
Weak_V	1.5V	NA	NA	tie-up current

=====
Keyword: [Receiver Thresholds]
Required: No
Sub-Params: Vth, Vth_min, Vth_max, Vinh_ac, Vinh_dc, Vinl_ac, Vinl_dc, Threshold_sensitivity, Reference_supply, Vcross_low, Vcross_high, Vdiff_ac, Vdiff_dc, Tslew_ac, Tdiffslew_ac
Description: -The [Receiver Thresholds] keyword defines both a set of receiver input thresholds as well as their sensitivity to variations in a referenced supply. The subparameters are defined as follows:

Vth, Vth_min and Vth_max are the ideal input threshold voltages at which the output of a digital logic receiver changes state. Vth is the nominal input threshold voltage under the voltage, temperature and process conditions that define 'typ'. Vth_min is the minimum input threshold voltage at 'typ' conditions while Vth_max is the maximum input threshold voltage at 'typ' conditions.

Vinh_ac is the voltage that a low-to-high going input waveform must reach in order to guarantee that the receiver's output has changed state. In other words, reaching Vinh_ac is sufficient to guarantee a receiver state change. Vinh_ac is expressed as an offset from Vth.

Vinh_dc is the voltage that an input waveform must remain above (more positive than) in order to guarantee that a receiver output will NOT change state. Vinh_dc is expressed as an offset from Vth.

Vinl_ac is the voltage that a high-to-low going input waveform must reach in order to guarantee that the receiver's output has changed state. In other words, reaching Vinl_ac is sufficient to guarantee a receiver state change. Vinl_ac is expressed as an offset from Vth.

Vinl_dc is the voltage that an input waveform must remain below (more negative than) in order to guarantee that a receiver's output will NOT change state. Vinl_dc is expressed as an offset from Vth.

Threshold_sensitivity is a unit less number that specifies how Vth varies with respect to the supply voltage defined by the Reference_supply subparameter. Threshold_sensitivity is defined as:

change in input threshold voltage
Threshold_sensitivity = -----
change in referenced supply voltage

Threshold_sensitivity must be entered as a whole number or decimal, not as a fraction.

Reference_supply indicates which supply voltage Vth tracks; i.e., it indicates which supply voltage change causes a change in input threshold. The legal arguments to this subparameter are as follows:

Power_clamp_ref	The supply voltage defined by the [POWER Clamp Reference] keyword
Gnd_clamp_ref	The supply voltage defined by the [GND Clamp Reference] keyword
Pullup_ref	The supply voltage defined by the [Pullup reference] keyword
Pulldown_ref	The supply voltage defined by the [Pulldown reference] keyword
Ext_ref	The supply voltage defined by the [External Reference] keyword

Tslew_ac and Tdiffslew_ac measures the absolute difference in time between the point at which an input waveform crosses Vinl_ac and the point it crosses Vinh_ac. The purpose of this parameter is to document the maximum amount of time an input signal may take to transition between Vinh_ac and Vinl_ac and still allow the device to meet its input setup and hold specifications. Tslew_ac is the parameter used for single ended receivers while Tdiffslew_ac must be used for receivers with differential inputs.

Vcross_low is the least positive voltage at which a differential receivers' input signals may cross while switching and still allow the receiver to meet its timing and functional specifications. Vcross_low is specified with respect to 0 V.

Vcross_high is the most positive voltage at which a differential receivers' input signals may cross while switching and still allow the receiver to meet its timing and functional specifications. Vcross_high is specified with respect to 0 V.

Vdiff_dc is the minimum voltage difference between the inputs of a differential receiver that guarantees the receiver will not change state.

Vdiff_ac is the minimum voltage difference between the inputs of a differential receiver that guarantees the receiver will change state.

Usage Rules: [Receiver Thresholds] must follow all subparameters under the [Model] keyword and precede all other keywords of a model except [Model Spec].
The [Receiver Thresholds] keyword is valid if the model type includes any reference to input or I/O. For single ended receivers the Vinh_ac, Vinh_dc, Vinl_ac, Vinh_dc, Vth and Tslew_ac subparameters are required and override the Vinh, Vinl, Vinh+/- and Vinl+/- subparameters declared under the

[Model] or [Model Spec] keywords. For single ended receivers the Vth_min, Vth_max, Threshold_sensitivity and Reference_supply subparameters are optional. However, if the Threshold_sensitivity subparameter is present then the Reference_supply subparameter must also be present.

For differential receivers (i.e., the [Receiver Thresholds] keyword is part of a [Model] statement that describes a pin listed in the [Diff Pin] keyword) then the Vcross_low,

Vcross_high, Vdiff_ac, Vdiff_dc and Tdiffslew_ac subparameters are required. The rest of the subparameters are not applicable. The Vdiff_ac and Vdiff_dc values override the value of the vdiff subparameter specified by the [Diff Pin] keyword. Note that Vcross_low and Vcross_high are valid over the device's minimum and maximum operating conditions.

Subparameter Usage Rules:

Numerical arguments are separated from their associated subparameter by an equals sign (=); white space around the equals sign is optional. The argument to the Reference_supply subparameter is separated from the subparameter by white space.

Vth at Minimum or Maximum Operating Conditions:

As described above, the Vth_min and Vth_max subparameters define the minimum and maximum input threshold values under typical operating conditions. There is no provision for directly specifying Vth under minimum or maximum operating conditions. Instead, these values are calculated using the following equation:

$$Vth(\min/\max) = Vth^* + [(Threshold_sensitivity) \times (change\ in\ supply\ voltage)]$$

where Vth* is either Vth, Vth_min or Vth_max as appropriate, and the supply voltage is the one indicated by the Reference_supply subparameter.

A basic 3.3 V single ended receiver using only the required subparameters.

```
[Receiver Thresholds]
Vth = 1.5V
Vinh_ac = +225mV
Vinh_dc = +100mV
Vinl_ac = -225mV
Vinl_dc = -100mV
Tslew_ac = 1.2ns
```

A single ended receiver using an external threshold reference. In this case the input threshold is the external reference voltage so Threshold_sensitivity equals 1.

```
[Receiver Thresholds]
Vth = 1.0V
Threshold_sensitivity = 1
Reference_supply Ext_ref
Vinh_ac = +200mV
Vinh_dc = +100mV
Vinl_ac = -200mV
Vinl_dc = -100mV
Tslew_ac = 400ps
```

| A fully specified single ended 3.3 V CMOS receiver

[Receiver Thresholds]
Vth = 1.5V
Vth_min = 1.45V
Vth_max = 1.53V
Threshold_sensitivity = 0.45
Reference_supply Power_clamp_ref
Vinh_ac = +200mV
Vinh_dc = +100mV
Vinl_ac = -200mV
Vinl_dc = -100mV
Tslew_ac = 400ps

| A differential receiver

[Receiver Thresholds]
Vcross_low = 0.65V
Vcross_high = 0.90V
Vdiff_ac = +200mV
Vdiff_dc = +100mV
Tdiffslew_ac = 200ps

=====
Keyword: [Add Submodel]
Required: No
Description: References a submodel to be added to an existing model.
Usage Rules: The [Add Submodel] keyword is invoked within a model to add the functionality that is contained in the submodel or list of submodels in each line that follows. The first column contains the submodel name. The second column contains a submodel mode under which the submodel is used.

If the top-level model type is one of the I/O or 3-state models, the submodel mode may be Driving, Non-Driving, or All. For example, if the submodel mode is Non-Driving, then the submodel is used only in the high-Z state of a 3-state model. Set the submodel mode to All if the submodel is to be used for all modes of operation.

The submodel mode cannot conflict with the top-level model type. For example, if the top-level model type is an Open or Output type, the submodel mode cannot be set to Non-Driving. Similarly, if the top-level model type is Input, the submodel mode cannot be set to Driving.

The submodel mode can be set to All to cover all permitted modes for any top-level model type including, for example, Input, Output, and I/O.

The [Add Submodel] keyword is not defined for Series or Series_switch model types.

Refer to the ADD SUBMODEL DESCRIPTION section in this document for the descriptions of available submodels.

```
[Add Submodel]
| Submodel_name      Mode
Bus_Hold_1          Non-Driving | Adds the electrical characteristics of
                    | [Submodel] Bus_Hold_1 for receiver or
                    | high-Z mode only.
Dynamic_clamp_1     All          | Adds the Dynmanic_clamp_1 model for
                    | all modes of operation.
```

```
=====
Keyword: [Driver Schedule]
Required: No
Description: Describes the relative model switching sequence for referenced
models to produce a multi-staged driver.
Usage Rules: The [Driver Schedule] keyword establishes a hierarchical order
between models and should be placed under the [Model] which
acts as the top-level model. The scheduled models are then
referenced from the top-level model by the [Driver Schedule]
keyword.
```

When a multi-staged buffer is modeled using the [Driver Schedule] keyword, all of its stages (including the first stage, or normal driver) have to be modeled as scheduled models.

If there is support for this feature in a EDA tool, the [Driver Schedule] keyword will cause it to use the [Pulldown], [Pullup], [Pullup Reference], [Voltage Range], [Ramp], [Rising Waveform] and [Falling Waveform] keywords from the scheduled models instead of the top-level model, according to the timing relationships described in the [Driver Schedule] keyword. Consequently, the keywords in the above list will be ignored in the top-level model. All of the remaining keywords not shown in the above list, and all of the subparameters will be used from the top-level model and should be ignored in the scheduled model(s).

However, both the top-level and the scheduled model(s) have to be complete models, i.e., all of the required keywords must be present and follow the syntactical rules.

For backwards compatibility reasons and for EDA tools which do not support multi-staged switching, the keywords in the above list can be used in the top-level [Model] to describe the overall characteristics of the buffer as if it was a composite model. It is not guaranteed, however, that such a top-level model will yield the same simulation results as a full multi-stage model. It is recommended that a "golden waveform" for the device consisting of a [Rising Waveform] table and a [Falling Waveform] table be supplied in the top-level model to serve as a reference for validation.

Even though some of the keywords are ignored in the scheduled model, it may still make sense in some cases to supply correct data with them. One such situation would arise when a [Model] is used both as a regular top-level model as well as a scheduled model.

The [Driver Schedule] table consists of five columns. The first column contains the model names of other models that exists in the .ibs file. The remaining four columns describe delays: Rise_on_dly, Rise_off_dly, Fall_on_dly, and Fall_off_dly. The t=0 time of each delay is the event when the EDA tool's internal pulse initiates a rising or falling transition. All specified delay values must be equal to or greater than 0. There are only five valid combinations in which these delay values can be defined:

- 1) Rise_on_dly with Fall_on_dly
- 2) Rise_off_dly with Fall_off_dly
- 3) Rise_on_dly with Rise_off_dly
- 4) Fall_on_dly with Fall_off_dly
- 5) All four delays defined
(be careful about correct sequencing)

The four delay parameters have the meaning as described below. (Note that this description applies to buffer types which have both pullup and pulldown structures. For those buffer types which have only a pullup or pulldown structure, the description for the missing structure can be omitted.)

Rise_on_dly is the amount of time that elapses from the internal simulator pulse initiating a RISING edge to the t = 0 time of the waveform or ramp that turns the I-V table of the PULLUP device ON, and the t = 0 time of the waveform or ramp that turns the I-V table of the PULLDOWN device OFF (if they were not already turned ON and OFF, respectively, by another event).

Rise_off_dly is the amount of time that elapses from the internal simulator pulse initiating a RISING edge to the t = 0 time of the waveform or ramp that turns the I-V table of the PULLUP device OFF, and the t = 0 time of the waveform or ramp that turns the I-V table of the PULLDOWN device ON (if they were not already turned ON and OFF, respectively, by another event).

Fall_on_dly is the amount of time that elapses from the internal simulator pulse initiating a FALLING edge to the t = 0 time of the waveform or ramp that turns the I-V table of the PULLDOWN device ON, and the t = 0 time of the waveform or ramp that turns the I-V table of the PULLUP device OFF (if they were not already turned ON and OFF, respectively, by another event).

Fall_off_dly is the amount of time that elapses from the internal simulator pulse initiating a FALLING edge to the t = 0 time of the waveform or ramp that turns the I-V table of the PULLDOWN device OFF, and the t = 0 time of the waveform or ramp that turns the I-V table of the PULLUP device ON (if they were not already turned ON and OFF, respectively, by another event).

In the above four paragraphs, the word "event" refers to the moment in time when the delay is triggered by the stimulus. This stimulus is provided to the top-level model by the simulation tool. The expiration of delays cannot generate events.

Note that some timing combinations may only be possible if the two halves of a complementary buffer are modeled separately as two open_* models.

No [Driver Schedule] table may reference a model which itself has within it a [Driver Schedule] keyword.

Use 'NA' when no delay value is applicable. For each scheduled model the transition sequence must be complete, i.e., the scheduled model must return to its initial state.

Only certain numerical entry combinations are permitted to define a complete transition sequence. The table below gives the initial scheduled model states for each permitted set of numerical entries. The numerical delay entries, r, r1 and r2 are relative to the internal simulator pulse rising edge, and f, f1 and f2 are the numerical delay entries relative to internal simulator pulse falling edge. For the cases where

two delays are given relative to the same edge, the r2 entry is larger than the r1 entry, and the f2 entry is larger than the f1 entry. For cases below, the interchanging of such values corresponds to opposite direction switching. Once the scheduled model is set to its initial state, the switching is controlled by the internal simulator pulse and delays relative to it.

In the table below the scheduled model initial states depend on the initial state of the [Model]. This top-level [Model] state ('Low' or 'High') is a function of the stimulus pulse (or simulation control method) and the [Model] Polarity subparameter. For example, if a [Model] Polarity is Inverting and its stimulus pulse starts high, the [Model] initial state is 'Low' and all scheduled model initial states follow the settings under the 'Low' column. Two possible four-data ordering combinations are omitted because their initial states are ambiguous. Special rules to select the initial states would produce sequencing equivalent to the two-data combinations shown in the first two lines of the table.

SCHEDULED MODEL INITIAL STATE TABLE

Table Numerical Delay Entries				[Model] Initial State	
Rise_on	Rise_off	Fall_on	Fall_off	Low	High
r	NA	f	NA	Low	High
NA	r	NA	f	High	Low
r1	r2	NA	NA	Low	Low
r2	r1	NA	NA	High	High
NA	NA	f1	f2	High	High
NA	NA	f2	f1	Low	Low
r1	r2	f2	f1	Low	Low
r2	r1	f1	f2	High	High

The delay numbers r, r1, r2, and f, f1, f2 plus the associated model transitions should fit within the corresponding pulse width durations. Smaller pulse width stimuli may change the switching sequencing and is not supported.

Other Notes: The added models typically consist of Open_sink (Open_drain) or Open_source models to provide sequentially increased drive strengths. The added drive may be removed within the same transition for a momentary boost or during the opposite transition.

The syntax also allows for reducing the drive strength.

Note that the Rise_on_dly, Rise_off_dly, Fall_on_dly, Fall_off_dly parameters are single value parameters, so typical, minimum and maximum conditions cannot be described with them directly. In order to account for those effects, one can refer to the fastest waveform table with the delay number and then insert an appropriate amount of horizontal lead in section in those waveforms which need more delay.

Notice that the C_comp parameter of a multi-stage buffer is defined in the top-level model. The value of C_comp therefore includes the total capacitance of the entire buffer, including all of its stages. Since the rising and falling waveform measurements include the effects of C_comp, each of these waveforms must be generated with the total C_comp present, even if the various stages of the buffer are characterized individually.

Note: In a future release, the [Driver Schedule] keyword may be replaced by a newer method of specification that is consistent with some other planned extensions. However, the [Driver Schedule] syntax will continue to be supported.

[Driver Schedule]

Model_name	Rise_on_dly	Rise_off_dly	Fall_on_dly	Fall_off_dly
MODEL_OUT	0.0ns	NA	0.0ns	NA

Examples of added multi-staged transitions

M_O_SOURCE1	0.5ns	NA	0.5ns	NA
	low (high-Z) to high		high to low (high-Z)	
M_O_SOURCE2	0.5n	1.5n	NA	NA
	low to high to low		low (high-Z)	
M_O_DRAIN1	1.0n	NA	1.5n	NA
	low to high (high-Z)		high (high-Z) to low	
M_O_DRAIN2	NA	NA	1.5n	2.0n
	high (high-Z)		high to low to high	

=====
Keyword: [Temperature Range]
Required: Yes, if other than the preferred 0, 50, 100 degree Celsius range
Description: Defines the temperature range over which the model is to operate.
Usage Rules: List the actual die temperatures (not percentages) in the typ, min, max format. "NA" is allowed for min and max only.
Other Notes: The [Temperature Range] keyword also describes the temperature range over which the various I-V tables and ramp rates were derived. Refer to NOTES ON DATA DERIVATION METHODS for rules on which temperature values to put in the 'min' and 'max' columns.

variable	typ	min	max
[Temperature Range]	27.0	-50	130.0

=====
Keyword: [Voltage Range]
Required: Yes, if [Pullup Reference], [Pulldown Reference], [POWER Clamp Reference], and [GND Clamp Reference] are not present
Description: Defines the power supply voltage tolerance over which the model is intended to operate. It also specifies the default voltage rail to which the [Pullup] and [POWER Clamp] I-V data is referenced.
Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. "NA" is allowed for the min and max values only.
Other Notes: If the [Voltage Range] keyword is not present, then all four of the keywords described below must be present: [Pullup Reference], [Pulldown Reference], [POWER Clamp Reference], and [GND Clamp Reference]. If the [Voltage Range] is present, the other keywords are optional and may or may not be used as required. It is legal (although redundant) for an optional keyword to specify the same voltage as specified by the [Voltage Range] keyword.

variable	typ	min	max
[Voltage Range]	5.0V	4.5V	5.5V

```

=====
Keyword: [Pullup Reference]
Required: Yes, if the [Voltage Range] keyword is not present
Description: Defines a voltage rail other than that defined by the [Voltage Range] keyword as the reference voltage for the [Pullup] I-V data.
Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. "NA" is allowed for the min and max values only.
Other Notes: This keyword, if present, also defines the voltage range over which the typ, min, and max dV/dt_r values are derived.
=====

```

```

variable          typ          min          max
[Pullup Reference] 5.0V          4.5V          5.5V
=====

```

```

=====
Keyword: [Pulldown Reference]
Required: Yes, if the [Voltage Range] keyword is not present
Description: Defines a power supply rail other than 0 V as the reference voltage for the [Pulldown] I-V data. If this keyword is not present, the voltage data points in the [Pulldown] I-V table are referenced to 0 V.
Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. "NA" is allowed for the min and max values only.
Other Notes: This keyword, if present, also defines the voltage range over which the typ, min, and max dV/dt_f values are derived.
=====

```

```

variable          typ          min          max
[Pulldown Reference] 0V           0V           0V
=====

```

```

=====
Keyword: [POWER Clamp Reference]
Required: Yes, if the [Voltage Range] keyword is not present
Description: Defines a voltage rail other than that defined by the [Voltage Range] keyword as the reference voltage for the [POWER Clamp] I-V data.
Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. "NA" is allowed for the min and max values only.
Other Notes: Refer to the "Other Notes" section of the [GND Clamp Reference] keyword.
=====

```

```

variable          typ          min          max
[POWER Clamp Reference] 5.0V          4.5V          5.5V
=====

```

```

=====
Keyword: [GND Clamp Reference]
Required: Yes, if the [Voltage Range] keyword is not present
Description: Defines a power supply rail other than 0 V as the reference voltage for the [GND Clamp] I-V data. If this keyword is not present, the voltage data points in the [GND Clamp] I-V table are referenced to 0 V.
Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. "NA" is allowed for the min and max values only.
Other Notes: Power Supplies: It is intended that standard TTL and CMOS models be specified using only the [Voltage Range] keyword. However, in cases where the output characteristics of a model depend on more than a single supply and ground, or a [Pullup], [Pulldown], [POWER Clamp], or [GND Clamp] table is referenced to something other than the default supplies, use the additional 'reference' keywords.
=====

```

```

variable          typ          min          max
[GND Clamp Reference] 0V           0V           0V
=====

```

```

=====
Keyword: [External Reference]
Required: Yes, if a receiver's input threshold is determined by an
external reference voltage
Description: Defines a voltage source that supplies the reference voltage
used by a receiver for its input threshold reference.
Usage Notes: Provide actual voltages (not percentages in the typ, min max
format. "NA" is allowed for the min and max values only.
Note that the numerically largest value should be placed in
'max' column, while the numerically smallest value should
be placed in the 'min' column.
=====

```

variable	typ	min	max
[External Reference]	1.00V	0.95V	1.05V

```

=====
Keywords: [TTgnd], [TTpower]
Required: No
Description: These keywords specify the transit time parameters used to
estimate the transit time capacitances or develop transit time
capacitance tables for the [GND Clamp] and [POWER Clamp]
tables.
Usage Rules: For each of these keywords, the three columns hold the transit
values corresponding to the typical, minimum and maximum [GND
Clamp] or [POWER Clamp] tables, respectively. The entries for
TT(typ), TT(min), and TT(max) must be placed on a single line
and must be separated by at least one white space. All three
columns are required under these keywords. However, data is
required only in the typical column. If minimum and/or
maximum values are not available, the reserved word "NA" must
be used indicating the TT(typ) value by default.
Other Notes: The transit time capacitance is added to C_comp. It is in a
SPICE reference model as  $C_t = TT * d(I_d)/d(V_d)$  where
 $d(I_d)/d(V_d)$  defines the DC conductance at the incremental DC
operating point of the diode, and TT is the transit time.
This expression does not include any internal series
resistance. Such a resistance is assumed to be negligible in
practice. Assume that the internal diode current ( $I_d$ ) -
voltage ( $V_d$ ) relationship is  $I_d = I_s * (\exp(q(V_d)/kT) - 1)$ 
where  $I_s$  is the saturation current,  $q$  is electron charge,  $k$  is
Boltzmann's constant, and  $T$  is temperature in degrees Kelvin.
Then  $d(I_d)/d(V_d)$  is approximately  $(q/kT) * I_d$  when the diode
is conducting, and zero otherwise. This yields the
simplification  $C_t = TT * (q/kT) * I_d$ . The  $I_d$  is found from
the [GND Clamp] and [POWER Clamp] operating points, and the
corresponding TTgnd or TTpower is used to calculate the  $C_t$ 
value. If the [Temperature Range] keyword is not defined,
then use the default "typ" temperature for all  $C_t$ 
calculations.

The effective TT parameter values are intended to APPROXIMATE
the effects. They may be different from the values found in
the SPICE diode equations. Refer to the NOTES ON DATA
DERIVATION METHOD for extracting the effective values.
=====

```

variable	TT(typ)	TT(min)	TT(max)
[TTgnd]	10n	12n	9n
[TTpower]	12n	NA	NA

```

=====
Keywords: [Pulldown], [Pullup], [GND Clamp], [POWER Clamp]
=====

```

Required: Yes, if they exist in the model

Description: The data points under these keywords define the I-V tables of the pulldown and pullup structures of an output buffer and the I-V tables of the clamping diodes connected to the GND and the POWER pins, respectively. Currents are considered positive when their direction is into the component.

Usage Rules: In each of these sections, the first column contains the voltage value, and the three remaining columns hold the typical, minimum, and maximum current values. The four entries, Voltage, I(typ), I(min), and I(max) must be placed on a single line and must be separated by at least one white space.

All four columns are required under these keywords. However, data is only required in the typical column. If minimum and/or maximum current values are not available, the reserved word "NA" must be used. "NA" can be used for currents in the typical column, but numeric values MUST be specified for the first and last voltage points on any I-V table. Each I-V table must have at least 2, but not more than 100, rows.

Other Notes: The I-V table of the [Pullup] and the [POWER Clamp] structures are 'Vcc relative', meaning that the voltage values are referenced to the Vcc pin. (Note: Under these keywords, all references to 'Vcc' refer to the voltage rail defined by the [Voltage Range], [Pullup Reference], or [POWER Clamp Reference] keywords, as appropriate.) The voltages in the data tables are derived from the equation: $V_{table} = V_{cc} - V_{output}$.

Therefore, for a 5 V model, -5 V in the table actually means 5 V above Vcc, which is +10 V with respect to ground; and 10 V means 10 V below Vcc, which is -5 V with respect to ground. Vcc-relative data is necessary to model a pullup structure properly, since the output current of a pullup structure depends on the voltage between the output and Vcc pins and not the voltage between the output and ground pins. Note that the [GND Clamp] I-V table can include quiescent input currents, or the currents of a 3-stated output, if so desired.

When tabulating data for ECL models, the data in the [Pulldown] table is measured with the output in the 'logic low' state. In other words, the data in the table represents the I-V characteristics of the output when the output is at the most negative of its two logic levels. Likewise, the data in the [Pullup] table is measured with the output in the 'logic one' state and represents the I-V characteristics when the output is at the most positive logic level. Note that in BOTH of these cases, the data is referenced to the Vcc supply voltage, using the equation: $V_{table} = V_{cc} - V_{output}$.

Monotonicity Requirements:

To be monotonic, the I-V table data must meet any one of the following 8 criteria:

- 1- The CURRENT axis either increases or remains constant as the voltage axis is increased.
- 2- The CURRENT axis either increases or remains constant as the voltage axis is decreased.
- 3- The CURRENT axis either decreases or remains constant as the voltage axis is increased.

- 4- The CURRENT axis either decreases or remains constant as the voltage axis is decreased.
- 5- The VOLTAGE axis either increases or remains constant as the current axis is increased.
- 6- The VOLTAGE axis either increases or remains constant as the current axis is decreased.
- 7- The VOLTAGE axis either decreases or remains constant as the current axis is increased.
- 8- The VOLTAGE axis either decreases or remains constant as the current axis is decreased.

An IBIS syntax checking program shall test for non-monotonic data and provide a maximum of one warning per I-V table if non-monotonic data is found. For example:

"Warning: Line 300, Pulldown I-V table for model DC040403 is non-monotonic! Most simulators will filter this data to remove the non-monotonic data."

It is also recognized that the data may be monotonic if currents from both the output stage and the clamp diode are added together as most simulators do. To limit the complexity of the IBIS syntax checking programs, such programs will conduct monotonicity testing only on one I-V table at a time.

It is intended that the [POWER Clamp] and [GND Clamp] tables are summed together and then added to the appropriate [Pullup] or [Pulldown] table when a buffer is driving high or low, respectively.

From this assumption and the nature of 3-statable buffers, it follows that the data in the clamping table sections are handled as constantly present tables and the [Pullup] and

[Pulldown] tables are used only when needed in the simulation.

The clamp tables of an Input or I/O buffer can be measured directly with a curve tracer, with the I/O buffer 3-stated. However, sweeping enabled buffers results in tables that are the sum of the clamping tables and the output structures. Based on the assumption outlined above, the [Pullup] and [Pulldown] tables of an IBIS model must represent the difference of the 3-stated and the enabled buffer's tables. (Note that the resulting difference table can demonstrate a non-monotonic shape.) This requirement enables the simulator to sum the tables, without the danger of double counting, and arrive at an accurate model in both the 3-stated and enabled conditions.

Since in the case of a non 3-statable buffer, this difference table cannot be generated through lab measurements (because the clamping tables cannot be measured alone), the [Pullup] and [Pulldown] tables of an IBIS model can contain the sum of the clamping characteristics and the output structure. In this case, the clamping tables must contain all zeroes, or the keywords must be omitted.

```
-----
[Pulldown]
| Voltage  I(typ)   I(min)   I(max)
|
| -5.0V   -40.0m   -34.0m   -45.0m
```

-4.0V	-39.0m	-33.0m	-43.0m
.			
0.0V	0.0m	0.0m	0.0m
.			
5.0V	40.0m	34.0m	45.0m
10.0V	45.0m	40.0m	49.0m

[Pullup] | Note: Vtable = Vcc - Voutput

Voltage	I(typ)	I(min)	I(max)
-5.0V	32.0m	30.0m	35.0m
-4.0V	31.0m	29.0m	33.0m
.			
0.0V	0.0m	0.0m	0.0m
.			
5.0V	-32.0m	-30.0m	-35.0m
10.0V	-38.0m	-35.0m	-40.0m

[GND Clamp]

Voltage	I(typ)	I(min)	I(max)
-5.0V	-3900.0m	-3800.0m	-4000.0m
-0.7V	-80.0m	-75.0m	-85.0m
-0.6V	-22.0m	-20.0m	-25.0m
-0.5V	-2.4m	-2.0m	-2.9m
-0.4V	0.0m	0.0m	0.0m
5.0V	0.0m	0.0m	0.0m

[POWER Clamp] | Note: Vtable = Vcc - Voutput

Voltage	I(typ)	I(min)	I(max)
-5.0V	4450.0m	NA	NA
-0.7V	95.0m	NA	NA
-0.6V	23.0m	NA	NA
-0.5V	2.4m	NA	NA
-0.4V	0.0m	NA	NA
0.0V	0.0m	NA	NA

=====
Keywords: [ISSO PD], [ISSO PU]
Required: No
Description: The data points under the keyword [ISSO PD] define the effective current of the pulldown structure of a buffer as a function of the voltage on the pulldown reference node (the ground node), whereas the points under the keyword [ISSO PU] define the effective current of the pullup structure as a function of the voltage on the pullup reference node (the power node).

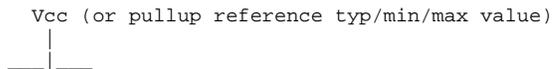
Usage Rules: The first column contains the voltage value at which the currents of the remaining three columns are obtained. The three remaining columns contain the typical, minimum, and maximum effective current values to be defined below of pullup/pulldown stage.

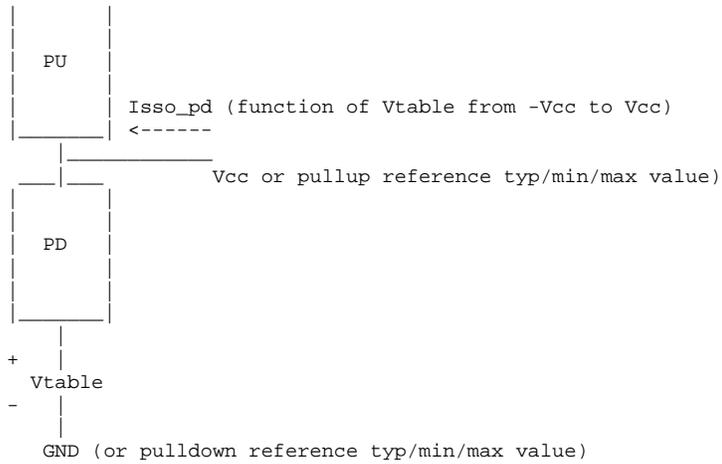
All four columns are required under this keyword. However, data is only required in the typical column. If minimum and/or maximum current values are not available, the reserved word "NA" must be used. "NA" can be used for currents in the typical column, but numeric values MUST be specified for the first and last voltage points in any table. Each table must have at least 2, but not more than 100, rows.

The [ISSO PD] table voltages are relative to the [Pulldown Reference] typ/min/max values (usually ground). The [ISSO PU] table voltages are relative to the [Pullup Reference] typ/min/max values (also usually the [Voltage Range] voltages). In the case of the [ISSO PU] table the voltages follow the same $V_{table} = V_{cc} - V_{measured}$ convention as the [Pullup] table. Each of the tables are aligned with and span the typical $-V_{cc}$ to V_{cc} voltages.

If the [ISSO_PD] and [ISSO_PU] keywords are not present, the effect of power supply variations on the I-V tables is not explicitly defined by the model.

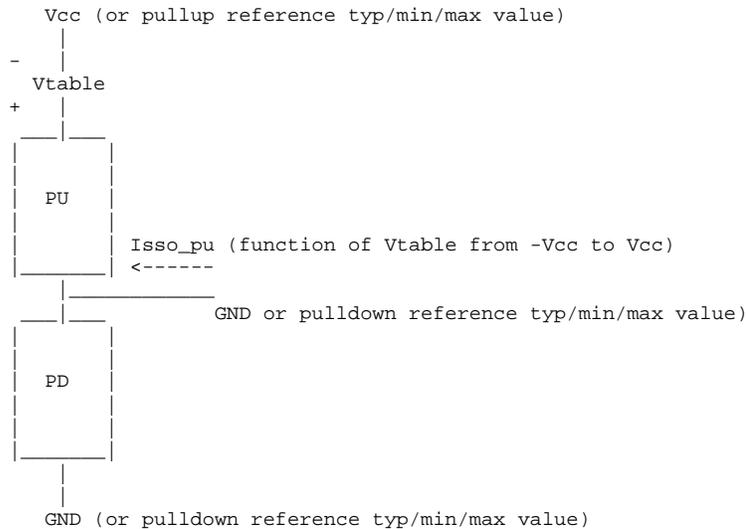
The effective current table for the Isso_pd current is extracted by the following process. The buffer is set to "logic zero". A Vtable voltage source is inserted between the [Pulldown Reference] node and the buffer as shown below. This Vtable voltage is swept from $-V_{cc}$ (typical) to $+V_{cc}$ (typical) and is relative to the [Pulldown Reference] typ/min/max values for the corresponding columns. The output is connected to the Vee-GND (typical) value as shown below.
Low State (logic zero)





The effective current table for the I_{sso_pu} current is extracted by the following process. The buffer is set to "logic one". A V_{table} voltage source is inserted between the [Pullup Reference] node and the buffer as shown below. This V_{table} voltage is swept from $-V_{cc}$ (typical) to $+V_{cc}$ (typical) and is relative to the [Pullup Reference] typ/min/max values for the corresponding columns. The output is connected to the V_{cc} (typical) value as shown below.

High State (logic one)

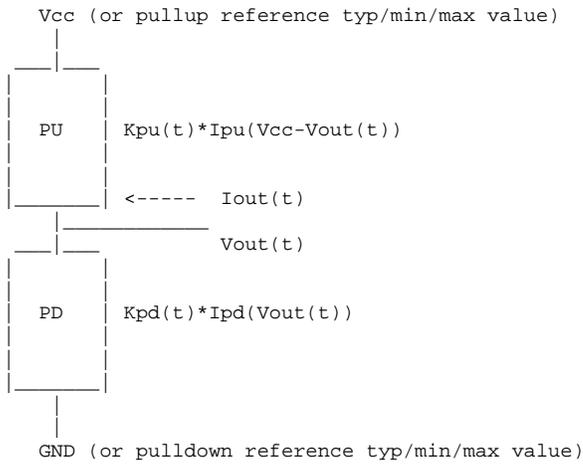


For each of these extractions, the corresponding [GND Clamp] and [POWER Clamp] currents need to be removed. Normally these are negligible. However, if on-die terminators exist, the extra currents that are associated with them should be removed from the [ISSO PD] and [ISSO PU] tables. The process details are not discussed here, but need to be solved by the modeler. Such details may depend upon the contents of the [GND Clamp] and [POWER Clamp] tables and the [GND Clamp Reference] and [POWER Clamp Reference] selections.

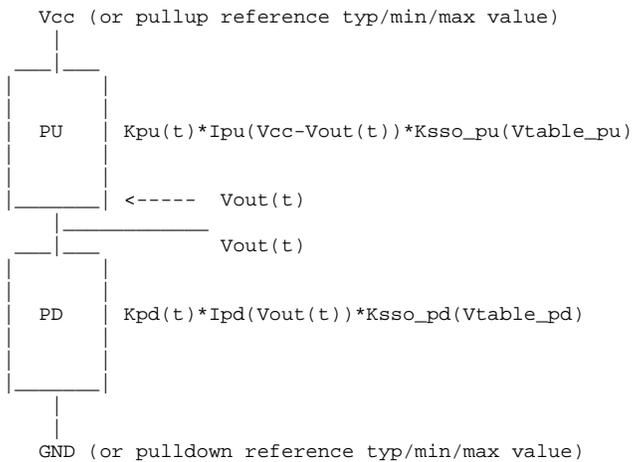
Currents are considered positive when their direction is into the component.

Other Notes: Simulators can use such tables to calculate modulation coefficients to modulate the original pulldown and pullup currents when a voltage variation on the pullup and pulldown reference nodes is revealed during power and/or ground bounce, and/or SSO simulation events.

To describe the modulation coefficients, a reference algorithm to generate an output response producing $V_{out}(t)$ for a given load including clamp currents that requires an $I_{out}(t)$ is shown in terms of pullup table currents $I_{pu}(V_{cc}-V_{out}(t))$ and pulldown table currents $I_{pd}(V_{out}(t))$.



When the supplies are modulated during simulation, the modulation coefficients $K_{sso_pu}(V_{table_pu})$ and $K_{sso_pd}(V_{table_pd})$ modify the equations as shown:



The V_{table_pd} and V_{table_pu} values may change at each time step. The $K_{sso_pd}(V_{table_pd})$ and $K_{sso_pu}(V_{table_pu})$ values are derived from the dynamic reference voltage variation and [ISSO PD] and [ISSO PU] table entries according to the formulas below:

$Ksso_pd(Vtable_pd) = Isso_pd(Vtable_pd)/Isso_pd(0)$

$Ksso_pu(Vtable_pu) = Isso_pu(Vtable_pu)/Isso_pu(0)$

Note that the extraction setup equates the currents for each column at $Vtable = 0$ lines to the corresponding pulldown and pullup table currents:

$Isso_pd(0) = Ipd(Vcc)$

$Isso_pu(0) = Ipu(Vcc)$

where Vcc are the *typ/min/max* values for the corresponding *typ/min/max* columns.

For example, for a *typ/min/max [Voltage Range]* of 5.0V, 4.5V and 5.5V, and with the negative reference set to GND, the $Isso_pu(0)$ and $Isso_pupd(0)$ values for *typ/min/max* should be ~~as~~ equal to the column values as shown:

	typ	min	max
$Isso_pd(0)$	$Ipd(5.0)$	$Ipd(4.5)$	$Ipd(5.5)$
$Isso_pu(0)$	$Ipu(5.0)$	$Ipu(4.5)$	$Ipu(5.5)$

With no modulation, $Ksso_pd(0) = 1$ and $Ksso_pu(0) = 1$. However, if during simulation of the typical corner the Vcc voltage drops from 5.0 to 4.7, then $Vtable_pu = 5.0 - 4.7 = 0.3$, and $Ksso_pu(0.3)$ is calculated. If at the same time the ground reference voltage at the buffer increases to 0.2 V, then $Ksso_pd(0.2)$ is calculated. These two modulation factors are used in the reference model calculations to account for gate modulation effects associated with both output transistors.

These modulation factors are updated at each time step.

Note, the [ISSO PD] and [ISSO PU] keywords are designed for CMOS technology and may not be appropriate for bipolar or ECL technologies. A single [ISSO PU] or [ISSO PD] keyword table is appropriate for open technologies such as *Open_drain*, *Open_source*, *Open_sink*, etc.

As a minor source of error, actual modulation effects may lag slightly from simulated modulation effects due to internal delays within the physical device.

Assume [Voltage Range] is ~~s~~-1.8V (*typ*), 1.7V (*min*) and 1.95V (*max*).

The table voltage entries are relative to the *typ/min/max* of the corresponding reference voltage for each table.

[ISSO_PD] | Relative to the [Pulldown Reference] voltage

Voltage	I(typ)	I(min)	I(max)
-1.8V	10.0m	7.0m	13.0m
.			
.			
-0.5V	24.0m	18.0m	31.0m
-0.2V	27.0m	20.0m	37.0m
0.0V	25.0m	19.0m	34.0m
0.2V	18.0m	13.0m	26.0m
0.5V	10.0m	7.0m	16.0m
0.7V	5.0m	3.0m	9.0m
1.0V	1.0m	0.7m	3.0m
.			
.			
1.8V	0.0m	0.0m	0.0m

[ISSO_PU] | Relative to the [Pullup Reference] voltage)

Voltage	I(typ)	I(min)	I(max)
-1.8V	-10.0m	-9.0m	-14.0m
.			
.			
-0.6V	-28.0m	-19.0m	-40.0m
-0.4V	-31.0m	-22.0m	-43.0m
-0.2V	-29.0m	-21.0m	-40.0m
0.0V	-27.0m	-19.0m	-38.0m
0.2V	-21.0m	-14.0m	-31.0m
0.4V	-14.0m	-9.0m	-22.0m
.			
.			
1.8V	0.0m	0.0m	0.0m

=====

Keywords: [Rgnd], [Rpower], [Rac], [Cac]

Required: Yes, if they exist in the model

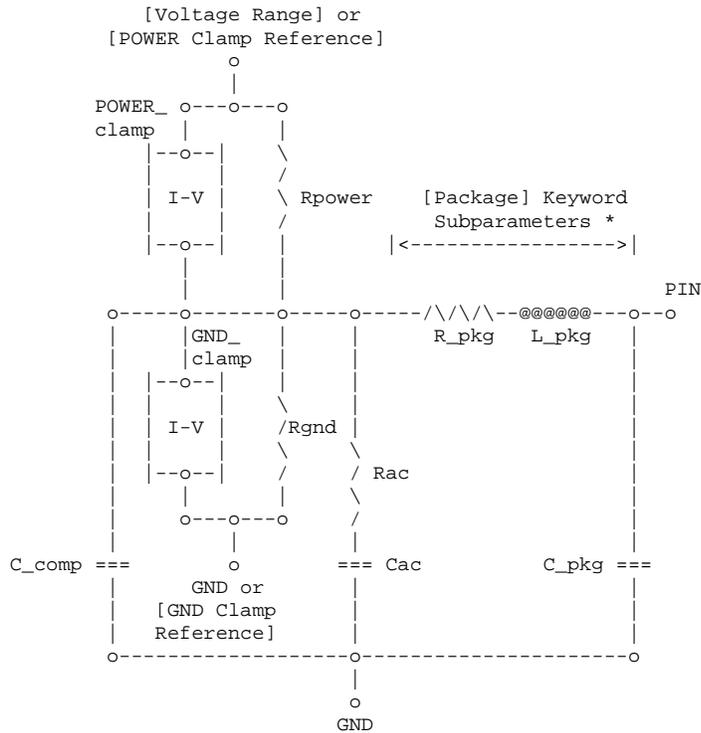
Description: The data for these keywords define the resistance values of Rgnd and Rpower connected to GND and the POWER pins, respectively, and the resistance and capacitance values for an AC terminator.

Usage Rules: For each of these keywords, the three columns hold the typical, minimum, and maximum resistance values. The three entries for R(typ), R(min), and R(max), or the three entries for C(typ), C(min), and C(max) must be placed on a single line and must be separated by at least one white space. All three columns are required under these keywords. However, data is only required in the typical column. If minimum and/or maximum values are not available, the reserved word "NA" must be used indicating the R(typ) or C(typ) value by default. Note that only one instance of any one of these keywords is permitted within any single [Model]. For example, [Rgnd] may not be used twice under the same [Model] description.

Other Notes: It should be noted that [Rpower] is connected to 'Vcc' and [Rgnd] is connected to 'GND'. However, [GND Clamp Reference] voltages, if defined, apply to [Rgnd]. [POWER Clamp Reference] voltages, if defined, apply to [Rpower]. Either or both [Rgnd] and [Rpower] may be defined and may coexist with [GND Clamp] and [POWER Clamp] tables. If the terminator consists of a series R and C (often referred to as either an

AC or RC terminator), then both [Rac] and [Cac] are required. When [Rgnd], [Rpower], or [Rac] and [Cac] are specified, the Model_type must be Terminator.

|<-----TERMINATOR Model----->|



* Note: More advanced package parameters are available within this standard, including more detailed power and ground net descriptions.

variable	R(typ)	R(min)	R(max)	
[Rgnd]	330ohm	300ohm	360ohm	Parallel Terminator
[Rpower]	220ohm	200ohm	NA	
[Rac]	30ohm	NA	NA	
variable	C(typ)	C(min)	C(max)	
[Cac]	50pF	NA	NA	AC terminator

```

=====
Keywords: [On], [Off]
Required: Yes, both [On] and [Off] for Series_switch Model_types only
Description: The 'On' state electrical models are positioned under [On].
The 'Off' state electrical models are positioned under [Off].
Usage Rules: These keywords are only valid for Series_switch Model_types.
Only keywords associated with Series_switch electrical models
are permitted under [On] or [Off]. The Series electrical
models describe the path for one state only and do not use
the [On] and [Off] keywords.

In Series_switch models, [On] or [Off] must be positioned
before any of the [R Series], [L Series], [Rl Series],
[C Series], [Lc Series], [Rc Series], [Series Current],
and [Series MOSFET] keywords. There is no provision for
any of these keywords to be defined once, but to apply to
both states.
=====
[On]
... On state keywords such as [R Series], [Series Current], [Series MOSFET]
[Off]
... Off state keywords such as [R Series], [Series Current]
=====
Keywords: [R Series], [L Series], [Rl Series], [C Series], [Lc Series],
[Rc Series]
Required: Yes, if they exist in the model
Description: The data for these keywords allow the definition of Series or
Series_switch R, L or C paths.
Usage Rules: For each of these keywords, the three columns hold the
typical, minimum, and maximum resistance values. The three
entries must be placed on a single line and must be separated
by at least one white space. All three columns are required
under these keywords. However, data is only required in the
typical column. If minimum and/or maximum values are not
available, the reserved word "NA" must be used.

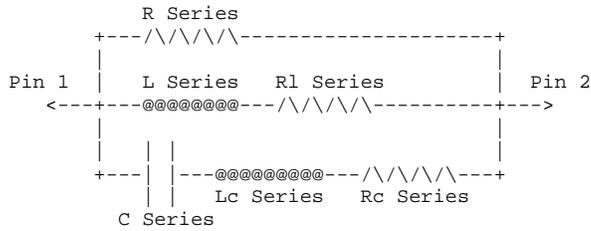
Note that only one instance of any one of these keywords is
permitted within any single [On] or [Off] keyword for [Model]s
of type Series_switch. For example, [L Series] may not be
used twice under the same [Off] description. Similarly, only
one instance of any one of these keyword is permitted within
any single [Model] of type Series.

Other Notes: This series RLC model is defined to allow IBIS to model simple
passive models and/or parasitics.

These keywords are valid only for Series or Series_switch
Model_types.

The model is:

```



[Rl Series] shall be defined only if [L Series] exists.
[Rl Series] is 0 ohms if it is not defined in the path.

[Rc Series] and [Lc Series] shall be defined only if
[C Series] exists. [Rc Series] is 0 ohms if it is not
defined in the path. [Lc Series] is 0 henries if it is
not defined in the path.

C_comp values are ignored for series models.

variable	R(typ)	R(min)	R(max)	
[R Series]	8ohm	6ohm	12ohm	
variable	L(typ)	L(min)	L(max)	
[L Series]	5nH	NA	NA	
variable	R(typ)	R(min)	R(max)	
[Rl Series]	4ohm	NA	NA	
variable	C(typ)	C(min)	C(max)	The other elements
[C Series]	50pF	NA	NA	are 0 impedance

Keyword: [Series Current]

Required: Yes, if they exist in the model

Description: The data points under this keyword define the I-V tables for voltages measured at Pin 1 with respect to Pin 2. Currents are considered positive if they flow into Pin 1. Pins 1 and 2 are listed under the [Series Pin Mapping] keyword under columns [Series Pin Mapping] and pin_2, respectively.

Usage Rules: The first column contains the voltage value, and the remaining columns hold the typical, minimum, and maximum current values. The four entries, Voltage, I(typ), I(min), and I(max) must be placed on a single line and must be separated by at least one white space.

All four columns are required under these keywords. However, data is only required in the typical column. If minimum and/or maximum current values are not available, the reserved word "NA" must be used. "NA" can be used for currents in the typical column, but numeric values MUST be specified for the first and last voltage points on any I-V table. Each I-V table must have at least 2, but not more than 100 rows.

Other Notes: There is no monotonicity requirement. However the model supplier should realize that it may not be possible to derive a behavioral model from non-monotonic data. This keyword is valid only for Series or Series_switch Model_types.

The model is:

```

          Table Current
          ----->
          + Table Voltage -
          Pin 1 |-----| Pin 2
          <---+         +--->
              |-----|

```

C_comp values are ignored for [Series Current] models.

[Series Current]

Voltage	I(typ)	I(min)	I(max)
-5.0V	-3900.0m	-3800.0m	-4000.0m
-0.7V	-80.0m	-75.0m	-85.0m
-0.6V	-22.0m	-20.0m	-25.0m
-0.5V	-2.4m	-2.0m	-2.9m
-0.4V	0.0m	0.0m	0.0m
5.0V	0.0m	0.0m	0.0m

Keyword: [Series MOSFET]

Required: Yes, for series MOSFET switches

Description: The data points under this keyword define the I-V tables for voltages measured at Pin 2 for a given Vds setting. Currents are considered positive if they flow into Pin 1. Pins 1 and 2 are listed under the [Series Pin Mapping] keyword under [Series Pin Mapping] and pin_2 columns, respectively.

Sub-Params: Vds

Usage Rules: The first column contains the voltage value, and the three remaining columns hold the typical, minimum, and maximum current values. The four entries, Voltage, I(typ), I(min), and I(max) must be placed on a single line and must be separated by at least one white space.

All four columns are required under this keyword. However, data is only required in the typical column. If minimum and/or maximum current values are not available, the reserved word "NA" must be used. "NA" can be used for currents in the typical column, but numeric values MUST be specified for the first and last voltage points on any I-V table. Each I-V table must have at least 2, but not more than 100 rows.

Other Notes: There is no monotonicity requirement. However the model supplier should realize that it may not be possible to derive a behavioral model from non-monotonic data.

$$ids = f(vds).$$

This functional relationship depends on the actual source voltage V_s and can be expressed in terms of the corresponding table currents associated with V_s (and expressed as a function of V_{table}).

If only one [Series MOSFET] table is supplied (as a first order approximation), the functional relationship is assumed to be linearly related to the table drain to source current, I_{ds} , for the given V_{ds} subparameter value and located at the existing gate to source voltage value V_{table} . This table current is denoted as $I_{ds}(V_{table}, V_{ds})$. The functional relationship becomes:

$$ids = I_{ds}(V_{table}, V_{ds}) * vds/V_{ds}.$$

More than one [Series MOSFET] table under a [Model] keyword is permitted. However, the usage of this data is simulator dependent. Each table must begin with the [Series MOSFET] keyword and V_{ds} subparameter. Each successive [Series MOSFET] table must have a different subparameter value for V_{ds} . The number of tables for any specific [Model] must not exceed 100.

C_{comp} values are ignored for [Series MOSFET] models.

An NMOS Example

[On]

[Series MOSFET]

$V_{ds} = 1.0$

Voltage	I(typ)	I(min)	I(max)	
5.0V	257.9m	153.3m	399.5m	Defines the I_{ds} current as a function of V_{table} , for $V_{ds} = 1.0$
4.0V	203.0m	119.4m	317.3m	
3.0V	129.8m	74.7m	205.6m	
2.0V	31.2m	16.6m	51.0m	
1.0V	52.7p	46.7p	56.7p	
0.0V	0.0p	0.0p	0.0p	

| A PMOS/NMOS Example

| [On]

| [Series MOSFET]

| Vds = 0.5

	Voltage	I(typ)	I(min)	I(max)
0.0	48.6ma	NA	NA	
0.1	47.7ma	NA	NA	
0.2	46.5ma	NA	NA	
0.3	46.1ma	NA	NA	
0.4	45.3ma	NA	NA	
0.5	44.4ma	NA	NA	
0.6	42.9ma	NA	NA	
0.7	42.3ma	NA	NA	
0.8	41.2ma	NA	NA	
0.9	39.7ma	NA	NA	
1.0	38.6ma	NA	NA	
1.1	38.1ma	NA	NA	
1.2	38.6ma	NA	NA	
1.3	40.7ma	NA	NA	
1.4	45.0ma	NA	NA	
1.5	49.2ma	NA	NA	
1.6	52.3ma	NA	NA	
1.7	55.1ma	NA	NA	
1.8	57.7ma	NA	NA	
1.9	58.8ma	NA	NA	
2.0	58.9ma	NA	NA	
2.1	59.2ma	NA	NA	
2.2	59.3ma	NA	NA	
2.3	59.4ma	NA	NA	
2.4	59.8ma	NA	NA	
2.5	60.1ma	NA	NA	
2.6	61.8ma	NA	NA	
2.7	62.3ma	NA	NA	
2.8	63.4ma	NA	NA	
2.9	64.4ma	NA	NA	
3.0	65.3ma	NA	NA	
3.1	66.0ma	NA	NA	
3.2	66.8ma	NA	NA	
3.3	68.2ma	NA	NA	

=====
Keyword: [Ramp]

Required: Yes, except for inputs, terminators, Series and Series_switch model types

Description: Defines the rise and fall times of a buffer. The ramp rate does not include packaging but does include the effects of the C_comp or C_comp_* parameters.

Sub-Params: dV/dt_r, dV/dt_f, R_load

Usage Rules: The rise and fall time is defined as the time it takes the output to go from 20% to 80% of its final value. The ramp rate is defined as:

$$\frac{dV}{dt} = \frac{\text{20\% to 80\% voltage swing}}{\text{Time it takes to swing the above voltage}}$$

The ramp rate must be specified as an explicit fraction and must not be reduced. The [Ramp] values can use "NA" for the min and max values only. The R_load subparameter is optional if the default 50 ohm load is used. The R_load subparameter is required if a non-standard load is used.

```

-----
[Ramp]
| variable      typ          min          max
dV/dt_r        2.20/1.06n    1.92/1.28n    2.49/650p
dV/dt_f        2.46/1.21n    2.21/1.54n    2.70/770p
R_load = 300ohms

```

```

=====

```

```

Keywords: [Rising Waveform], [Falling Waveform]
Required: No
Description: Describes the shape of the rising and falling edge waveforms
of a driver.
Sub-Params: R_fixture, V_fixture, V_fixture_min, V_fixture_max, C_fixture,
L_fixture, R_dut, L_dut, C_dut
Usage Rules: Each [Rising Waveform] and [Falling Waveform] keyword
introduces a table of voltage versus time points that describe
the shape of an output waveform. These voltage versus time
points are taken under the conditions specified by the
R/L/C/V_fixture and R/L/C_dut subparameters. The table itself
consists of one column of time points, then three columns of
voltage points in the standard typ, min, and max format. The
four entries must be placed on a single line and must be
separated by at least one white space. All four columns are
required. However, data is only required in the typical
column. If minimum or maximum data is not available, use the
reserved word "NA". The first value in the time column need
not be '0'. Time values must increase as one parses down the
table. The waveform table can contain a maximum of 1000 data
rows. A maximum of 100 waveform tables are allowed per model.

```

Note that for backward compatibility, the existing [Ramp] keyword is still required. The data in the waveform table is taken with the effects of the C_comp parameter included.

A waveform table must include the entire waveform; i.e., the first entry (or entries) in a voltage column must be the DC voltage of the output before switching and the last entry (or entries) of the column must be the final DC value of the output after switching. Each table must contain at least two entries. Thus, numerical values are required for the first and last entries of any column containing numerical data.

The data in all of the waveform tables should be time correlated. In other words, the edge data in each of the tables (rising and falling) should be entered with respect to a single point in time when the input stimulus is assumed to have initiated a logic transition. All waveform extractions should reference a common input stimulus time in order to provide a sufficiently accurate alignment of waveforms. The first line in each waveform table should be assumed to be the reference point in time corresponding to a logic transition. For example, assume that some internal rising edge logic transition starts at time = 0. Then a rising edge voltage-time table might be created starting at time zero. The first several table entries might be some "lead-in" time caused by some undefined internal buffer delay before the voltage actually starts transitioning. The falling edge stimulus (for the purpose of setting reference time for the voltage-time table) should also start at time = 0. And, the falling edge voltage-time table would be created starting at time zero with a possibly different amount of "lead-in" time caused by a possibly different but corresponding falling edge

modeling.

All tables assume that the die capacitance is included.
Potential numerical problems associated with processing the
data using the effective C_comp (or C_comp_* values as
appropriate) for effective die capacitance may be handled
differently among simulators.

[Rising Waveform]

R_fixture = 50

V_fixture = 0.0

C_fixture = 50p | These are shown, but are generally not recommended

L_fixture = 2n

C_dut = 7p

R_dut = 1m

L_dut = 1n

Time	V(typ)	V(min)	V(max)
0.0000s	25.2100mV	15.2200mV	43.5700mV
0.2000ns	2.3325mV	-8.5090mV	23.4150mV
0.4000ns	0.1484V	15.9375mV	0.3944V
0.6000ns	0.7799V	0.2673V	1.3400V
0.8000ns	1.2960V	0.6042V	1.9490V
1.0000ns	1.6603V	0.9256V	2.4233V
1.2000ns	1.9460V	1.2050V	2.8130V
1.4000ns	2.1285V	1.3725V	3.0095V
1.6000ns	2.3415V	1.5560V	3.1265V
1.8000ns	2.5135V	1.7015V	3.1600V
2.0000ns	2.6460V	1.8085V	3.1695V
...			
10.0000ns	2.7780V	2.3600V	3.1670V

[Falling Waveform]

R_fixture = 50

V_fixture = 5.5

V_fixture_min = 4.5

V_fixture_max = 5.5

Time	V(typ)	V(min)	V(max)
0.0000s	5.0000V	4.5000V	5.5000V
0.2000ns	4.7470V	4.4695V	4.8815V
0.4000ns	3.9030V	4.0955V	3.5355V
0.6000ns	2.7313V	3.4533V	1.7770V
0.8000ns	1.8150V	2.8570V	0.8629V
1.0000ns	1.1697V	2.3270V	0.5364V
1.2000ns	0.7539V	1.8470V	0.4524V
1.4000ns	0.5905V	1.5430V	0.4368V
1.6000ns	0.4923V	1.2290V	0.4266V
1.8000ns	0.4639V	0.9906V	0.4207V
2.0000ns	0.4489V	0.8349V	0.4169V
...			
10.0000ns	0.3950V	0.4935V	0.3841V

=====
Keyword: [Composite Current]

Required: No

Description: Describes the shape of the rising and falling edge current waveforms from the power reference terminal of the buffer.

Usage Rules: The [Composite Current] keyword is positioned under the last row of the [Rising Waveform] table (for rising waveform currents) or [Falling Waveform] table (for falling waveform currents). The keywords are followed by a table of current versus time rows (I-T) that describe the shape of a current waveform. These I-T tables inherit the test fixture load of

the [Rising Waveform] or [Falling Waveform] R/L/C/V_fixture and R/L/C_dut subparameters.

The [Composite Current] keyword is optional. It can be omitted, or it can be positioned under some or all of the rising and falling waveform tables.

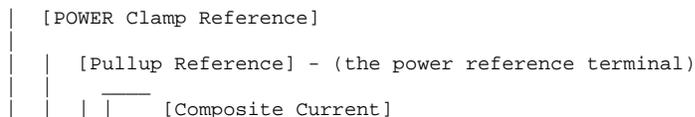
The table itself consists of one column of time points, then three columns of current points in the standard typ, min, and max format. The four entries must be placed on a single line and must be separated by at least one white space. All four columns are required. However, data is only required in the typical column. If minimum or maximum data is not available, use the reserved word "NA". The first value in the time column need not be '0'. Time values must increase as one parses down the table. The waveform table can contain a maximum of 1000 data points.

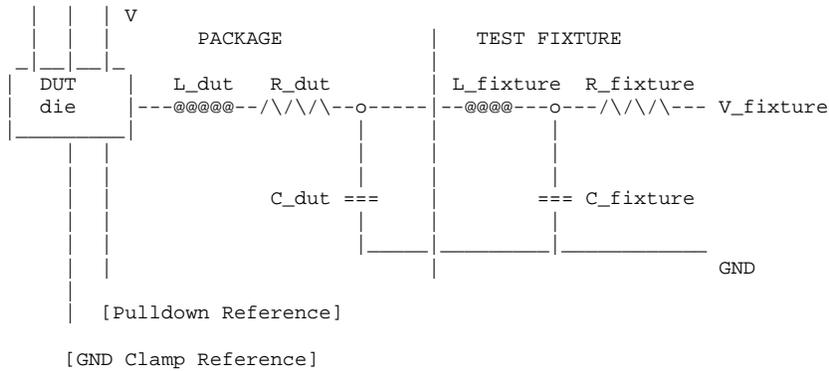
The I-T table data must be time-correlated with the V-T data above it. That is, the I-T data should be entered with respect to the same point in time that the V-T table above it references and for the given *_fixture load. See the [Rising Waveform] and [Falling Waveform] section for more information about the common input stimulus time. Note that additional "lead-in" time may need to be added to all V-T waveforms, as a portion of the I-T waveform data describes pre-driver current that may occur earlier in time than the V-T rising or falling edge transitions above it. That is, the currents documented in the I-T table correspond to the voltages in the V-T table at the identical time points and for the given *_fixture load.

The diagram below illustrates a general configuration from which a [Rising Waveform] or [Falling Waveform] is extracted. The DUT die shows all of the available power and ground pin reference voltage terminals. For many buffers, only one power pin and one common ground pin terminal are used. The absolute GND is the reference for the V_fixture voltage and the package model equivalent network. It can also serve as a reference for C_comp, unless C_comp is optionally split into component attached to the other reference voltages.

The [Composite Current] I-T table includes all of the current through the [Pullup Reference] terminal. If the [POWER Clamp Reference] terminal is the same as the [Pullup Reference] terminal (according to the [Pin Mapping] keyword table), the [Composite Current] entries include the currents through both the [POWER Clamp] and [Pullup] sections of the DUT (for example, when an on-die terminator is connected to the power reference terminal). Note that the terminals are shown in terms of separately defined reference voltages, but still exist even if they are defined with default [Voltage Range] or 0 V settings.

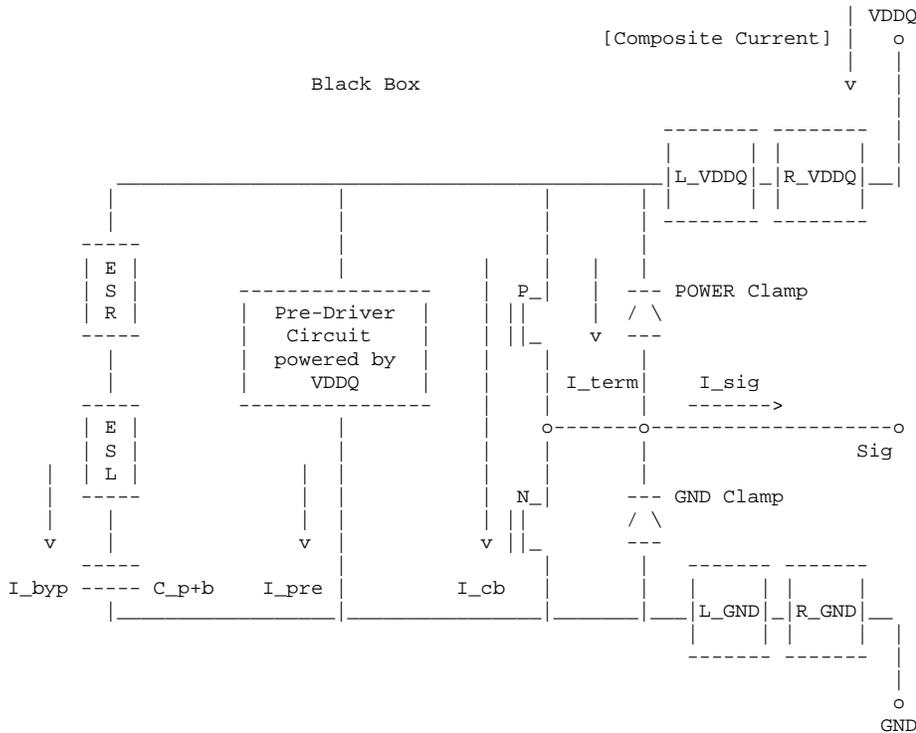
[External Reference] - (used only for non-driver modes)





For *_ECL model types, the [Pullup] and [Pulldown] sections of the DUT share the same power reference terminal. The [Composite Current] includes the currents through both sections.

Other Notes: The diagram below documents some expected internal paths for a useful special case where only one common power pin (VDDQ) and one common ground exists (GND).



Other elements in a more detailed typical (per buffer) model are:

- I_byp - Bypass current
- I_pre - Pre-Driver current
- I_cb - Crow-bar current
- I_term - Termination current (optional)
- L_VDDQ - On-die inductance of I/O Power
- R_VDDQ - On-die resistance of I/O Power
- L_GND - On-die inductance of Ground
- R_GND - On-die resistance of Ground
- C_p+b - Bypass + Parasitic Capacitance
- ESR - Equivalent Series Resistance for on-die Decap
- ESL - Equivalent Series Inductance for on-die Decap

While the [Composite Current] already includes the buffer I_byp current, some Series model type elements may be used to document an equivalent bypass impedance to improve simulation results. Such an equivalent impedance can be extracted on a per buffer basis, but summed and expressed as a total equivalent impedance between the power and ground pins of the component with the Series model type keywords, including [C Series], [Lc Series], [Rc Series] and [R Series] under a separate [Model]. These elements are connected using the [Series Pin Mapping] keyword. Paths between several voltage rails can be modeled in this manner. The [Pin Mapping] keyword documents what buffers share common and often isolated power rails.

The C_p+b value might include the detailed distribution of C_comp when C_comp* is attached to several rails. If the C_comp value and the C_p+b value are about the same magnitude, the [C Series] value should be adjusted to avoid double counting.

The power reference terminal (VDDQ) is usually the [Pullup Reference], or the default [Voltage Range] terminal. The [Pulldown Reference] terminal is usually at the GND connection.

The [Composite Current] can still be defined for model types without the [Pullup] keywords (such as Open_drain) because the [Pullup Reference] or [Voltage Range] are still required. Pre-driver and other internal paths still can exist.

In most cases six [Composite Current] tables are recommended for accurate modeling. The first four tables correspond to the recommended fixture conditions for [Rising Waveform] and [Falling Waveform] tables (normally 50 ohm loads to Vdd and GND). Two additional waveforms for no load conditions (such as with an R_fixture of 1.0 Megaohm) are useful. However, some EDA tools process only the first four waveforms. So the additional open load waveforms for I-T tables should be in [Rising Waveform] and [Falling Waveform] tables that are positioned after the other V-T tables to maintain the best output response simulation accuracy.

For Open_drain and Open_source technologies, two tables are often specified (one for the [Rising Waveform] and one for the [Falling Waveform]). The tables should be positioned in front of any other optional waveform tables because some EDA tools process just the first two tables. Also, the open load tables may not yield meaningful simulations unless internal on-die terminators exist.

When the [Model] is configured for differential operation with the [Diff Pin] keyword, the individual I-T currents for each [Model] are used as an approximation, and may not accurately conform to the measured currents under actual differential operation.

The [Composite Current] table can be derived from currents measured at the [Pulldown Reference] (GND) node, but adjusted for the current flowing through the output pin and at other terminals.

The [Pin Mapping] keyword is used to document how buffers with common voltage rails are connected. The effective impedances for each buffer between the [Pullup Reference] and [Pulldown Reference] are then combined to form the total effective impedance between the voltage rails.

The [Composite Current] keyword does not accurately document the effects of controlled switching buffers such as those with [Submodel] or [Driver Schedule] keywords. The currents associated with [Submodel] switching under specified test load conditions can occur at different times under other load conditions. The scheduled models under the [Driver Schedule] keyword can be attached to different voltage rails in an

undocumented manner.

[Rising Waveform]

R_fixture = 50.0

V_fixture = 0.0

...
... | Rising Waveform table
...

[Composite Current]

Time	I(typ)	I(min)	I(max)
0	4.243E-05	NA	NA
4.00E-11	4.244E-05	NA	NA
8.00E-11	4.242E-05	NA	NA
1.20E-10	4.265E-05	NA	NA
1.60E-10	3.610E-05	NA	NA
2.00E-10	3.903E-03	NA	NA

..
..

3.80E-09	2.012E-02	NA	NA
3.84E-09	2.012E-02	NA	NA
3.88E-09	2.012E-02	NA	NA
3.92E-09	2.012E-02	NA	NA
3.96E-09	2.012E-02	NA	NA
4.00E-09	2.012E-02	NA	NA

[Falling Waveform]

R_fixture = 50.0

V_fixture = 1.8

...
... | Falling Waveform table
...

[Composite Current]

Time	I(typ)	I(min)	I(max)
0	4.302E-05	NA	NA
4.00E-11	4.299E-05	NA	NA
8.00E-11	4.304E-05	NA	NA
1.20E-10	4.287E-05	NA	NA
1.60E-10	4.782E-05	NA	NA
2.00E-10	1.459E-04	NA	NA

..
..
..

3.80E-09	4.933E-05	NA	NA
3.84E-09	5.211E-05	NA	NA
3.88E-09	5.490E-05	NA	NA
3.92E-09	5.441E-05	NA	NA
3.96E-09	4.842E-05	NA	NA
4.00E-09	4.244E-05	NA	NA

... etc.

```

-----
Keyword: [Test Data]
Required: No
Description: Indicates the beginning of a set of Golden Waveforms and
references the conditions under which they were derived. An
IBIS file may contain any number of [Test Data] sections
representing different driver and load combinations.
Golden Waveforms are a set of waveforms simulated
using known ideal test loads. They are useful in verifying
the accuracy of behavioral simulation results against the
transistor level circuit model from which the IBIS model
parameters originated.
Sub Params: Test_data_type, Driver_model, Driver_model_inv, Test_load
Usage Rules: The name following the [Test Data] keyword is required. It
allows a tool to select which data to analyze.

The Test_data_type subparameter is required, and its value
must be either "Single_ended" or "Differential." The value of
Test_data_type must match the value of Test_load_type found in
the load called by Test_load.

The Driver_model subparameter is required. Its value
specifies the "device under test" and must be a valid [Model]
name. Driver_model_inv is only legal if Test_data_type is
Differential. Driver_model_inv is not required but may be
used in the case in which a differential driver uses two
different models for the inverting and non-inverting pins.

The Test_load subparameter is required and indicates which
[Test Load] was used to derive the Golden Waveforms. It must
reference a valid [Test Load] name.
-----

```

```

{Test Data} Data1
Test_data_type Single_ended
Driver_model Buffer1
Test_load Load1
-----

```

```

-----
Keywords: [Rising Waveform Near], [Falling Waveform Near],
[Rising Waveform Far], [Falling Waveform Far],
[Diff Rising Waveform Near], [Diff Falling Waveform Near],
[Diff Rising Waveform Far], [Diff Falling Waveform Far]
Required: At least one Rising/Falling waveform is required under the
scope of the [Test Data] keyword.
Description: Describes the shape of the rising and falling Golden Waveforms
of a given driver and a given [Test Load] measured at the
driver I/O pad (near) or receiver I/O pad (far). A model
developer may use the [Rising Waveform Near/Far] and [Falling
Waveform Near/Far] keywords to document Golden Waveforms whose
purpose is to facilitate the correlation of reference
waveforms and behavioral simulations.
Usage Rules: The process, temperature, and voltage conditions under which
the Golden Waveforms are generated must be identical to those
-----

```

~~used to generate the I-V and V-T tables. The Golden Waveforms must be generated using unpackaged driver and receiver models. The simulator must NOT use the Golden Waveform tables in the construction of its internal stimulus function.~~

~~The tables must conform to the format described under the [Rising Waveform] and [Falling Waveform] keywords.~~

~~Both differential and single-ended waveforms are allowed~~

~~regardless of the value of Test_data_type. If Test_data_type is Single_ended then differential waveforms will be ignored. If Test_data_type is Differential, a single ended waveform refers to the model specified by Driver_model and the non-inverting driver output.~~

~~{Rising Waveform Par}~~

Time	V(typ)	V(min)	V(max)
0.0000s	25.2100mV	15.2200mV	43.5700mV
0.2000ns	2.3325mV	8.5090mV	23.4150mV
0.4000ns	0.1484V	15.9275mV	0.3944V
0.6000ns	0.7799V	0.2673V	1.3400V
0.8000ns	1.2960V	0.6042V	1.9490V
1.0000ns	1.6603V	0.9256V	2.4233V
1.2000ns	1.9460V	1.2050V	2.8130V
1.4000ns	2.1285V	1.3725V	3.0095V
1.6000ns	2.3415V	1.5560V	3.1265V
1.8000ns	2.5135V	1.7015V	3.1600V
2.0000ns	2.6460V	1.8085V	3.1695V
...			
10.0000ns	2.7780V	2.3600V	3.1670V

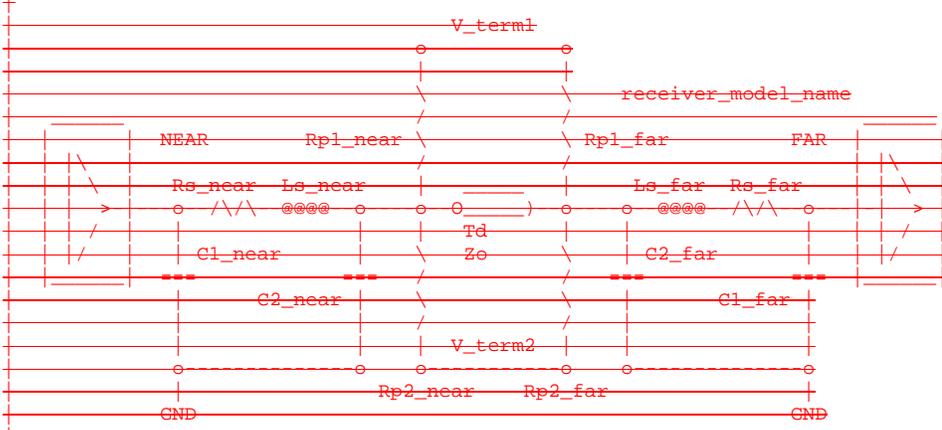
~~{Falling Waveform Par}~~

Time	V(typ)	V(min)	V(max)
0.0000s	5.0000V	4.5000V	5.5000V
0.2000ns	4.7470V	4.4695V	4.8815V
0.4000ns	3.9030V	4.0955V	3.5355V
0.6000ns	2.7313V	3.4533V	1.7770V
0.8000ns	1.8150V	2.8570V	0.8629V
1.0000ns	1.1697V	2.3270V	0.5364V
1.2000ns	0.7539V	1.8470V	0.4524V
1.4000ns	0.5905V	1.5430V	0.4368V
1.6000ns	0.4923V	1.2290V	0.4266V
1.8000ns	0.4639V	0.9906V	0.4207V
2.0000ns	0.4489V	0.8349V	0.4169V
...			
10.0000ns	0.3950V	0.4935V	0.3841V

Keyword: [Test Load]
Required: No
Description: Defines a generic test load network and its associated electrical parameters for reference by Golden Waveforms under the [Test Data] keyword. The Golden Waveform tables correspond to a given [Test Load] which is specified by the Test_load subparameter under the [Test Data] keyword.
Sub-Params: Test_load_type, C1_near, Rs_near, Ls_near, C2_near, Rp1_near,

Rp2_near, Td, Zo, Rp1_far, Rp2_far, C2_far, Ls_far, Rs_far, C1_far, V_term1, V_term2, Receiver_model, Receiver_model_inv, R_diff_near, R_diff_far.
Usage Rules: The Test_load_type subparameter is required, and its value must be either "Single_ended" or "Differential."

The subparameters specify the electrical parameters associated with a fixed generic test load. The diagram below describes the single_ended test load.
 All subparameters except Test_load_type are optional. If omitted, series elements are shorted and shunt elements are opened by default.



If the Td subparameter is present, then the Zo subparameter must also be present. If the Td subparameter is not present, then the simulator must remove the transmission line from the network and short the two nodes to which it was connected.

V_term1 defines the termination voltage for parallel termination resistors Rp1_near and Rp1_far. This voltage is not related to the [Voltage Range] keyword. If either Rp1_near or Rp1_far is used, then V_term1 must also be used.

V_term2 defines the termination voltage for parallel termination resistors Rp2_near and Rp2_far. If either Rp2_near or Rp2_far is used, then V_term2 must also be used.

=====
=====
Section 6a
=====

A D D S U B M O D E L D E S C R I P T I O N
=====

The [Add Submodel] keyword can be used under a top-level [Model] keyword to add special-purpose functionality to the existing top-level model. This section describes the structure of the top-level model and the submodel.

TOP-LEVEL MODEL:

When special-purpose functional detail is needed, the top-level model can call one or more submodels. The [Add Submodel] keyword is positioned after the initial set of required and optional subparameters of the [Model] keyword and among the keywords under [Model].

The [Add Submodel] keyword lists of name of each submodel and the permitted mode (Driving, Non-Driving or All) under which each added submodel is used.

SUBMODEL:

A submodel is defined using the [Submodel] keyword. It contains a subset of keywords and subparameters used for the [Model] keyword along with other keywords and subparameters that are needed for the added functionality.

The [Submodel] and [Submodel Spec] keywords are defined first since they are used for all submodels.

The only required subparameter in [Submodel] is Submodel_type to define the list of submodel types. No subparameters under [Model] are permitted under the [Submodel] keyword.

The following set of keywords that are defined under the [Model] keyword are supported by the [Submodel] keyword:

- [Pulldown]
- [Pullup]
- [GND Clamp]
- [POWER Clamp]
- [Ramp]
- [Rising Waveform]
- [Falling Waveform]

The [Voltage Range], [Pullup Reference], [Pulldown Reference], [GND Clamp Reference], and [POWER Clamp Reference] keywords are not permitted. The voltage settings are inherited from the top-level model.

These additional keywords are used only for the [Submodel] are documented in this section:

[Submodel Spec]
[GND Pulse Table]
[POWER Pulse Table]

The application of these keywords depends upon the Submodel_type entries listed below:

Dynamic_clamp
Bus_hold
Fall_back

Permitted keywords that are not defined for any of these submodel types are ignored. The rules for what set of keywords are required are found under the Dynamic Clamp, Bus Hold, and Fall Back headings of this section.

Keyword: [Submodel]
Required: No
Description: Used to define a submodel, and its attributes.
Sub-Params: Submodel_type
Usage Rules: Each submodel must begin with the keyword [Submodel]. The submodel name must match the one that is listed under an [Add Submodel] keyword and must not contain more than 20 characters. A .ibs file must contain enough [Submodel] keywords to cover all of the model names specified under the [Add Submodel] keyword.

Submodel_type subparameter is required and must be one of the following:

Dynamic_clamp, Bus_hold, Fall_back

The C_comp subparameter is not permitted under the [Submodel] keyword. The total effective die capacitance including the submodel contributions are provided in the top-level model.

Other Notes: The following list of keywords that are defined under the [Model] keyword can be used under [Submodel]: [Pulldown], [Pullup], [GND Clamp], [POWER Clamp], [Ramp], [Rising Waveform], and [Falling Waveform].

The following list of additional keywords can be used:
[Submodel Spec], [GND Pulse Table], and [POWER Pulse Table].

[Submodel] Dynamic_clamp1
Submodel_type Dynamic_clamp

```

-----
Keyword: [Submodel Spec]
Required: No
Description: The [Submodel Spec] keyword defines four columns under which
specification and information subparameters are defined for
submodels.
Sub-Params: V_trigger_r, V_trigger_f, Off_delay
Usage Rules: The [Submodel Spec] is to be used only with submodels.

The following subparameters are used:
V_trigger_r      Rising edge trigger voltage
V_trigger_f      Falling edge trigger voltage
Off_delay        Turn-off delay from V_trigger_r or
                 V_trigger_f

For each subparameter contained in the first column, the
remaining three hold its typical, minimum and maximum values.
The entries of typical, minimum and maximum be must be placed
on a single line and must be separated by at least one white
space. All four columns are required under the [Submodel
Spec] keyword. However, data is required only in the typical
column. If minimum and/or maximum values are not available,
the reserved word "NA" must be used to indicate the typical
value by default.

The values in the minimum and maximum columns usually
correspond to the values in the same columns for the inherited
top-level voltage range or reference voltages in the top-level
model. The V_trigger_r and V_trigger_f subparameters should
hold values in the minimum and maximum columns that correspond
to the voltage range or reference voltages of the top-level
model. The Off_delay subparameter, however, is an exception
to this rule because in some cases it may be completely or
or partially independent from supply voltages and/or
manufacturing process variations. Therefore the minimum and
maximum entries for the Off_delay subparameter should be
ordered simply by their magnitude.

Unless noted, each [Submodel Spec] subparameter is independent
of any other subparameter.

V_trigger_r, V_trigger_f rules:

The voltage trigger values for the rising and falling edges
provide the starting time when an action is initiated.

Off_delay rules:

The functionality of the Off_delay subparameter is to provide
an additional time related mechanism to turn off circuit
elements.
-----

```

```

Dynamic Clamp Example:
[Submodel Spec]
Subparameter      typ      min      max
V_trigger_r       3.6      2.9      4.3 | Starts power pulse table
V_trigger_f       1.4      1.2      1.6 | Starts gnd pulse table

Bus Hold Example:
[Submodel Spec]
Subparameter      typ      min      max
V_trigger_r       3.1      2.4      3.7 | Starts low to high
                                     | bus hold transition
V_trigger_f       1.8      1.6      2.0 | Starts high to low
                                     | bus hold transition

Bus_hold application with pullup structure triggered on and then clocked
off:
[Submodel Spec]
Subparameter      typ      min      max
V_trigger_r       3.1      2.4      3.7 | Low to high transition
                                     | triggers the turn on
                                     | process of the pullup
V_trigger_f       -10.0    -10.0    -10.0 | Not used, so trigger
                                     | voltages are set out
                                     | of range
Off_delay         5n      4n      6n   | Time from rising edge
                                     | trigger at which the
                                     | pullup turned off

```

```

=====
Dynamic Clamp:

When the Submodel_type subparameter under the [Submodel] keyword is set to
Dynamic_clamp, the submodel describes the dynamic clamp functionality.

The [GND Pulse Table] and [POWER Pulse Table] keywords are defined. An
example for a complete dynamic clamp model is provided.

=====
Keywords: [GND Pulse Table], [POWER Pulse Table]
Required: No
Description: Used to specify the offset voltage versus time of [GND Clamp]
and [POWER Clamp] tables within submodels.
Usage Rules: Each [GND Pulse Table] and [POWER Pulse Table] keyword
introduces a table of voltage vs. time points that describe
the shape of an offset voltage from the [GND Clamp Reference]
voltage (or default ground) or the [POWER Clamp Reference]
voltage (or default [Voltage Range] voltage). Note, these
voltage values are inherited from the top-level model.

The table itself consists of one column of time points, then
three columns of voltage points in the standard typ, min, and
max format. The four entries must be placed on a single line
and must be separated by at least one white space. All four
columns are required. However, data is only required in the
typical column. If minimum or maximum data is not available,
use the reserved word "NA". Time values must increase as one
parses down the table. The waveform table can contain of

```

maximum of 100 rows.

Each table must contain at least two entries. Thus, numerical values are required for the first and last entries of any column containing numerical data.

The voltage entries in both the [Gnd Pulse Table] and [POWER Pulse Table] tables are directly measured offsets. At each instance, the [Gnd Pulse Table] voltage is ADDED to the [GND Clamp] table voltages to provide the shifted table voltages. At each instance, the [POWER Pulse Table] voltage is SUBTRACTED (because of polarity conventions) from the [POWER Clamp] table voltages to provide the shifted table voltages.

Only one [GND Pulse Table] and one [POWER Pulse Table] are allowed per model.

The [GND Pulse Table] and [POWER Pulse Table] interact with [Submodel Spec] subparameters V_trigger_f and V_trigger_r. Several modes of operation exist based on whether a pulse table and its corresponding trigger subparameter are given. These modes are classified as triggered and static.

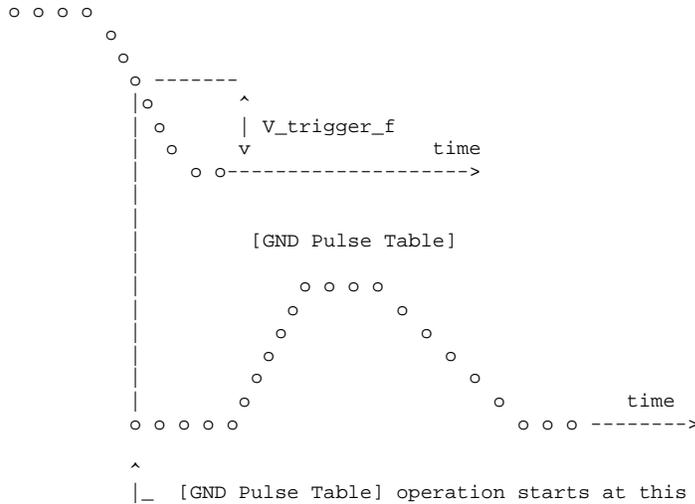
Triggered Mode:

For triggered mode a pulse table must exist and include the entire waveform; i.e., the first entry (or entries) in a voltage column must be equal to the last entry.

Also, a corresponding [Submodel Spec] V_trigger_* subparameter must exist. The triggered interaction is described:

The V_trigger_f subparameter under [Submodel Spec] is used to detect when the falling edge waveform at the die passes the trigger voltage. At that time the [Gnd Pulse Table] operation starts. Similarly, the V_trigger_r subparameter is used to detect when the rising edge waveform at the die passes the trigger voltage. At that time [POWER Pulse Table] operation starts. The [GND Pulse Table] dependency is shown below:

Waveform at Die



The V_trigger_r and [POWER Pulse Table] operate in a similar manner. When the V_trigger_r voltage value is reached on the rising edge, the [POWER Pulse Table] is started. Normally the offset voltage entries in the [POWER Pulse Table] are negative.

Static Mode:

When the [GND Pulse Table] keyword does not exist, but the added model [GND Clamp] table does exist, the added model [GND Clamp] is used directly. Similarly, when the [POWER Pulse Table] keyword does not exist, but the added model [POWER Clamp] table does exist, the added model [POWER Clamp] is used directly.

This mode provides additional fixed clamping to an I/O_* buffer or a 3-state buffer when it is used as a driver.

 Example of Dynamic_clamp Model with both dynamic GND and POWER clamps:

```
[Submodel]      Dynamic_Clamp_1
Submodel_type  Dynamic_clamp

[Submodel Spec]
Subparameter   typ      min      max
V_trigger_f    1.4      1.2      1.6 | Falling edge trigger
V_trigger_r    3.6      2.9      4.3 | Rising edge trigger

                typ      min      max
[Voltage Range] 5.0      4.5      5.5
Note, the actual voltage range and reference voltages are inherited from
the top-level model.
[GND Pulse Table]                                | GND Clamp offset table

Time          V(typ)    V(min)    V(max)
0             0         0         0
```

1e-9	0	0	0
2e-9	0.9	0.8	1.0
10e-9	0.9	0.8	1.0
11e-9	0	0	0

[GND Clamp]

| Table to be offset

Voltage	I(typ)	I(min)	I(max)
-5.000	-3.300e+01	-3.000e+01	-3.500e+01
-4.000	-2.300e+01	-2.200e+01	-2.400e+01
-3.000	-1.300e+01	-1.200e+01	-1.400e+01
-2.000	-3.000e+00	-2.300e+00	-3.700e+00
-1.900	-2.100e+00	-1.500e+00	-2.800e+00
-1.800	-1.300e+00	-8.600e-01	-1.900e+00
-1.700	-6.800e-01	-4.000e-01	-1.100e+00
-1.600	-2.800e-01	-1.800e-01	-5.100e-01
-1.500	-1.200e-01	-9.800e-02	-1.800e-01
-1.400	-7.500e-02	-7.100e-02	-8.300e-02
-1.300	-5.750e-02	-5.700e-02	-5.900e-02
-1.200	-4.600e-02	-4.650e-02	-4.550e-02
-1.100	-3.550e-02	-3.700e-02	-3.450e-02
-1.000	-2.650e-02	-2.850e-02	-2.500e-02
-0.900	-1.850e-02	-2.100e-02	-1.650e-02
-0.800	-1.200e-02	-1.400e-02	-9.750e-03
-0.700	-6.700e-03	-8.800e-03	-4.700e-03
-0.600	-3.000e-03	-4.650e-03	-1.600e-03
-0.500	-9.450e-04	-1.950e-03	-3.650e-04
-0.400	-5.700e-05	-2.700e-04	-5.550e-06
-0.300	-1.200e-06	-1.200e-05	-5.500e-08
-0.200	-3.000e-08	-5.000e-07	0.000e+00
-0.100	0.000e+00	0.000e+00	0.000e+00
0.000	0.000e+00	0.000e+00	0.000e+00
5.000	0.000e+00	0.000e+00	0.000e+00

[POWER Pulse Table]

| POWER Clamp offset table

Time	V(typ)	V(min)	V(max)
0	0	0	0
1e-9	0	0	0
2e-9	-0.9	-1.0	-0.8
10e-9	-0.9	-1.0	-0.8
11e-9	0	0	0

[POWER Clamp]

| Table to be offset

Voltage	I(typ)	I(min)	I(max)
-5.000	1.150e+01	1.100e+01	1.150e+01
-4.000	7.800e+00	7.500e+00	8.150e+00
-3.000	4.350e+00	4.100e+00	4.700e+00
-2.000	1.100e+00	8.750e-01	1.300e+00
-1.900	8.000e-01	6.050e-01	1.000e+00
-1.800	5.300e-01	3.700e-01	7.250e-01
-1.700	2.900e-01	1.800e-01	4.500e-01
-1.600	1.200e-01	6.850e-02	2.200e-01
-1.500	3.650e-02	2.400e-02	6.900e-02
-1.400	1.200e-02	1.100e-02	1.600e-02
-1.300	6.300e-03	6.650e-03	6.100e-03
-1.200	4.200e-03	4.750e-03	3.650e-03
-1.100	2.900e-03	3.500e-03	2.350e-03
-1.000	1.900e-03	2.450e-03	1.400e-03
-0.900	1.150e-03	1.600e-03	7.100e-04
-0.800	5.500e-04	9.150e-04	2.600e-04
-0.700	1.200e-04	4.400e-04	5.600e-05
-0.600	5.400e-05	1.550e-04	1.200e-05
-0.500	1.350e-05	5.400e-05	1.300e-06
-0.400	8.650e-07	7.450e-06	4.950e-08
-0.300	6.250e-08	7.550e-07	0.000e+00
-0.200	0.000e+00	8.400e-08	0.000e+00
-0.100	0.000e+00	0.000e-08	0.000e+00
0.000	0.000e+00	0.000e+00	0.000e+00

=====
=====

Bus Hold:

When the Submodel_type subparameter under the [Submodel] keyword is set to Bus_hold, the added model describes the bus hold functionality. However, while described in terms of bus hold functionality, active terminators can also be modeled.

Existing keywords and subparameters are used to describe bus hold models. The [Pullup] and [Pulldown] tables both are used to define an internal buffer that is triggered to switch to its opposite state. This switching transition is specified by a [Ramp] keyword or by the [Rising Waveform] and [Falling Waveform] keywords. The usage rules for these keywords are the same as under the [Model] keyword. In particular, at least either the [Pullup] or [Pulldown] keyword is required. Also, the [Ramp] keyword is required, even if the [Rising Waveform] and [Falling Waveform] tables exist. However, the voltage ranges and reference voltages are inherited from the top-level model.

For bus hold submodels, the [Submodel Spec] keyword, V_trigger_r, and V_trigger_f are required. The Off_delay subparameter is optional, and can only be used if the submodel consists of a pullup or a pulldown structure only, and not both. Devices which have both pullup and pulldown structures controlled in this fashion can be modeled using two submodels, one for each half of the circuit.

The transition is triggered by action at the die using the [Submodel Spec] V_trigger_r and V_trigger_f subparameters as described next. In all subsequent discussions, "low" means the pulldown structure is on or active, and the pullup structure is off or inactive if either or both exist. The opposite settings are referred to as "high".

If the starting voltage is below `V_trigger_f`, then the bus hold model is set to the low state causing additional pulldown current. If the starting voltage is above `V_trigger_r`, the bus hold model is set to the high state for additional pullup current.

Under some unusual cases, the above conditions can be both met or not met at all. To resolve this, the EDA tool should compute the starting voltage with the bus hold model set to low. If the starting voltage is equal to or less than the average of `V_trigger_r` and `V_trigger_f`, keep the bus hold model in the low state. Otherwise, set the bus hold model to the high state.

When the input passes through `V_trigger_f` during a high-to-low transition at the die, the bus hold output switches to the low state. Similarly, when the input passes through `V_trigger_r` during a low-to-high transition at the die, the bus hold output switches to the high state.

If the bus hold submodel has a pullup structure only, `V_trigger_r` provides the time when its pullup is turned on and `V_trigger_f` or `Off_delay` provides the time when it is turned off, whichever occurs first. Similarly, if the submodel has a pulldown structure only, `V_trigger_f` provides the time when its pulldown is turned on and `V_trigger_r` or `Off_delay` provides the time when it is turned off, whichever occurs first. The required `V_trigger_r` and `V_trigger_f` voltage entries can be set to values outside of the input signal range if the pullup or pulldown structures are to be held on until the `Off_delay` turns them off.

The starting mode for each of the submodels which include the `Off_delay` subparameter of the `[Submodel Spec]` keyword is the off state. Also, while two submodels provide the desired operation, either of the submodels may exist without the other to simulate turning on and off only a pullup or a pulldown current.

The following tables summarize the bus hold initial and switching transitions:

BUS HOLD WITHOUT OFF_DELAY:

Initialization:

Initial Vdie Value	Initial Bus Hold Submodel State	
$\leq V_trigger_r$ & $< V_trigger_f$	low	
$\Rightarrow V_trigger_f$ & $> V_trigger_r$	high	
$\leq (V_trigger_f + V_trigger_r)/2$	low	Recommendations if neither or both conditions above are satisfied
$> (V_trigger_f + V_trigger_r)/2$	high	

Transitions:

Prior Bus Hold Submodel State	Vdie transition through $V_trigger_r/f$	Bus Hold Transition
low	$V_trigger_r$	low-to-high
low	$V_trigger_f$	no change
high	$V_trigger_r$	no change
high	$V_trigger_f$	high-to-low

BUS HOLD WITH OFF_DELAY (REQUIRES EITHER [PULLUP] or [PULLDOWN] ONLY):

Initialization:

[Pullup] or [Pulldown] Table	Initial Bus Hold Submodel State (Off Mode)
[Pullup]	low
[Pulldown]	high

Transitions:

Prior Bus Hold Submodel State	Vdie transition through $V_trigger_r/f$	Bus Hold Transition	Off_delay Transition
low	$V_trigger_r$	low-to-high	high-to-low
low	$V_trigger_f$	no change	no change
high	$V_trigger_r$	no change	no change
high	$V_trigger_f$	high-to-low	low-to-high

Note, if Vdie passes again through the $V_trigger_r/f$ thresholds before the Off_delay time is reached, the bus hold state follows the change documented in the first table, overriding the Off_delay transition.

No additional keywords are needed for this functionality.

```

| Complete Bus Hold Model Example:
[Submodel]      Bus_hold_1
Submodel_type   Bus_hold
|
[Submodel Spec]
| Subparameter      typ      min      max
|
V_trigger_f     1.3      1.2      1.4 | Falling edge trigger
V_trigger_r     3.1      2.6      4.6 | Rising edge trigger
|
| Subparameter      typ      min      max
[Voltage Range] 5.0      4.5      5.5
| Note, the actual voltage range and reference voltages are inherited from
| the top-level model.
[Pulldown]
|
-5V   -100uA   -80uA   -120uA
-1V   -30uA   -25uA   -40uA
0V    0        0        0
1V    30uA    25uA    40uA
3V    50uA    45uA    50uA
5V    100uA   80uA    120uA
10v   120uA   90uA    150uA
|
[Pullup]
|
-5V   100uA    80uA    120uA
-1V   30uA    25uA    40uA
0V    0        0        0
1V   -30uA   -25uA   -40uA
3V   -50uA   -45uA   -50uA
5V   -100uA  -80uA   -120uA
10v  -120uA  -90uA   -150uA
|
-----
[Ramp]
| Subparameter      typ      min      max
dV/dt_r            2.0/0.50n  2.0/0.75n  2.0/0.35n
dV/dt_f            2.0/0.50n  2.0/0.75n  2.0/0.35n
R_load = 500
|
-----

```


The switching transition is specified by a [Ramp] keyword or by the [Rising Waveform] and [Falling Waveform] keywords. The [Ramp] keyword is required, even if the [Rising Waveform] and [Falling Waveform] tables exist. However, the voltage ranges and reference voltages are inherited from the top-level model.

For fall back submodels, the [Submodel Spec] keyword, V_trigger_r, and V_trigger_f are required. Unlike the bus hold model, the Off_delay subparameter is not permitted. Devices which have both pullup and pulldown structures can be modeled using two submodels, one for the rising cycle and one for the falling cycle.

In all following discussion, "low" means the pulldown structure is on or active, and the pullup structure is off or inactive. The opposite settings are referred to as "high".

The transition is triggered by action at the die using the [Submodel Spec] V_trigger_r and V_trigger_f subparameters. The initialization and transitions are set as follows:

INITIAL STATE:

[Pullup] or [Pulldown] Table	Initial Fall Back Submodel State (Off Mode)
[Pullup]	low
[Pulldown]	high

DRIVER RISING CYCLE:

Prior State	Vdie	Rising Edge Transition	Vdie > V_trigger_r Transition
low	<= V_trigger_r > V_trigger_r	low-to-high stays low	high-to-low stays low
high	<= V_trigger_r > V_trigger_r	stays high stays high	high-to-low stays high

DRIVER FALLING CYCLE:

Prior State	Vdie	Falling Edge Transition	Vdie < V_trigger_f Transition
high	=> V_trigger_f < V_trigger_f	high-to-low stays high	low-to-high stays high
low	=> V_trigger_f < V_trigger_f	stays low stays low	low-to-high stays low

One application is to configure the submodel with only a pullup structure. At the beginning of the rising edge cycle, the pullup is turned on to the high state. When the die voltage passes V_trigger_r, the pullup structure is turned off. Because only the pullup structure is used, the off state is low corresponding to a high-Z state. During the falling transition, the pullup remains in the high-Z state if the V_trigger_f is set out of range to avoid setting the submodel to the high state. So a temporary boost in drive occurs only during the first part of the rising cycle.

A similar submodel consisting of only a pulldown structure could be constructed to provide added drive strength only at the beginning of the falling cycle. The complete IBIS model would have both submodels to give added drive strength for both the start of the rising and the start of the falling cycles.

No additional keywords are needed for this functionality.

Complete Dynamic Output Model Example Using Two Submodels:

```
[Submodel]      Dynamic_Output_r
Submodel_type   Fall_back

[Submodel Spec]
  Subparameter      typ      min      max
V_trigger_f        -10.0    -10.0   -10.0 | Falling edge trigger
                  | set out of range to
                  | disable trigger
V_trigger_r         3.1      2.6     4.6 | Rising edge trigger
```

```
          typ      min      max
[Voltage Range]  5.0     4.5     5.5
Note, the actual voltage range and reference voltages are inherited from
the top-level model.
```

```
[Pullup]
-5V    100mA    80mA    120mA
0V     0        0        0
10v    -200mA  -160mA  -240mA
```

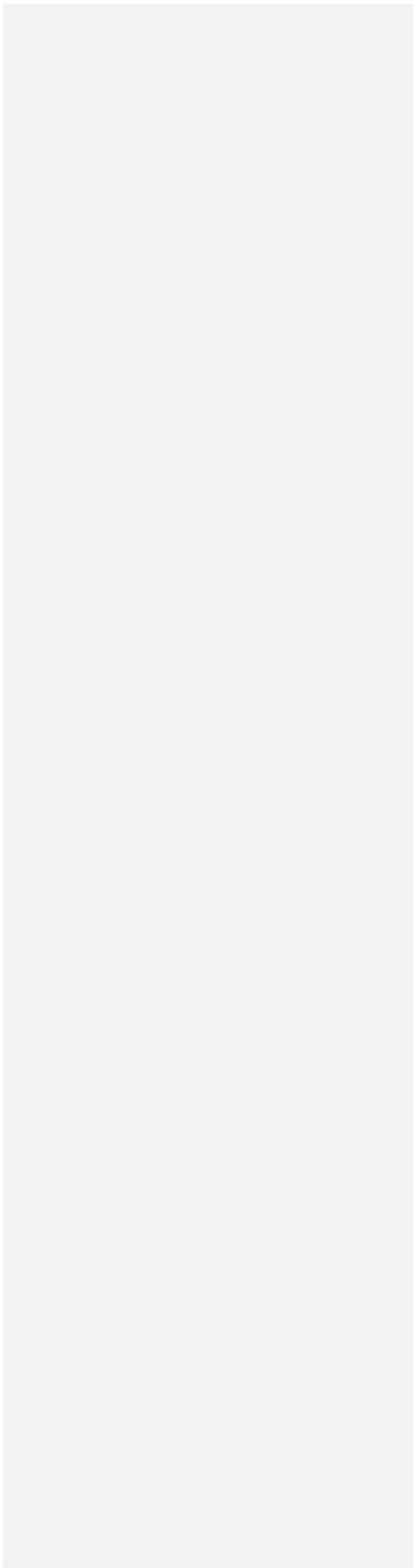
[Pulldown] table is omitted to signify Open_source functionality.

```
[Ramp]
          typ      min      max
dV/dt_r  1.5/0.50n  1.43/0.75n  1.58/0.35n
dV/dt_f  1.5/0.50n  1.43/0.75n  1.58/0.35n
R_load = 50
```

```

[Submodel]      Dynamic_Output_f
Submodel_type   Fall_back
|
[Submodel Spec]
|   Subparameter      typ      min      max
V_trigger_r      10.0      10.0      10.0 | Rising edge trigger
|                                     | set out of range to
|                                     | disable trigger
V_trigger_f      1.3      1.2      1.4 | Falling edge trigger
|
|                                     typ      min      max
[Voltage Range]  5.0      4.5      5.5
| Note, the actual voltage range and reference voltages are inherited from
| the top-level model.
|
[Pulldown]
|
-5V   -100mA   -80mA   -120mA
0V    0        0        0
10v   200mA   160mA   240mA
|
| [Pullup] table is omitted to signify Open_drain functionality.
|
-----
[Ramp]
|
dV/dt_r      typ      min      max
dV/dt_f      1.5/0.50n  1.43/0.75n  1.58/0.35n
R_load = 50
|
=====
=====

```



=====
=====
Section 6b

M U L T I - L I N G U A L M O D E L E X T E N S I O N S
=====
=====

INTRODUCTION:

The SPICE, VHDL-AMS and Verilog-AMS languages are supported by IBIS. This chapter describes how models written in these languages can be referenced and used by IBIS files.

The language extensions use the following keywords within the IBIS framework:

- [External Circuit] - References enhanced descriptions of structures
- [End External Circuit] on the die, including digital and/or analog,
 active and/or passive circuits

- [External Model] - Same as [External Circuit], except limited to
- [End External Model] the connection format and usage of the [Model]
 keyword, with one additional feature added:
 support for true differential buffers

- [Node Declarations] - Lists on-die connection points related to
- [End Node Declarations] the [Circuit Call] keyword

- [Circuit Call] - Instantiates [External Circuit]s and connects
- [End Circuit Call] them to each other and/or die pads

The placement of these keywords within the hierarchy of IBIS is shown in the following diagram:

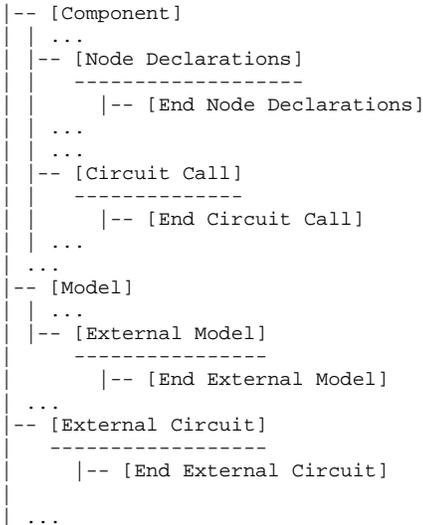


Figure 1: Partial keyword hierarchy

LANGUAGES SUPPORTED:

IBIS files can reference other files which are written using the SPICE, VHDL-AMS, or Verilog-AMS languages. In this document, these languages are defined as follows:

"SPICE" refers to SPICE 3, Version 3F5 developed by the University of California at Berkeley, California. Many vendor-specific EDA tools are compatible with most or all of this version.

"VHDL-AMS" refers to "IEEE Standard VHDL Analog and Mixed-Signal Extensions", approved March 18, 1999 by the IEEE-SA Standards Board and designated IEEE Std. 1076.1-1999, or later.

"Verilog-AMS" refers to the Analog and Mixed-Signal Extensions to Verilog-HDL as documented in the Verilog-AMS Language Reference, Version 2.0, or later. This document is maintained by Accellera (formerly Open Verilog International), an independent organization. Verilog-AMS is a superset that includes Verilog-A and the Verilog Hardware Description Language IEEE 1364-2001, or later.

"VHDL-A(MS)" refers to the analog subset of VHDL-AMS described above.

"Verilog-A(MS)" refers to the analog subset of Verilog-AMS described above.

In addition the "IEEE Standard Multivalued Logic System for VHDL Model Interoperability (Std_logic_1164)", designated IEEE Std. 1164-1993, or later is required to promote common digital data types for IBIS files referencing VHDL-AMS. Also, the Accellera Verilog-AMS Language Reference Manual Version 2.2, or later is required to promote common digital data types for IBIS files referencing Verilog-AMS.

Note that, for the purposes of this section, keywords, subparameters and other data used without reference to the external languages just described are referred to collectively as "native" IBIS.

OVERVIEW:

The four keyword pairs discussed in this chapter can be separated into two groups based on their functionalities. The [External Model], [End External Model], [External Circuit] and [End External Circuit] keywords are used as pointers to the models described by one of the external languages. The [Node Declarations], [End Node Declarations], [Circuit Call], and [End Circuit Call] keywords are used to describe how [External Circuit]s are connected to each other and/or to the die pads.

The [External Model] and [External Circuit] keywords are very similar in that they both support the same external languages, and they can both be used to describe passive and/or active circuitry. The key difference between the two keywords is that [External Model] can only be placed under the [Model] keyword, while [External Circuit] can only be placed outside the [Model] keyword. This is illustrated in Figure 1 above.

The intent behind [External Model] is to provide an upgrade path from native IBIS [Model]s to the external languages (one exception to this is the support for true differential buffers). Thus, the [External Model] keyword can be used to replace the usual I-V and V-T tables, C_comp, C_comp_pullup,

C_comp_pulldown, C_comp_power_clamp, C_comp_gnd_clamp subparameters, [Ramp], [Driver Schedule], [Submodel] keywords, etc. of a [Model] by any modeling technique that the external languages allow. For [External Model]s, the connectivity, test load and specification parameters (such as Vinh and Vinl) are preserved from the [Model] keyword and the simulator is expected to carry out the same type of connections and measurements as is usually done with the [Model] keyword. The only difference is that the model itself is described by an external language.

In the case of the [External Circuit], however, one can model a circuit having any number of ports (see definitions below). For example, the ports may include impedance or buffer strength selection controls in addition to the usual signal and supply connections. The connectivity of an [External Circuit] is defined by the [Node Declarations] and [Circuit Call] keywords. Currently, the test loads and measurement parameters for an [External Circuit] can only be defined inside the model description itself. The results of measurements can be reported to the user or tool via other means.

The [Circuit Call] keyword acts similarly to subcircuit calls in SPICE, instantiating the various [External Circuit]s and connecting them together. Please note that models described by the [External Model] keyword are connected according to the rules and assumptions of the [Model] keyword. [Circuit Call] is not necessary for these cases and must not be used.

DEFINITIONS:

For the purposes of this document, several general terms are defined below.

- circuit - any arbitrary collection of active or passive electrical elements treated as a unit
- node - any electrical connection point; also called die node (may be digital or analog; may be a connection internal to a circuit or between circuits)
- pad - a special case of a node. A pad connects a buffer or other circuitry to a package; also called die pad.
- port - access point in an [External Model] or [External Circuit] definition for digital or analog signals

pseudo-differential circuits - combination of two single-ended circuits which drive and/or receive complementary signals, but where no internal current relationship exists between them

true differential circuits - circuits where a current relationship exists between two output or inputs which drive or receive complementary signals

GENERAL ASSUMPTIONS:

Ports under [Model]s:

The use of ports under native IBIS must be understood before the multi-lingual extensions can be correctly applied. The [Model] keyword assumes, but does not explicitly require naming ports on circuits. These ports are automatically connected by IBIS-compliant tools without action by the user. For example, the [Voltage Reference] keyword implies the existence of power supply rails which are connected to the power supply ports of the circuit described by the [Model] keyword.

For multi-lingual modeling, ports must be explicitly named in the [External Model] or [External Circuit]; the ports are no longer assumed by EDA tools. To preserve compatibility with the assumptions of [Model], a list of pre-defined port names has been created where the ports are reserved with fixed functionality. These reserved ports are defined in the table below.

Port Name	Description
1 D_drive	Digital input to a model unit
2 D_enable	Digital enable for a model unit
3 D_receive	Digital receive port of a model unit, based on data on A_signal (and/or A_signal_pos and A_signal_neg)
4 A_puref	Voltage reference port for pullup structure
5 A_pcref	Voltage reference port for power clamp structure
6 A_pdref	Voltage reference port for pulldown structure
7 A_gcref	Voltage reference port for ground clamp structure
8 A_signal	I/O signal port for a model unit
9 A_extref	External reference voltage port
10 D_switch	Digital input for control of a series switch model
11 A_gnd	Global reference voltage port
12 A_pos	Non-inverting port for series or series switch models
13 A_neg	Inverting port for series or series switch models
14 A_signal_pos	Non-inverting port of a differential model
15 A_signal_neg	Inverting port of a differential model

The first letter of the port name designates it as either digital ("D") or analog ("A"). Reserved ports 1 through 13 listed above are assumed or implied under the native IBIS [Model] keyword. Again, for multi-lingual models, these ports must be explicitly assigned by the user in the model if their functions are to be used. A_gnd is a universal reference node, similar to SPICE ideal node "0." Ports 14 and 15 are only available under [External Model] for support of true differential buffers.

Under the [Model] description, power and ground reference ports are created and connected by IBIS-compliant tools as defined by the [Power Clamp Reference], [GND Clamp Reference], [Pullup Reference], [Pulldown Reference] and/or [Voltage Range] keywords. The A_signal port is connected to the die pad, to drive or receive an analog signal.

Ports under [External Model]s:

The [External Model] keyword may only appear under the [Model] keyword and it may only use the same ports as assumed with the native IBIS [Model] keyword. However, [External Model] requires that reserved ports be explicitly declared in the referenced language(s); tools will continue to assume the connections to these ports.

For [External Model], reserved analog ports are usually assumed to be die pads. These ports would be connected to the component pins through [Package Model]s or [Pin] parasitics. Digital ports under [External Model] would connect to other internal digital circuitry.

Drawings of two standard [Model] structures -- an I/O buffer and a Series Switch -- are shown below, with their associated port names.

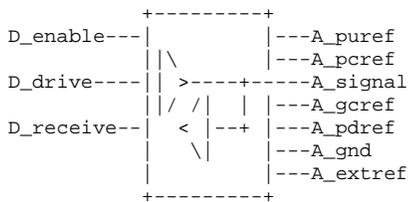


Figure 2: Port names for I/O buffer

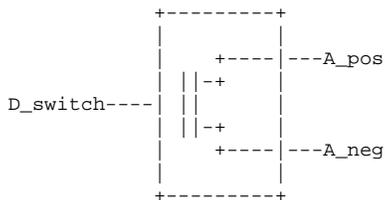


Figure 3: Port names for series switch

Ports under [External Circuit]s:

The [External Circuit] keyword allows the user to define any number of ports and port functions on a circuit. The [Circuit Call] keyword instantiates

[External Circuit]s and connects their ports to specific die nodes (this can include pads). In this way, the ports of an [External Circuit] declaration become specific component die nodes. Note that, if reserved digital port names are used with an [External Circuit], those ports will be connected automatically as defined in the port list above (under [External Circuit], reserved analog port names do not retain particular meanings).

The diagram below illustrates the use of [External Circuit]. Buffer A is an

instance of [External Circuit] "X". Similarly, Buffer B is an instance of [External Circuit] "Z". These instances are created through [Circuit Calls]. [External Circuit] "Y" defines an on-die interconnect circuit. Nodes "a" through "e" and nodes "f" through "j" are specific instances of the ports defined for [External Circuit]s "X" and "Z". These ports become the internal nodes of the die and must be explicitly declared with the [Node Declarations] keyword. The "On-die Interconnect" [Circuit Call] creates an instance of the [External Circuit] "Y" and connects the instance with the appropriate power, signal, and ground die pads. The "A" and "B" [Circuit Call]s connect the individual ports of each buffer instance to the "On-die Interconnect" [Circuit Call].

Note that the "Analog Buffer Control" signal is connected directly to the pad for pin 3. This connection is also made through an entry under the [Circuit Call] keyword.

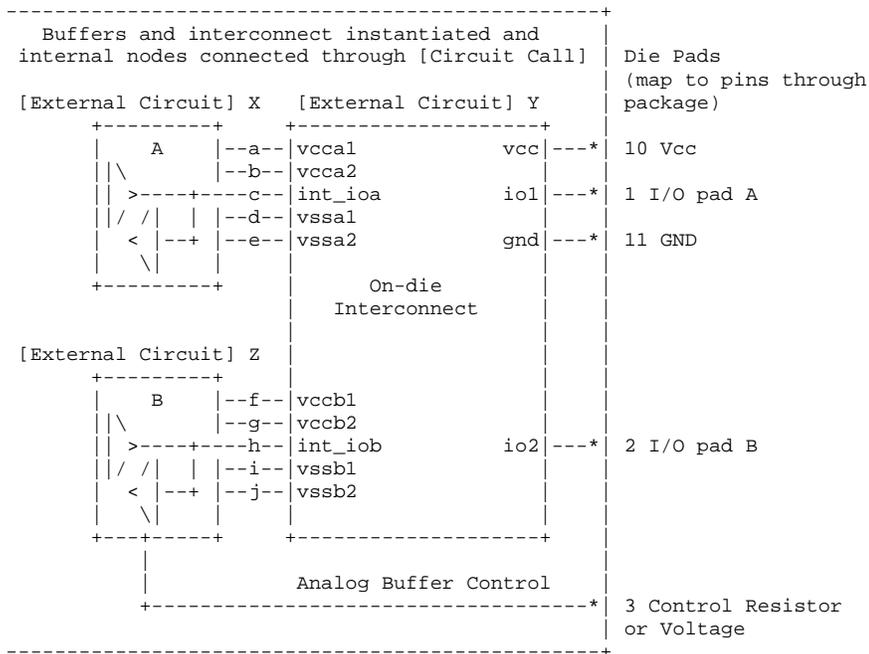


Figure 4: Example showing [External Circuit] ports

The [Model], [External Model] and [External Circuit] keywords (with [Circuit Call]s and [Node Declarations] as appropriate) may be combined together in the same IBIS file or even within the same [Component] description.

Port types and states:

The intent of native IBIS is to model the circuit block between the region where analog signals are of interest, and the digital logic domain internal to the component. For the purposes of this discussion, the IBIS circuit block is called a "model unit" in the drawings and document text below.

The multi-lingual modeling extensions maintain and expand this approach, assuming that both digital signals and/or analog signals can move to and

from the model unit. All VHDL-AMS and Verilog-AMS models, therefore must have digital ports and analog ports. In certain cases, digital ports may not be required, as in the case of interconnects; see [External Circuit] below. Routines to convert signals from one format to the other are the responsibility of the model author.

Digital ports under AMS languages must follow certain constraints on type and state. In VHDL-AMS models, analog ports must have type "electrical". Digital ports must have type "std_logic" as defined in IEEE Standard Multivalued Logic System for VHDL Model Interoperability (Std_logic_1164), or later. In Verilog-AMS models, analog ports must be of discipline "electrical" or a subdiscipline thereof. Digital ports must be of discipline "logic" as defined in the Accellera Verilog-AMS Language Reference Manual Version 2.2, or later and be constrained to states as defined in IEEE Std. 1164-1993, or later.

The digital ports delivering signals to the AMS model, D_drive, D_enable, and D_switch, must be limited to the '1' or '0' states for VHDL-AMS, or, equivalently, to the 1 or 0 states for Verilog-AMS. The D_receive digital port may only have the '1', '0', or 'X' states in VHDL-AMS, or, equivalently, the 1, 0, or X states in Verilog-AMS. All digital ports other than the foregoing predefined ports may use any of the logic states allowed by IEEE Std. 1164-1993, or later.

SPICE, VHDL-A(MS), Verilog-A(MS) versus VHDL-AMS and VERILOG-AMS

SPICE, VHDL-A(MS), Verilog-A(MS) cannot process digital signals. All SPICE, VHDL-A(MS), Verilog-A(MS) input and output signals must be in analog format. Consequently, IBIS multi-lingual models using SPICE, VHDL-A(MS) or Verilog-A(MS) require analog-to-digital (A_to_D) and/or digital-to-analog (D_to_A) converters to be provided by the EDA tool. The converter subparameters are declared by the user, as part of the [External Model] or [External Circuit] syntax, with user-defined names for the ports which connect the converters to the analog ports of the SPICE, VHDL-A(MS), or Verilog-A(MS) model. The details behind these declarations are explained in the keyword definitions below.

To summarize, Verilog-AMS and VHDL-AMS contain all the capability needed to ensure that a model unit consists of only digital ports and/or analog ports. SPICE, VHDL-A(MS) and Verilog-A(MS), however, need extra data conversion, provided by the EDA tool, to ensure that any digital signals can be correctly processed.

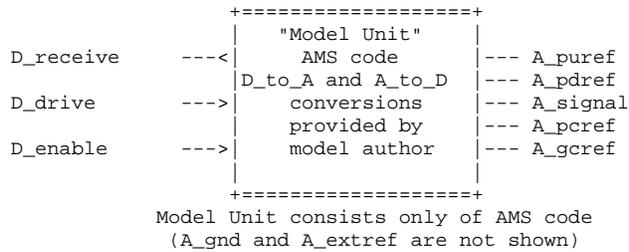


Figure 5: AMS Model Unit, using an I/O buffer as an example

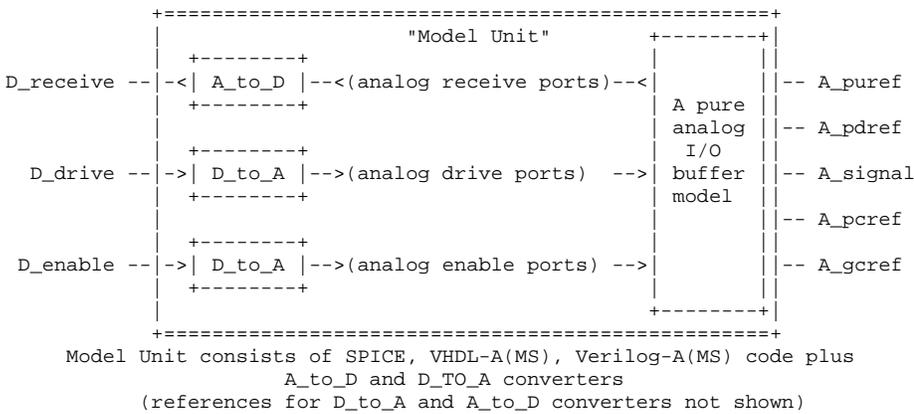


Figure 6: An analog-only Model Unit, using an I/O buffer as an example

```

=====
KEYWORD DEFINITIONS:
=====
Keywords: [External Model], [End External Model]
Required: No
Description: Used to reference an external file written in one of the
supported languages containing an arbitrary circuit
definition, but having ports that are compatible with the
[Model] keyword, or having ports that are compatible with the
[Model] keyword plus an additional signal port for true
differential buffers.

Sub-Params: Language, Corner, Parameters, Ports, D_to_A, A_to_D
Usage Rules: The [External Model] keyword must be positioned within a
[Model] section and it may only appear once for each [Model]
keyword in a .ibs file. It is not permitted under the
[Submodel] keyword.

```

[Circuit Call] may not be used to connect an [External Model].

A native IBIS [Model]'s data may be incomplete if the [Model] correctly references an [External Model]. Any native IBIS keywords that are used in such a case must contain syntactically correct data and subparameters according to native IBIS rules. In all cases, [Models] which reference [External Models] must include the following keywords and subparameters:

```
Model_type
Vinh, Vinl (as appropriate to Model_type)
[Voltage Range] and/or [Pullup Reference],
[Pulldown Reference], [POWER Clamp Reference],
[GND Clamp Reference], [External Reference]
[Ramp]
```

In models without the [External Model] keyword, data for [Ramp] should be measured using a load that conforms to the recommendations in Section 9: Notes on Data Derivation Method. However, when used within the scope of [External Model], the [Ramp] keyword is intended strictly to provide EDA tools with a quick first-order estimate of driver switching characteristics. When using [External Model], therefore, data for [Ramp] may be measured using a different load, if it results in data that better represent the driver's behavior in standard operation. Also in this case, the R_load subparameter is optional, regardless of its value, and will be ignored by EDA simulators. For example, the 20% to 80% voltage and time intervals for a differential buffer may be measured using the typical differential operating load appropriate to that buffer's technology. Note that voltage and time intervals must always be recorded explicitly rather than as a reduced fraction, in accordance with [Ramp] usage rules.

The following keywords and subparameters may be omitted, regardless of Model_type, from a [Model] using [External Model]:

```
C_comp, C_comp_pullup, C_comp_pulldown, C_comp_power_clamp,
C_comp_gnd_clamp
[Pulldown], [Pullup], [POWER Clamp], [GND Clamp]
```

Subparameter Definitions:

Language:

Accepts "SPICE", "VHDL-AMS", "Verilog-AMS", "VHDL-A(MS)" or "Verilog-A(MS)" as arguments. The Language subparameter is required and must appear only once.

Corner:

Three entries follow the Corner subparameter on each line:

```
corner_name file_name circuit_name
```

The corner_name entry is "Typ", "Min", or "Max". The file_name entry points to the referenced file in the same directory as the .ibs file.

Up to three Corner lines are permitted. A "Typ" line is required. If "Min" and/or "Max" data is missing, the tool may use "Typ" data in its place. However, the tool should notify the user of this action.

The circuit_name entry provides the name of the circuit to be simulated within the referenced file. For SPICE files, this is normally a ".subckt" name. For VHDL-AMS files, this is normally an "entity(architecture)" name pair. For Verilog-AMS files, this is normally a "module" name.

No character limits, case-sensitivity limits or extension conventions are required or enforced for file_name and circuit_name entries. However, the total number of characters in each Corner line must comply with the rules in Section 3. Furthermore, lower-case file_name entries are recommended to avoid possible conflicts with file naming conventions under different operating systems. Case differences between otherwise identical file_name entries or circuit_name entries should be avoided. External languages may not support case-sensitive distinctions.

Parameters:

Lists names of parameters that can be passed into an external model file. Each Parameters assignment must match a name or keyword in the external file or language. The list of Parameters may span several lines by using the word Parameters at the start of each line. The Parameters subparameter is optional, and the external model must operate with default settings without any Parameters assignments.

Parameter passing is not supported in SPICE. VHDL-AMS and VHDL-A(MS) parameters are supported using "generic" names, and Verilog-AMS and Verilog-A(MS) parameters are supported using "parameter" names.

Ports:

Ports are interfaces to the [External Model] which are available to the user and tool at the IBIS level. They are used to connect the [External Model] to die pads. The Ports parameter is used to identify the ports of the [External Model] to the simulation tool. The port assignment is by position and the port names do not have to match exactly the names inside the external file. The list of port names may span several lines if the word Ports is used at the start of each line.

Model units under [External Model] may only use reserved

ports. The reserved, pre-defined port names are listed in the General Assumptions heading above. As noted earlier, digital and analog reserved port functions will be assumed by the tool and connections made accordingly. All the ports appropriate to the particular Model_type subparameter entry must be explicitly listed (see below). Note that the user may connect SPICE, Verilog-A(MS) and VHDL-A(MS) models to A_to_D and D_to_A converters using custom names for analog ports within the model unit, so long as the digital ports of the converters use the digital reserved port names.

The rules for pad connections with [External Model] are identical to those for [Model]. The [Pin Mapping] keyword may be used with [External Model]s but is not required. If used, the [External Model] specific voltage supply ports -- A_puref, A_pdref, A_gcref, A_pcuref, and A_extref -- are connected as defined under the [Pin Mapping] keyword. In all cases, the voltage levels connected on the reserved supply ports are defined by the [Power Clamp Reference], [GND Clamp Reference], [Pullup Reference], [Pulldown Reference], and/or [Voltage Range] keywords, as in the case of [Model].

Digital-to-Analog/Analog-to-Digital Conversions:

These subparameters define all digital-to-analog and analog-to-digital converters needed to properly connect digital signals with the analog ports of referenced external SPICE, Verilog-A(MS) or VHDL-A(MS) models. These subparameters must be used when [External Model] references a file written in the SPICE, Verilog-A(MS) or VHDL-A(MS) languages. They are not permitted with Verilog-AMS or VHDL-AMS external files.

D_to_A:

As assumed in [Model], some interface ports of [External Model] circuits expect digital input signals. As SPICE, Verilog-A(MS) or VHDL-A(MS) models understand only analog signals, some conversion from digital to analog format is required. For example, input logical states such as '0' or '1,' implied in [Model], must be converted to actual input voltage stimuli, such as a voltage ramp, for SPICE simulation.

The D_to_A subparameter provides information for converting a digital stimulus, such as '0' or '1', into an analog voltage ramp (a digital 'X' input is ignored by D_to_A converters). Each digital port which carries data for conversion to analog format must have its own D_to_A line.

The D_to_A subparameter is followed by eight arguments:

```
d_port port1 port2 vlow vhigh trise tfall corner_name
```

The d_port entry holds the name of the digital port. This entry is used for the reserved port names D_drive, D_enable, and D_switch. The port1 and port2 entries hold the SPICE, Verilog-A(MS) or VHDL-A(MS) analog input port names across which voltages are specified. These entries are used for the user-defined port names, together with another port name, used

as a reference.

Normally port1 accepts an input signal and port2 is the reference for port1. However, for an opposite polarity stimulus, port1 could be connected to a reference port and port2 could serve as the input.

The vlow and vhigh entries accept analog voltage values which must correspond to the digital off and on states, where the vhigh value must be greater than the vlow value. For example, a 3.3 V ground-referenced buffer would list vlow as 0 V and vhigh as 3.3 V. The trise and tfall entries are times, must be positive and define input ramp rise and fall times between 0 and 100 percent.

The corner_name entry holds the name of the external model corner being referenced, as listed under the Corner subparameter.

At least one D_to_A line must be present, corresponding to the "Typ" corner model, for each digital line to be converted. Additional D_to_A lines for other corners may be omitted. In this case, the typical corner D_to_A entries will apply to all model corners and the "Typ" corner_name entry may be omitted.

A_to_D:

The A_to_D subparameter is used to generate a digital state ('0', '1', or 'X') based on analog voltages generated by the SPICE, Verilog-A(MS) or VHDL-A(MS) model or analog voltages present at the pad/pin. This allows an analog signal from the external SPICE, Verilog-A(MS) or VHDL-A(MS) circuit or pad/pin to be read as a digital signal by the simulation tool.

The A_to_D subparameter is followed by six arguments:

```
d_port port1 port2 vlow vhigh corner_name
```

The d_port entry lists the reserved port name D_receive. As with D_to_A, the port1 entry would normally contain the reserved name A_signal (see below) or a user-defined port name, while port2 may list any other analog reserved port name, used as a reference. The voltage measurements are taken in this example from the port1 entry with respect to the port2 entry. These ports must also be named by the Ports subparameter.

The vlow and vhigh entries list the low and high analog threshold voltage values. The reported digital state on D_receive will be '0' if the measured voltage is lower than the vlow value, '1' if above the vhigh value, and 'X' otherwise.

The corner_name entry holds the name of the external model corner being referenced, as listed under the Corner subparameter.

At least one A_to_D line must be supplied corresponding to the "Typ" corner model. Other A_to_D lines for other corners may be omitted. In this case, the typical corner A_to_D entries will apply to all model corners.

IMPORTANT: measurements for receivers in IBIS are normally assumed to be conducted at the die pads/pins. In such cases, the electrical input model data comprises a "load" which affects the waveform seen at the pads. However, for models measure the analog input response at the die pads or inside the circuit (this does not preclude tools from reporting digital D_receive and/or analog port responses in addition to at-pad A_signal response). If at-pad measurements are desired, the A_signal port would be named in the A_to_D line under port1. The A_to_D converter then effectively acts "in parallel" with the load of the circuit. If internal measurements are desired (e.g., if the user wishes to view the signal after processing by the receiver), the user-defined signal port would be named in the A_to_D line under port1. The A_to_D converter is effectively "in series" with the receiver model. The vhigh and vlow parameters should be adjusted as appropriate to the measurement point of interest.

Note that, while the port assignments and SPICE, Verilog-A(MS) or VHDL-A(MS) model must be provided by the user, the D_to_A and A_to_D converters will be provided automatically by the tool (the converter parameters must still be declared by the user). There is no need for the user to develop external SPICE, Verilog-A(MS) or VHDL-A(MS) code specifically for these functions.

A conceptual diagram of the port connections of a SPICE, Verilog-A(MS) or VHDL-A(MS) [External Model] is shown below. The example illustrates an I/O buffer. Note that the drawing implies that the D_receive state changes in response to the analog signal my_receive, not A_signal (see above):

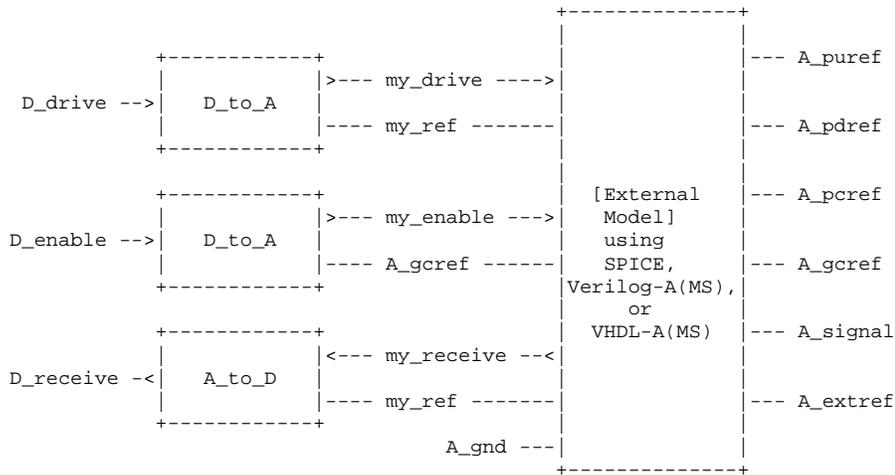


Figure 7: Example of an [External Model] I/O buffer using SPICE, Verilog-A(MS) or VHDL-A(MS)

An example of an [External Model] is shown at the end of this section.

Pseudo-Differential Buffers:

Pseudo-differential buffers may be described using a pair of [External Models] which may or may not be identical. Each of the analog I/O signal ports (usually **A_signal**) is connected to a specific pad through the [Pin] list in the usual fashion, and the two ports are linked together as a differential pair through the [Diff Pin] keyword.

The reserved signal name **A_signal** is required for the I/O signal ports of [External Models] connected to pads used in a pseudo-differential configuration.

Users should note that, in pseudo-differential buffers, only one formal signal port is used to stimulate the two [External Model] digital inputs (**D_drive**). One of these inputs will reflect the timing and polarity of the formal signal port named by the user, while the other input is inverted and (potentially) delayed with respect to the formal port as defined under the [Diff Pin] keyword. THIS SECOND PORT IS AUTOMATICALLY CREATED BY THE SIMULATION TOOL. Users do not have to create special structures to invert or delay the driven digital signal. Simulation tools will correctly implement the two input ports once the [Diff Pin] keyword has been detected in the .ibs file. This approach is identical to that used in native IBIS.

The D_to_A adapters used for SPICE, Verilog-A(MS) or VHDL-A(MS) files can be set up to control ports on pseudo-differential buffers. If SPICE, Verilog-A(MS) or VHDL-A(MS) is used as an external language, the [Diff Pin] vdiff subparameter overrides the contents of vlow and vhigh under A_to_D.

IMPORTANT: For pseudo-differential buffers under [External Model], the analog input response may only be measured at the die pads. The [Diff Pin] parameter is required, and controls both the polarity and the differential thresholds used to determine the D_receive port response (the D_receive port will follow the state of the non-inverting pin/pad as referenced to the inverting pin/pad). For SPICE, Verilog-A(MS) or VHDL-A(MS) models, the A_to_D line must name the A_signal port under either port1 or port2, as with a single-ended buffer. The A_to_D converter then effectively acts "in parallel" with the load of the buffer circuit. The vhigh and vlow parameters will be overridden by the [Diff Pin] vdiff declarations.

The port relationships are shown in the examples below.

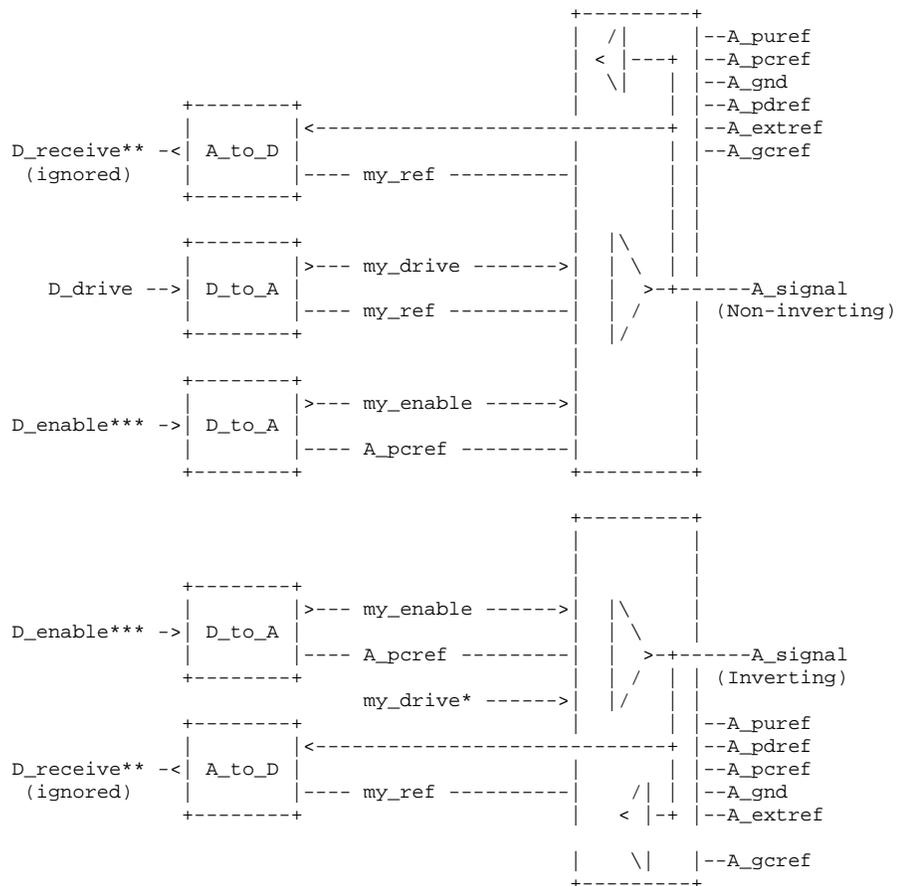


Figure 8: Example SPICE, Verilog-A(MS) or VHDL-A(MS) implementation

- * This signal is automatically created, by inverting and delaying `D_drive` based on the information in [Diff Pin].
- ** Pseudo-differential buffers must have `A_to_D` entries, but `D_receive` is determined by the state of `A_signal (Inverting)` and `A_signal (Non-inverting)` according to the [Diff Pin] declaration.
- *** `D_enable` is shared between the separate buffers. This sharing is handled by the EDA tool.

True Differential Models:

True differential buffers may be described using [External Model]. In a true differential [External Model], the differential I/O ports which connect to die pads use the reserved names A_signal_pos and A_signal_neg, as shown in the diagram below.

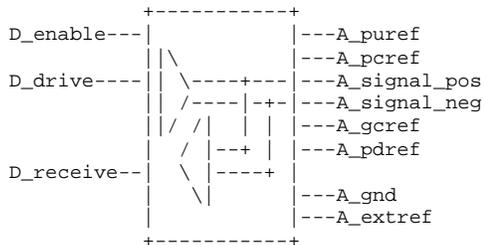


Figure 10: Port names for true differential I/O buffer

IMPORTANT: All true differential models under [External Model] assume single-ended digital port connections (D_drive, D_enable, D_receive).

The [Diff Pin] keyword is still required within the same [Component] definition when [External Model] describes a true differential buffer. The [Model] names or [Model Selector] names referenced by the pair of pins listed in an entry of the [Diff Pin] MUST be the same.

The D_to_A or A_to_D adapters used for SPICE, Verilog-A(MS) or VHDL-A(MS) files may be set up to control or respond to true differential ports. An example is shown below.

Note that the thresholds refer to the state of the non-inverting signal, using the inverting signal as a reference. Therefore, the output signal is considered high when, for example, the non-inverting input is +200 mV above the inverting input. Similarly, the output signal is considered low when the same non-inverting input is -200 mV "above" the inverting input.

EDA tools will report the state of the D_receive port for true differential *-AMS [External Model]s according to the AMS code written by the model author; the use of [Diff Pin] does not affect the reporting of D_receive in this case. EDA tools are free to additionally report the state of the I/O pads according to the [Diff Pin] vdiff subparameter.

For SPICE, Verilog-A(MS) or VHDL-A(MS) and *-AMS true differential [External Model]s, the EDA tool must not override or change the model author's connection of the D_receive port.

Four additional Model_type arguments are available under the [Model] keyword. One of these must be used when an [External Model] describes a true differential model:

I/O_diff, Output_diff, 3-state_diff, Input_diff

Two additional differential timing test loads are available:

Rref_diff, Cref_diff

These subparameters are also available under the [Model Spec] keyword for the typical, minimum, and maximum corner cases.

These timing test loads require that both the inverting and non-inverting ports of the differential model refer to valid buffer model data (not terminations, supply rails, etc.). The differential test loads may also be combined with the single-ended timing test loads Rref, Cref, and Vref. Note that the single-ended timing test loads plus Vmeas are used if Rref_diff and Cref_diff are NOT supplied.

Series and Series Switch Models:

Native IBIS did not define the transition characteristics of digital switch controls. Switches were assumed to either be on or off during a simulation and I-V characteristics could be defined for either or both states. The [External Model] format allows users to control the state of a switch through the D_switch port. As with other digital ports, the use of SPICE, Verilog-A(MS) or VHDL-A(MS) in an [External Model] requires the user to declare D_to_A ports, to convert the D_switch signal to an analog input to the SPICE, Verilog-A(MS) or VHDL-A(MS) model (whether the port's state may actually change during a simulation is determined by the EDA tool used).

Series and Series_switch devices both are described under the [External Model] keyword using the reserved port names A_pos and A_neg. Note that the [Series Pin Mapping] keyword must be present and correctly used elsewhere in the file, in order to properly set the logic state of the switch. The A_pos port is defined in the first entry of the [Series Pin Mapping] keyword, and the A_neg port is defined in the pin2 entry. For series switches, the [Series Switch Groups] keyword is required.

Ports required for various Model_types:

As [External Model] makes use of the [Model] keyword's Model_type subparameter, not all digital and analog reserved ports may be needed for all Model_types. The table below defines which reserved port names are required for various Model_types.

Model_type	D_drive	D_enable	D_receive	A_signal	D_switch	A_pos	A_neg
I/O*	X	X	X	X			
3-state*	X	X			X		
Output*, Open*	X			X			
Input			X	X			
Terminator				X			
Series						X	X
Series_switch					X	X	X

Model_type	D_drive	D_enable	D_receive	A_signal_pos	A_signal_neg
I/O_diff	X	X	X	X	X
3-state_diff	X	X		X	X
Output_diff	X			X	X
Input_diff			X	X	X

 Example [External Model] using SPICE:

```
[Model] ExBufferSPICE
```

```
Model_type I/O
```

```
Vinh = 2.0
```

```
Vinl = 0.8
```

Other model subparameters are optional

	typ	min	max
[Voltage Range]	3.3	3.0	3.6

```
[Ramp]
```

```
dV/dt_r 1.57/0.36n 1.44/0.57n 1.73/0.28n
```

```
dV/dt_f 1.57/0.35n 1.46/0.44n 1.68/0.28n
```

```

[External Model]
Language SPICE
|
| Corner corner_name file_name      circuit_name (.subckt name)
Corner   Typ          buffer_typ.spi  buffer_io_typ
Corner   Min          buffer_min.spi  buffer_io_min
Corner   Max          buffer_max.spi  buffer_io_max
|
| Parameters - Not supported in SPICE
|
| Ports List of port names (in same order as in SPICE)
Ports A_signal my_drive my_enable my_receive my_ref
Ports A_puref A_pdref A_pceref A_gceref A_extref
|
| D_to_A d_port  port1    port2    vlow vhigh trise tfall corner_name
D_to_A  D_drive my_drive  my_ref   0.0 3.3 0.5n 0.3n Typ
D_to_A  D_enable my_enable A_gceref 0.0 3.3 0.5n 0.3n Typ
|
| A_to_D d_port  port1    port2    vlow vhigh corner_name
A_to_D  D_receive my_receive my_ref  0.8 2.0 Typ
|
| Note: A_signal might also be used instead of a user-defined interface port
| for measurements taken at the die pads
|
[End External Model]
-----
| Example [External Model] using VHDL-AMS:
|-----
[Model] ExBufferVHDL
Model_type I/O
Vinh = 2.0
Vinl = 0.8
|
| Other model subparameters are optional
|
|          typ      min      max
[Voltage Range] 3.3    3.0    3.6
|
| [Ramp]
dV/dt_r      1.57/0.36n  1.44/0.57n  1.73/0.28n
dV/dt_f      1.57/0.35n  1.46/0.44n  1.68/0.28n
|
[External Model]
Language VHDL-AMS
|
| Corner corner_name file_name      circuit_name entity(architecture)
Corner   Typ          buffer_typ.vhd  buffer(buffer_io_typ)
Corner   Min          buffer_min.vhd  buffer(buffer_io_min)
Corner   Max          buffer_max.vhd  buffer(buffer_io_max)
|
| Parameters List of parameters
Parameters delay rate
Parameters preemphasis

```

```

| Ports List of port names (in same order as in VHDL-AMS)
Ports A_signal A_puref A_pdref A_pcref A_gcref
Ports D_drive D_enable D_receive
[End External Model]

-----
Example [External Model] using Verilog-AMS:
-----

[Model] ExBufferVerilog
Model_type I/O
Vinh = 2.0
Vinl = 0.8

| Other model subparameters are optional

[Voltage Range]      typ      min      max
                    3.3      3.0      3.6

[Ramp]
dV/dt_r      1.57/0.36n  1.44/0.57n  1.73/0.28n
dV/dt_f      1.57/0.35n  1.46/0.44n  1.68/0.28n

[External Model]
Language Verilog-AMS

| Corner corner_name file_name      circuit_name (module)
Corner   Typ          buffer_typ.v  buffer_io_typ
Corner   Min          buffer_min.v  buffer_io_min
Corner   Max          buffer_max.v  buffer_io_max

| Parameters List of parameters
Parameters delay rate
Parameters preemphasis

| Ports List of port names (in same order as in Verilog-AMS)
Ports A_signal A_puref A_pdref A_pcref A_gcref
Ports D_drive D_enable D_receive
[End External Model]

-----
Example [External Model] using VHDL-A(MS):
-----

[Model] ExBufferVHDL_analog
Model_type I/O
Vinh = 2.0
Vinl = 0.8

| Other model subparameters are optional

[Voltage Range]      typ      min      max
                    3.3      3.0      3.6

```

```

[Ramp]
dV/dt_r      1.57/0.36n  1.44/0.57n  1.73/0.28n
dV/dt_f      1.57/0.35n  1.46/0.44n  1.68/0.28n
|
[External Model]
Language VHDL-A(MS)
|
| Corner corner_name file_name      circuit_name entity(architecture)
Corner      Typ          buffer_typ.vhd  buffer(buffer_io_typ)
Corner      Min          buffer_min.vhd  buffer(buffer_io_min)
Corner      Max          buffer_max.vhd  buffer(buffer_io_max)
|
| Parameters List of parameters
|
Parameters delay rate
Parameters preemphasis
|
| Ports List of port names (in same order as in VHDL-A(MS))
Ports A_signal my_drive my_enable my_receive my_ref
Ports A_puref A_pdref A_pref A_gcref A_extref
|
| D_to_A d_port  port1      port2      vlow vhigh trise tfall corner_name
D_to_A  D_drive my_drive   my_ref     0.0  3.3  0.5n  0.3n  Typ
D_to_A  D_enable my_enable  A_gcref  0.0  3.3  0.5n  0.3n  Typ
|
| A_to_D d_port  port1      port2      vlow vhigh corner_name
A_to_D  D_receive my_receive my_ref     0.8  2.0  Typ
|
| Note: A_signal might also be used instead of a user-defined interface port
| for measurements taken at the die pads
|
|-----|
| Example [External Model] using Verilog-A(MS):
|-----|
|
[Model] ExBufferVerilog_analog
Model_type I/O
Vinh = 2.0
Vinl = 0.8
|
| Other model subparameters are optional
|
|          typ      min      max
[Voltage Range]  3.3      3.0      3.6
|
[Ramp]
dV/dt_r      1.57/0.36n  1.44/0.57n  1.73/0.28n
dV/dt_f      1.57/0.35n  1.46/0.44n  1.68/0.28n
|
[External Model]
Language Verilog-A(MS)
|
| Corner corner_name file_name      circuit_name (module)
Corner      Typ          buffer_typ.va  buffer_io_typ
Corner      Min          buffer_min.va  buffer_io_min
Corner      Max          buffer_max.va  buffer_io_max

```

```

| Parameters List of parameters
Parameters delay rate
Parameters preemphasis

| Ports List of port names (in same order as in Verilog-A(MS))
Ports A_signal my_drive my_enable my_receive my_ref
Ports A_puref A_pdref A_pceref A_gceref A_extref

| D_to_A d_port port1 port2 vlow vhigh trise tfall corner_name
D_to_A D_drive my_drive my_ref 0.0 3.3 0.5n 0.3n Typ
D_to_A D_enable my_enable A_gceref 0.0 3.3 0.5n 0.3n Typ

| A_to_D d_port port1 port2 vlow vhigh corner_name
A_to_D D_receive my_receive my_ref 0.8 2.0 Typ

| Note: A_signal might also be used instead of a user-defined interface port
| for measurements taken at the die pads

[End External Model]

-----
| Example of True Differential [External Model] using SPICE:
-----

[Model] Ext_SPICE_Diff_Buff
Model_type I/O_diff
Rref_diff = 100

| Other model subparameters are optional

| [Voltage Range]
| typ min max
[Voltage Range] 3.3 3.0 3.6

| [Ramp]
| dV/dt_r 1.57/0.36n 1.44/0.57n 1.73/0.28n
| dV/dt_f 1.57/0.35n 1.46/0.44n 1.68/0.28n

| [External Model]
Language SPICE

| Corner corner_name file_name circuit_name (.subckt name)
Corner Typ diffio.spi diff_io_typ
Corner Min diffio.spi diff_io_min
Corner Max diffio.spi diff_io_max

| Ports List of port names (in same order as in SPICE)
Ports A_signal_pos A_signal_neg my_receive my_drive my_enable
Ports A_puref A_pdref A_pceref A_gceref A_extref my_ref A_gnd

| D_to_A d_port port1 port2 vlow vhigh trise tfall corner_name
D_to_A D_drive my_drive my_ref 0.0 3.3 0.5n 0.3n Typ
D_to_A D_drive my_drive my_ref 0.0 3.0 0.6n 0.3n Min
D_to_A D_drive my_drive my_ref 0.0 3.6 0.4n 0.3n Max
D_to_A D_enable my_enable my_ref 0.0 3.3 0.5n 0.3n Typ
D_to_A D_enable my_enable my_ref 0.0 3.0 0.6n 0.3n Min
D_to_A D_enable my_enable my_ref 0.0 3.6 0.4n 0.3n Max

```

```

| A_to_D d_port    port1      port2      vlow  vhigh corner_name
A_to_D   D_receive A_signal_pos A_signal_neg -200m 200m Typ
A_to_D   D_receive A_signal_pos A_signal_neg -200m 200m Min
A_to_D   D_receive A_signal_pos A_signal_neg -200m 200m Max
|
[End External Model]
|
-----
| Example of True Differential [External Model] using VHDL-AMS:
-----
|
[Model] Ext_VHDL_Diff_Buff
Model_type I/O_diff
Rref_diff = 100
|
|          typ      min      max
[Voltage Range] 3.3    3.0    3.6
|
[Ramp]
dV/dt_r      1.57/0.36n  1.44/0.57n  1.73/0.28n
dV/dt_f      1.57/0.35n  1.46/0.44n  1.68/0.28n
|
| Other model subparameters are optional
|
[External Model]
Language VHDL-AMS
|
| Corner corner_name file_name      circuit_name entity(architecture)
Corner   Typ          diffio_typ.vhd  buffer(diff_io_typ)
Corner   Min          diffio_min.vhd  buffer(diff_io_min)
Corner   Max          diffio_max.vhd  buffer(diff_io_max)
|
| Parameters List of parameters
Parameters delay rate
Parameters preemphasis
|
| Ports List of port names (in same order as in VHDL-AMS)
Ports A_signal_pos A_signal_neg D_receive D_drive D_enable
Ports A_puref A_pdref A_pceref A_gceref
|
[End External Model]
|
-----
| Example of Pseudo-Differential [External Model] using SPICE:
-----
|
| Note that [Pin] and [Diff Pin] declarations are shown for clarity
|
|
[Pin] signal_name model_name R_pin L_pin C_pin
1 Example_pos Ext_SPICE_PDdiff_Buff
2 Example_neg Ext_SPICE_PDdiff_Buff
|
...

```

```

[Diff Pin] inv_pin vdiff tdelay_typ tdelay_min tdelay_max
1          2          200mV    0ns          0ns          0ns
|
| ...
|
[Model] Ext_SPICE_PDiff_Buff
Model_type I/O
|
| Other model subparameters are optional
|
|          typ      min      max
[Voltage Range] 3.3      3.0      3.6
|
[Ramp]
dV/dt_r      1.57/0.36n  1.44/0.57n  1.73/0.28n
dV/dt_f      1.57/0.35n  1.46/0.44n  1.68/0.28n
|
[External Model]
Language SPICE
|
| Corner  corner_name  file_name  circuit_name (.subckt name)
Corner    Typ          diffio.spi  diff_io_typ
Corner    Min          diffio.spi  diff_io_min
Corner    Max          diffio.spi  diff_io_max
|
| Ports List of port names (in same order as in SPICE)
Ports A_signal my_drive my_enable my_ref
Ports A_puref  A_pdref  A_pcref  A_gcref  A_gnd  A_extref
|
| D_to_A d_port  port1      port2      vlow vhigh trise tfall corner_name
D_to_A   D_drive my_drive   my_ref     0.0 3.3  0.5n 0.3n Typ
D_to_A   D_drive my_drive   my_ref     0.0 3.0  0.6n 0.3n Min
D_to_A   D_drive my_drive   my_ref     0.0 3.6  0.4n 0.3n Max
D_to_A   D_enable my_enable  A_pcref    0.0 3.3  0.5n 0.3n Typ
D_to_A   D_enable my_enable  A_pcref    0.0 3.0  0.6n 0.3n Min
D_to_A   D_enable my_enable  A_pcref    0.0 3.6  0.4n 0.3n Max
|
| A_to_D d_port  port1      port2      vlow vhigh corner_name
A_to_D   D_receive A_signal  my_ref     0.8 2.0  Typ
A_to_D   D_receive A_signal  my_ref     0.8 2.0  Min
A_to_D   D_receive A_signal  my_ref     0.8 2.0  Max
|
| This example shows the evaluation of the received signals at the die
| pads. [Diff Pin] defines the interpretation of the A_to_D output
| polarity and levels and overrides the A_to_D settings shown above.
|
[End External Model]
|
=====

```

=====
Keywords: [External Circuit], [End External Circuit]
Required: No
Description: Used to reference an external file containing an arbitrary circuit description using one of the supported languages.
Sub-Params: Language, Corner, Parameters, Ports, D_to_A, A_to_D
Usage Rules: Each [External Circuit] keyword must be followed by a unique name that differs from any name used for any [Model] or [Submodel] keyword.

The [External Circuit] keyword may appear multiple times. It is not scoped by any other keyword.

Each instance of an [External Circuit] is referenced by one or more [Circuit Call] keywords discussed later. (The [Circuit Call] keyword cannot be used to reference a [Model] keyword.)

The [External Circuit] keyword and contents may be placed anywhere in the file, outside of any [Component] keyword group or [Model] keyword group, in a manner similar to that of the [Model] keyword.

Subparameter Definitions:

Language:

Accepts "SPICE", "VHDL-AMS", "Verilog-AMS", "VHDL-A(MS)" or "Verilog-A(MS)" as arguments. The Language subparameter is required and must appear only once.

Corner:

Three entries follow the Corner subparameter on each line:

```
corner_name file_name circuit_name
```

The corner_name entry is "Typ", "Min", or "Max". The file_name entry points to the referenced file in the same directory as the .ibs file.

Up to three Corner lines are permitted. A "Typ" line is required. If "Min" and/or "Max" data is missing, the tool may use "Typ" data in its place. However, the tool should notify the user of this action.

The circuit_name entry provides the name of the circuit to be simulated within the referenced file. For SPICE files, this is normally a ".subckt" name. For VHDL-AMS files, this is normally an "entity(architecture)" name pair. For Verilog-AMS files, this is normally a "module" name.

No character limits, case-sensitivity limits or extension conventions are required or enforced for file_name and circuit_name entries. However, the total number of characters in each Corner line must comply with Section 3. Furthermore, lower-case file_name entries are recommended to avoid possible conflicts with file naming conventions under different operating systems. Case differences between otherwise identical file_name entries or circuit_name entries should be

avoided. External languages may not support case-sensitive distinctions.

Parameters:

Lists names of parameters that may be passed into an external circuit file. Each Parameters assignment must match a name or keyword in the external file or language. The list of Parameters can span several lines by using the word Parameters at the start of each line. The Parameters subparameter is optional, and the external circuit must operate with default settings without any Parameters assignments.

Parameter passing is not supported in SPICE. VHDL-AMS and VHDL-A(MS) parameters are supported using "generic" names, and Verilog-AMS and Verilog-A(MS) parameters are supported using "parameter" names.

Ports:

Ports are interfaces to the [External Circuit] which are available to the user and tool at the IBIS level. They are used to connect the [External Circuit] to die pads. The Ports parameter is used to identify the ports of the [External Circuit] to the simulation tool. The port assignment is by position and the port names do not have to match exactly the names inside the external file. The list of port names may span several lines if the word Ports is used at the start of each line.

The Ports parameter is used to identify the ports of the [External Circuit] to the simulation tool. The port assignment is by position and the port names do not have to match exactly the port names in the external file. The list of port names may span several lines if the word Ports is used at the start of each line.

[External Circuit] allows any number of ports to be defined, with any names which comply with Section 3 format requirements. Reserved port names may be used, but ONLY DIGITAL PORTS will have the pre-defined functions listed in the General Assumptions heading above. User-defined and reserved port names may be combined within the same [External Circuit].

The [Pin Mapping] keyword cannot be used with [External Circuit] in the same [Component] description.

Digital-to-Analog/Analog-to-Digital Conversions:

These subparameters define all digital-to-analog and analog-to-digital converters needed to properly connect digital signals with the analog ports of referenced external SPICE, Verilog-A(MS) or VHDL-A(MS) models. These subparameters must be used when [External Circuit] references a file written in the SPICE, Verilog-A(MS) or VHDL-A(MS) language. They are not permitted with Verilog-AMS or VHDL-AMS external files.

D_to_A:

As assumed in [Model] and [External Model], some interface ports of [External Circuit]s expect digital input signals. As SPICE, Verilog-A(MS) or VHDL-A(MS) models understand only analog signals, some conversion from digital to analog format is required. For example, input logical states such as '0' or '1' must be converted to actual input voltage stimuli, such as a voltage ramp, for SPICE simulation.

The D_to_A subparameter provides information for converting a digital stimulus, such as '0' or '1', into an analog voltage ramp (a digital 'X' input is ignored by D_to_A converters). Each digital port which carries data for conversion to analog format must have its own D_to_A declaration.

The D_to_A subparameter is followed by eight arguments:

```
d_port port1 port2 vlow vhigh trise tfall corner_name
```

The d_port entry holds the name of the digital port. This entry may contain user-defined port names or the reserved port names D_drive, D_enable, and D_switch. The port1 and port2 entries hold the SPICE, Verilog-A(MS) or VHDL-A(MS) analog input port names across which voltages are specified. These entries contain user-defined port names. One of these port entries must name a reference for the other port (for example, A_gnd).

Normally, port1 accepts an input signal and port2 is the reference for port1. However, for an opposite polarity stimulus, port1 could be connected to a voltage reference and port2 could serve as the input.

The vlow and vhigh entries accept voltage values which correspond to fully-off and fully-on states, where the vhigh value must be greater than the vlow value. For example, a 3.3 V ground-referenced buffer would list vlow as 0 V and vhigh as 3.3 V. The trise and tfall entries are times, must be positive and define input ramp rise and fall times between 0 and 100 percent.

The corner_name entry holds the name of the external circuit corner being referenced, as listed under the Corner subparameter.

Any number of D_to_A subparameter lines is allowed, so long as each contains a unique port name entry and at least one unique port1 or port2 entry (i.e., several D_to_A declarations may use the same reference node under port1 or port2). At least one D_to_A line must be present, corresponding to the "Typ" corner model, for each digital line to be converted. Additional D_to_A lines for other corners may be omitted. In this case, the typical corner D_to_A entries will apply to all model corners and the "Typ" corner_name entry may be omitted.

A_to_D:

The A_to_D subparameter is used to generate a digital state ('0', '1', or 'X') based on analog voltages from the SPICE, Verilog-A(MS) or VHDL-A(MS) model or from the pad/pin. This allows an analog signal from the external SPICE, Verilog-A(MS) or VHDL-A(MS) circuit to be read as a digital signal by the simulation tool.

The A_to_D subparameter is followed by six arguments:

```
d_port port1 port2 vlow vhigh corner_name
```

The d_port entry lists port names to be used for digital signals going. As with D_to_A, the port1 entry would contain a user-defined analog signal. Port2 would list another port name to be used as a reference. The voltage measurements are taken from the port1 entry with respect to the port2 entry. These ports must also be named by the Ports subparameter.

The vlow and vhigh entries list the low and high analog threshold voltage values. The reported digital state on D_receive will be '0' if the measured voltage is lower than the vlow value, '1' if above the vhigh value, and 'X' otherwise.

The corner_name entry holds the name of the external model corner being referenced, as listed under the Corner subparameter.

Any number of A_to_D subparameter lines is allowed, so long as each line contains at least one column entry which is distinct from the column entries of all other lines. In practice, this means that A_to_D subparameter lines describing different corners will have identical port names. Other kinds of variations described through A_to_D subparameter lines should use unique port names. For example, a user may wish to create additional A_to_D converters for individual analog signals to monitor common mode behaviors on differential buffers.

At least one A_to_D line must be supplied corresponding to the "Typ" corner model. Other A_to_D lines for other corners may be omitted. In this case, the typical corner D_to_A entries will apply to all model corners.

IMPORTANT: measurements for receivers in IBIS may be conducted at the die pads or the pins. In such cases, the electrical input model data comprises a "load" which affects the waveform seen. However, for [External Circuit]s, the user may choose whether to measure the analog input response in the usual fashion or internal to the circuit (this does not preclude tools from reporting digital D_receive and/or analog responses in addition to normal A_signal response). If native IBIS measurements are desired, the A_signal port would be named in the A_to_D line under port1. The A_to_D converter then effectively acts "in parallel" with the load of the circuit. If internal measurements are desired (e.g., if the user wishes to view the signal after processing by the receiver), the user-defined analog signal port would be named in the A_to_D line under port1. The A_to_D converter is effectively "in series" with the receiver model. The vhigh and vlow parameters should be adjusted appropriate to the measurement point of interest.

Note that, while the port assignments and SPICE, Verilog-A(MS) or VHDL-A(MS) model data must be provided by the user, the D_to_A and A_to_D converters will be provided automatically by the tool. There is no need for the user to develop external SPICE, Verilog-A(MS) or VHDL-A(MS) code specifically for these functions.

The [Diff Pin] keyword is NOT required for true differential [External Circuit] descriptions.

Pseudo-differential buffers are not supported under [External Circuit]. Use the existing [Model] and [External Model] keywords to describe these structures.

Note that the EDA tool is responsible for determining the specific measurement points for reporting timing and signal quality for [External Circuit]s.

In all other respects, [External Circuit] behaves exactly as [External Model].

Model B as an [External Circuit]

Example [External Circuit] using SPICE:

[External Circuit] BUFF-SPICE
Language SPICE

	Corner	corner_name	file_name	circuit_name (.subckt name)
Corner	Typ		buffer_typ.spi	bufferb_io_typ
Corner	Min		buffer_min.spi	bufferb_io_min
Corner	Max		buffer_max.spi	bufferb_io_max

| Parameters - Not supported in SPICE

```

| Ports List of port names (in same order as in SPICE)
Ports A_signal int_in int_en int_out A_control
Ports A_puref A_pdref A_pcref A_gcref
|
| D_to_A d_port port1 port2 vlow vhigh trise tfall corner_name
D_to_A D_drive int_in my_gcref 0.0 3.3 0.5n 0.3n Typ
D_to_A D_drive int_in my_gcref 0.0 3.0 0.6n 0.3n Min
D_to_A D_drive int_in my_gcref 0.0 3.6 0.4n 0.3n Max
D_to_A D_enable int_en my_gnd 0.0 3.3 0.5n 0.3n Typ
D_to_A D_enable int_en my_gnd 0.0 3.0 0.6n 0.3n Min
D_to_A D_enable int_en my_gnd 0.0 3.6 0.4n 0.3n Max
|
| A_to_D d_port port1 port2 vlow vhigh corner_name
A_to_D D_receive int_out my_gcref 0.8 2.0 Typ
A_to_D D_receive int_out my_gcref 0.8 2.0 Min
A_to_D D_receive int_out my_gcref 0.8 2.0 Max
|
| Note, the A_signal port might also be used and int_out not defined in
| a modified .subckt.
|
[End External Circuit]
|
|-----|
| Example [External Circuit] using VHDL-AMS:
|-----|
|
[External Circuit] BUFF-VHDL
Language VHDL-AMS
|
| Corner corner_name file_name circuit_name entity(architecture)
Corner Typ buffer_typ.vhd bufferb(buffer_io_typ)
Corner Min buffer_min.vhd bufferb(buffer_io_min)
Corner Max buffer_max.vhd bufferb(buffer_io_max)
|
| Parameters List of parameters
Parameters delay rate
Parameters preemphasis
|
| Ports List of port names (in same order as in VHDL-AMS)
Ports A_signal A_puref A_pdref A_pcref A_gcref A_control
Ports D_drive D_enable D_receive
|
[End External Circuit]
|
|-----|
| Example [External Circuit] using Verilog-AMS:
|-----|
|
[External Circuit] BUFF-VERILOG
Language Verilog-AMS
|
| Corner corner_name file_name circuit_name (module)
Corner Typ buffer_typ.v bufferb_io_typ
Corner Min buffer_min.v bufferb_io_min
Corner Max buffer_max.v bufferb_io_max
|

```

```

| Parameters List of parameters
Parameters delay rate
Parameters preemphasis
|
| Ports List of port names (in same order as in Verilog-AMS)
Ports A_signal A_puref A_pdref A_pceref A_gcref A_control
| Ports D_drive D_enable D_receive
|
|
[End External Circuit]
|
| Interconnect Structure as an [External Circuit]
|
|-----
| Example [External Circuit] using SPICE:
|-----
|
[External Circuit] BUS_SPI
Language SPICE
|
| Corner corner_name file_name circuit_name (.subckt name)
Corner Typ bus_typ.spi Bus_typ
Corner Min bus_min.spi Bus_min
Corner Max bus_max.spi Bus_max
|
| Parameters - Not supported in SPICE
|
| Ports are in same order as defined in SPICE
Ports vcc gnd io1 io2
Ports int_ioa vcca1 vcca2 vssa1 vssa2
Ports int_iob vccb1 vccb2 vssb1 vssb2
|
| No A_to_D or D_to_A required, as no digital ports are used
|
[End External Circuit]
|
|-----
| Example [External Circuit] using VHDL-AMS:
|-----
|
[External Circuit] BUS_VHD
Language VHDL-AMS
|
| Corner corner_name file_name circuit_name entity(architecture)
Corner Typ bus.vhd Bus(Bus_typ)
Corner Min bus.vhd Bus(Bus_min)
Corner Max bus.vhd Bus(Bus_max)
|
| Parameters List of parameters
Parameters r1 l1
Parameters r2 l2 temp
|
| Ports are in the same order as defined in VHDL-AMS
Ports vcc gnd io1 io2
Ports int_ioa vcca1 vcca2 vssa1 vssa2
Ports int_iob vccb1 vccb2 vssb1 vssb2
|

```

```

-----
Example [External Circuit] using Verilog-AMS:
-----

[External Circuit] BUS_V
Language Verilog-AMS

Corner corner_name file_name circuit_name (module)
Corner Typ bus.v Bus_typ
Corner Min bus.v Bus_min
Corner Max bus.v Bus_max

Parameters List of parameters
Parameters r1 l1
Parameters r2 l2 temp

Ports are in the same order as defined in Verilog-AMS
Ports vcc gnd io1 io2
Ports int_ioa vcca1 vcca2 vssa1 vssa2
Ports int_iob vccb1 vccb2 vssb1 vssb2

[End External Circuit]
=====

The scope of the following keywords is limited to the [Component] keyword.
They apply to the specific set of pin numbers and internal nodes only within
that [Component].

=====
Keywords: [Node Declarations], [End Node Declarations]
Required: Yes, if any internal nodes exist on the die as listed in
[Circuit Call], and/or if any die pads need to be explicitly
defined.
Description: Provides a list of internal die nodes and/or die pads for a
[Component] to make unambiguous interconnection descriptions
possible.
Usage Rules: All die node and die pad names that appear under any [Circuit
Call] keyword within the same [Component] must be listed under
the [Node Declarations] keyword.

If used, the [Node Declarations] keyword must appear before
any [Circuit Call] keyword(s) under the [Component] keyword.
Only one [Node Declarations] keyword is permitted for each
[Component] keyword. Since the [Node Declarations] keyword
is part of the [Component] keyword, all internal node or pad
references apply only to that [Component] (i.e., they are
local).

The internal die node and/or die pad names within [Node
Declarations] must be unique and therefore different from
the pin names used in the [Pin] keyword. Each node and/or
pad name must be separated by at least one white space. The
list may span several lines and is terminated by the [End
Node Declarations] keyword.

```

The names of die nodes and die pads can be composed of any combination of the legal characters outlined in Section 3.

[Node Declarations] | Must appear before any [Circuit Call] keyword

Die nodes:
a b c d e | List of die nodes
f g h nd1

Die pads:
pad_2a pad_2b pad_4 pad_11 | List of die pads

[End Node Declarations]

=====
Keywords: [Circuit Call], [End Circuit Call]
Required: Yes, if any [External Circuit]s are present in a [Component].
Description: This keyword is used to instantiate [External Circuit]s and to connect their ports to the die nodes or die pads.
Sub-Params: Signal_pin, Diff_signal_pins, Series_pins, Port_map
Usage Rules: The [Circuit Call] keyword must be followed by the name of an [External Circuit] that exists in the same [Component].

When a [Circuit Call] keyword defines any connections that involve one or more die pads (and consequently pins), the corresponding pins on the [Pin] list must use the reserved word "CIRCUITCALL" in the third column instead of a model name.

Each [External Circuit] must have at least one corresponding [Circuit Call] keyword. Multiple [Circuit Call] keywords may appear under a [Component] using the same [External Circuit] name, if multiple instantiations of an [External Circuit] are needed.

Signal_pin, Diff_signal_pins, or Series_pins:

The purpose of these subparameters is to identify which [External Circuit] needs to be stimulated in order to obtain a signal on a certain pin. These subparameters must be used only when the [External Circuit] that is referenced by the [Circuit Call] keyword makes use of the stimulus signal of the simulator. Any given [Circuit Call] keyword must contain no more than one instance of only one of these three subparameters. The subparameter is followed by one or two pin names which must be defined by the [Pin] keyword.

Signal_pin is used when the referenced [External Circuit] has a single analog signal port (I/O) connection to one pin. The subparameter is followed by a pin name that must match one of the pin names under the [Pin] keyword.

Diff_signal_pins is used when the referenced [External Circuit] describes a true differential model which has two analog signal port (I/O) connections, each to a separate pin. The subparameter is followed by two pin names, each of which must match one of the pin names under the [Pin] keyword. The first and second pin names correspond to the non-inverting and inverting signals of the differential model, respectively. The two pin names must not be identical.

Series_pins is used when the referenced [External Circuit] describes a Series or Series_switch model which has two analog signal port (I/O) connections to two pins. The subparameter is followed by two pin names, each of which must match one of the pin names under the [Pin] keyword. The first and second pin names correspond to the positive and negative ports of the Series or Series_switch model, respectively. However, the polarity order matters only when the model is polarity sensitive (as with the [Series Current] keyword). The two pin names must not be identical.

Port_map:

The Port_map subparameter is used to connect the ports of an [External Circuit] to die nodes or die pads.

Every occurrence of the Port_map subparameter must begin on a new line and must be followed by two arguments, the first being a port name, and the second being a die node, die pad, or a pin name.

The first argument of Port_map must contain a port name that matches one of the port names in the corresponding [External Circuit] definition. No port name may be listed more than once within a [Circuit Call] statement. Only those port names need to be listed with the Port_map subparameter which are connected to a die node or a die pad. This includes reserved and/or user-defined port names.

The second argument of the Port_map subparameter contains the name of a die node, die pad, or a pin. The names of die nodes, die pads, and pins may appear multiple times as Port_map subparameter arguments within the same [Circuit Call] statement to signify a common connection between multiple ports, such as common voltage supply.

Please note that a pin name in the second argument does not mean that the connection is made directly to the pin. Since native IBIS does not have a mechanism to declare die pads explicitly, connections to die pads are made through their corresponding pin names (listed under the [Pin] keyword). This convention must only be used with native IBIS package models where a one-to-one path between the die pads and pins is assumed. When a package model other than native IBIS is used with a [Component], the second argument of Port_map must have a die pad or die node name. These names are matched to the corresponding port name of the non-native package model by name (not by position). In this case, the package model may have an arbitrary circuit topology between the die pads and the pins. A one-to-one mapping is not required.

Examples:

NOTE REGARDING THIS EXAMPLE:

The pad_* to pin connections in Figure 12 and in the example lines with the comment, "explicit pad connection", are shown for reference. The connection syntax has not yet been defined. Therefore, the connections for pad_* to pin are not supported in this specification.

For the examples below please refer to the following diagram and the example provided for the [Node Declarations] keyword.


```

Notes:
1) The ports of the [External Model] E are automatically connected by
the tool, taking the [Pin Mapping] keyword into consideration, if exists.
2) The package model shown in this drawing assumes the capabilities of a
non-native IBIS package model are available to the model author.

[Circuit Call] A          | Instantiates [External Circuit] named "A"
Signal_pin 1
| mapping port          pad/node
Port_map  A_mypcr      a      | Port to internal node connection
Port_map  A_mypur      b      | Port to internal node connection
Port_map  A_mysig      c      | Port to internal node connection
Port_map  A_mypdr      d      | Port to internal node connection
Port_map  A_mygcr      e      | Port to internal node connection
[End Circuit Call]

[Circuit Call] B          | Instantiates [External Circuit] named "B"
Signal_pin 2
| mapping port          pad/node
Port_map  A_mypur      f      | Port to internal node connection
Port_map  A_mysig      g      | Port to internal node connection
Port_map  A_mypdr      h      | Port to internal node connection
Port_map  A_mycnt      pad_2b | Port to explicit pad connection
[End Circuit Call]

[Circuit Call] C          | Instantiates [External Circuit] named "C"
Signal_pin 3
| mapping port          pad/node
Port_map  A_mypcr      10     | Port to implicit pad connection
Port_map  A_mypur      10     | Port to implicit pad connection
Port_map  A_mysig      3      | Port to implicit pad connection
Port_map  A_mypdr      pad_11 | Port to explicit pad connection
Port_map  A_mygcr      pad_11 | Port to explicit pad connection
Port_map  D_mydrv      nd1    | Port to internal node connection
[End Circuit Call]

```

```

[Circuit Call] D | Instantiates [External Circuit] named "D"
|
Signal_pin 4a
| mapping port pad/node
Port_map A_my_pcref 10 | Port to implicit pad connection
Port_map A_my_signal pad_4 | Port to explicit pad connection
Port_map A_my_gcref pad_11 | Port to explicit pad connection
Port_map D_receive nd1 | Port to internal node connection
|
[End Circuit Call]

[Circuit Call] Die_Interconnect | Instantiates [External Circuit] named
| "Die_Interconnect"
| mapping port pad/node
Port_map vcc 10 | Port to implicit pad connection
Port_map gnd pad_11 | Port to explicit pad connection
Port_map iol 1 | Port to implicit pad connection
Port_map o2 pad_2a | Port to explicit pad connection
Port_map vcca1 a | Port to internal node connection
Port_map vcca2 b | Port to internal node connection
Port_map int_ioa c | Port to internal node connection
Port_map vssa1 d | Port to internal node connection
Port_map vssa2 e | Port to internal node connection
Port_map vccb1 f | Port to internal node connection
Port_map int_ob g | Port to internal node connection
Port_map vssb1 h | Port to internal node connection
|
[End Circuit Call]
|
=====
|
=====

```

=====
=====
Section 6c

ALGORITHMIC MODELING INTERFACE (AMI)
=====
=====

INTRODUCTION:

Executable shared library files to model advanced Serializer-Deserializer (SERDES) devices are supported by IBIS. This chapter describes how executable models written for these devices can be referenced and used by IBIS files.

The shared objects use the following keywords within the IBIS framework:

```
[Algorithmic Model]
[End Algorithmic Model]
```

The placement of these keywords within the hierarchy of IBIS is shown in the following diagram:

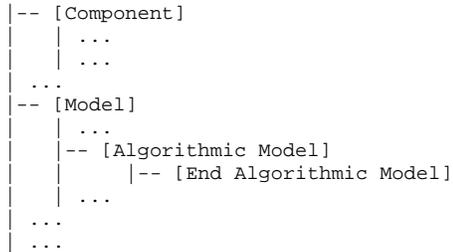


Figure 1: Partial keyword hierarchy

GENERAL ASSUMPTIONS:

This proposal breaks SERDES device modeling into two parts - electrical and algorithmic. The combination of the transmitter's analog back-end, the serial channel and the receiver's analog front-end are assumed to be linear and time invariant. There is no limitation that the equalization has to be linear and time invariant. The "analog" portion of the channel is characterized by means of an impulse response leveraging the pre-existing IBIS standard for device models.

The transmitter equalization, receiver equalization and clock recovery circuits are assumed to have a high-impedance (electrically isolated) connection to the analog portion of the channel. This makes it possible to model these circuits based on a characterization of the analog channel. The behavior of these circuits is modeled algorithmically through the use of executable code provided by the SERDES vendor. This proposal defines the functions of the executable models, the methods for passing data to and from these executable models and how the executable models are called from the EDA platform.

DEFINITIONS AND RULES:

The following Usage, Type Format and Default definitions are used throughout the following sections.

The information provided in this section is applicable to the content of the parameter definition file (.ami). Note that the rules described below deviate from the rules for .ibs files.

The content of the parameter definition file (.ami) is case sensitive.

Only the pipe ("|") character is acceptable as a comment character regardless of what the calling IBIS file uses for the comment character.

The line length of the parameter definition file (.ami) is not limited to a specific number of characters.

The root name in the file may contain an arbitrary string and does not need to match the file name.

A white space in the parameter definition file (.ami) may be one or more space, tab, and/or line termination characters.

Integers are numbers which are written without a fractional or decimal component, and fall within -2147483648 and 2147483647. If scientific notation is used then the exponent must be positive. For example, 65, 7, and -756, 123e3 are integers, 1.6, 123e99 or 123e-2 are not integers.

Float numbers are in general represented by a floating point number that may be scaled using a decimal exponent. A floating point number is represented by the significant digits, and optionally a sign and decimal point. For example, -1.23e-3, 123e-3, 1.23, 1 are all of type float.

String is a sequence of ASCII characters enclosed in double quotes (""). As defined in ANSI Standard X3.4-1986, the allowable ASCII characters consist of hexadecimal 20, 21, 23 to 7E, and the ASCII control characters 09 (HT), 0A (LF), and 0D (CR) for defining tabs and line termination sequences. The double quote character 22 (") is not allowed inside string literals.

Scaling factors or suffixes, such as p, n, etc... are not permitted in the parameter definition file (.ami). Scientific and floating point notation is permitted.

Note: Usage, Type, Format and Default and their allowed values are reserved names in the parameter definition file (.ami) discussed in the "KEYWORD DEFINITION" section.

Usage <usage>:

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Required, where <usage> must be substituted by one of the following: ~~Usage~~
(required for model specific parameters)

In	Parameter is required Input to executable
Out	Parameter is Output only from executable
Info	Information for user or EDA platform
InOut	Required Input to executable. Executable may return different value.

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Type <data_type>:

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Required, where <data_type> must be substituted by one of the following:

Type: (default is Float)

Float
Integer
String
Boolean (True/False)
Tap (For use by TX and RX equalizers)
UI (Unit Interval, 1 UI is the inverse of the data rate frequency,
for example 1 UI of a channel operating at 10 Gb/s is 100 ps)

Format <data_format> <data>:

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Where Format is optional and <data_format> and <data> are required.

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<data_format> and <data> must be substituted with one of the following:

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Value <value> Single value data. Note that Value and Default
(defined below) are mutually exclusive, and must not be used
together for the same parameter.

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Format: (default is range)

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Value <value> Single value data

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Range <typ value> <min value> <max value>
List <typ value> <value> <value> <value> ... <value>
Corner <typ value> <slow value> <fast value>
Increment <typ> <min> <max> <delta>

where $\text{min} \leq \text{typ} \leq \text{max}$ and delta is always positive.

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After expansion, the expanded values of the parameter are
 $\text{typ} + N \cdot \text{delta}$ where N is any positive or negative integer
value provided by the EDA tool during the expansion process
so that: $\text{min} \leq \text{expanded values} \leq \text{max}$

After expansion, the allowed values of the parameter are
 $\text{typ} + N \cdot \text{delta}$ where N is any positive or negative integer
value such that: $\text{min} \leq \text{typ} + N \cdot \text{delta} \leq \text{max}$

Steps <typ> <min> <max> <# steps>
Treat exactly like Increment with
<delta> == ($\text{max} - \text{min}$) / <# steps>

Table:

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The Format Table states that this parameter consists of one or more columns of data, with each row delimited by parentheses '(' and ')'. All rows must contain the same number of entries (columns). At least one row must be included. Default is illegal when Format Table is used.

The column entries must be of Type Float, UI, Integer, String or Boolean. Type Tap is illegal. If only one Type is provided, then all Table entries shall be of the specified type.

(Type <type>)

For Table only, Type can also be used to designate the entries for each column. In this case, type entries shall be given for each column in the Table:

(Type <type1> <type2> <type3> ...)

Labels is an optional leaf within Table and it is followed by a String entry for each column in the Table. Quoted null entries are permitted. Labels shall be positioned immediately before the first row in a Table and are of the form:

(Labels <"label1"> <"label2"> <"label3"> ...)

If Table is used for a reserved parameter, the rules for the number of columns and their meaning are described in the Reserved_Parameters section.

The EDA tool and the algorithmic model must always transmit the entire contents of a table through the AMI_parameters_in or AMI_parameters_out string (defined in Section 10 and illustrated in the examples below). Only the parameter_name and values in the table are included in the parameter string. The values in each row of the table are flattened into a single row of values without the parentheses surrounding each row when producing the parameter string.

For Usage Out and InOut, the number of rows returned by the executable model may differ from the number of rows documented in the .ami file, but a minimum of one row must be returned. Multiple GetWave calls are not required to return the same number of rows. For Usage Out, a one-row Table is required in the .ami file to serve as a template for single and multi-row tables. This can be used by the EDA tool to reconstruct a sequence of data values returned by the executable model into a table with as many rows as needed, and optionally for parameter initialization before being replaced by the actual Table data returned by the executable model.

Examples:

Single Row Table where all numbers are Float (note that '1' is a legal float entry):

```
(fwd (Usage In) (Type Float)
  (Table
    (1 -0.169324 1.40308 0.33024)
  )
  (Description "Application Description")
)
```

The EDA tool sends to the executable model in the parameter string:

```
(fwd 1 -0.169324 1.40308 0.33024)
```

Single Row, all numbers would be encoded as integers by the EDA tool:

```
(bit_pattern (Usage In) (Type Integer)
  (Table
    (1 1 1 1 0 0 1 0 0 1)
  )
  (Description "Bit Pattern Sequence")
)
```

The EDA tool sends to the executable model in the parameter string:

```
(bit_pattern 1 1 1 1 0 0 1 0 0 1)
```

Multiple row Table application with Labels: The optional Labels line is added above the first row. It is not sent or returned to/from the executable model, but is available to the EDA tool for information.

```
(poles (Usage InOut) (Type Float)
  (Table
    (Labels "complex_conj_flag" "real_part" "imag_part")
    (1 -5e8 0)
    (2 -9.4e8 8.3e8)
  )
)
```

```

      (1 -7.3e8 0)
    )
  (Description "Two real and two complex poles")
)

```

The EDA tool sends to the executable model in the parameter string:

```
(poles 1 -5e8 0 2 -9.4e8 8.3e8 1 -7.3e8 0)
```

An updated set with a different number of pole and row entries can be returned with a similar sequence to be converted back into the same or a different number of rows.

Type used to specify the type entry for each column(the example above is modified with Type entries for each column):

```

(poles (Usage InOut) (Type Integer Float Float)
  (Table
    (Labels "complex_conj_flag" "real_part" "imag_part")
      (1 -5e8 0)
      (2 -9.4e8 8.3e8)
      (1 -7.3e8 0)
    )
  (Description "Two real and two complex poles")
)

```

The encoding in the previous example is sent to the EDA tool and returned to the executable model.

Example of two rows with Type entries for each column (the fourth column numbers are interpreted as UI values):

```

(pdf (Usage In) (Type Integer Integer Float UI Float)
  (Table
    (Labels "Row" "Bin number" "Time" "UI" "Probability")
      (1 -5 -5e-9 -1 1e-5)
      (2 -4 -4e-9 -0.8 1e-4)
    )
  (Description "Probability Distribution Function Table")
)

```

The EDA tool sends to the executable model in the parameter string:

```
(pdf 1 -5 -5e-9 -1 1e-5 2 -4 -4e-9 -0.8 1e-4 ...)
```

Example above, but with Usage Out(only one row is necessary in the .ami file):

```

(pdf (Usage Out) (Type Integer Integer Float UI Float)
  (Table
    (Labels "Row" "Bin number" "Time" "UI" "Probability")
      (1 -5 -5e-9 -1 1e-5)
    )
  (Description "Probability Distribution Function Table")
)

```

One row is provided as a template, but the executable model can return, in the parameter string, different data and more than one row such as shown.

(pdf 1 -6 -6e-9 -1.2 3e-6 2 -5 -5e-9 -1 9e-6 ...)

~~Table The parameter name "Table" names a branch of the parameter tree rather than a single leaf. One of the leaves of this branch can be named "Labels" and, if provided, is to be assigned a string value containing a list of column names. For example:~~

```

|----- (Rx_Clock_PDF
|----- (Usage_Info)
|----- (Type_Float)
|----- (Format_Table
|----- (Labels_Row_No_Time_UI_Density)
|----- (-50 -0.1 1e-35)
|----- (-49 -0.98 2e-35)
|----- ...
|----- (0 0 1e-2)
|----- ...
|----- (49 0.98 2e-35)
|----- (50 0.1 1e-35)
|----- ) | End Table
|----- ) | End Rx_Clock_PDF

```

```

|----- Gaussian <mean> <sigma>
|----- Dual-Dirac <mean> <mean> <sigma>
|----- Composite of two Gaussian
|----- DjRj <minDj> <maxDj> <sigma>
|----- Convolve Gaussian (sigma) with uniform Modulation PDF

```

Formats Value, Corner and List can be of any defined Types whereas Formats Range, Increment and Steps can be of Types Float, UI, Integer and Tap only. Formats Gaussian, Dual-Dirac and DjRj can only be of Types Float and UI. For Format Table, the column entries must be of Type Float, UI, Integer, String or Boolean. Type Tap is illegal for Format Table. If only one Type is provided, then all Table entries shall be of the specified type. Type can also be used to designate the entries for each column in the table. More information is provided in the definition of the Table format.

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Table 4 summarizes the relationships between the different Format and Data Types for Reserved or Model Specific Parameters.

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Default <value>:
 Default and Value are mutually exclusive, and must not be used together for the same parameter. Default is not allowed for Table, Gaussian, Dual-Dirac and DjRj. Default is optional for Range, List, Corner, Increment and Steps. If a Default <value> is specified, its value must have the same Type as the parameter. For example, if Type is Boolean, <value> must be either True or False, if Type is Integer, <value> must be an integer. Also, if Default is specified, <value> must be a member of the set of allowed values of the parameter. If Default is not specified, the default value of the parameters will be the <typ> value. Depending on the Type, <value> will provide a default value for the parameter. For example, if the Type is Boolean, <value> could be True or False, if the Type is Integer, the <value> can be an integer value.

Description <string>:
 The string following Description may describe a reserved parameter, a model specific parameter, or the Algorithmic model itself. This string is used by the EDA platform to convey information to the end-user. Description <string> is optional, but its usage is highly recommended for describing the Algorithmic model and the model specific parameters of the Algorithmic model. The Description string may span multiple lines, but it is recommended that the text contained in the Description string should not exceed 120 characters per line. ASCII string following Description describes a reserved parameter, model specific parameter, or the Algorithmic model itself. It is used by the EDA platform to convey information to the end user. The entire line has to be limited to IBIS line length specification. String literals begin and end with a double quote (") and no double quotes are allowed inside the string literals.

The location of Description will determine what the parameter or model is being described.

Note that in the context of Algorithmic Model for type 'Corner', <slow value> and <fast value> align implicitly to slow and fast corners, and <slow value> does not have to be less than <fast value>. For type 'Range' and 'Increment', <min value>, <max value> does not imply slow and fast corners.

Notes:

1. Throughout the section, text strings inside the symbols "<" and ">" should be considered to be supplied or substituted by the model maker. Text strings inside "<" and ">" are not reserved and can be replaced.
2. Throughout the document, terms "long", "double" etc. are used to indicate the data types in the C programming language as published in ISO/IEC 9899-1999.

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KEYWORD DEFINITIONS:
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Keywords: [Algorithmic Model], [End Algorithmic Model]

Required: No

Description: Used to reference an external compiled model. This compiled model encapsulates signal processing functions. In the case of a receiver it may additionally include clock and data recovery functions. The compiled model can receive and modify waveforms with the analog channel, where the analog channel consists of the transmitter output stage, the transmission channel itself and the receiver input stage. This data exchange is implemented through a set of software functions. The signature of these functions is elaborated in section 10 of this document. The function interface must comply with ANSI 'C' language.

Sub-Params: Executable

Usage Rules: The [Algorithmic Model] keyword must be positioned within a [Model] section and it may appear only once for each [Model] keyword in a .ibs file. It is not permitted under the [Submodel] keyword.

The [Algorithmic Model] always processes a single waveform regardless whether the model is single ended or differential. When the model is differential the waveform passed to the [Algorithmic Model] must be a difference waveform.

[Algorithmic Model], [End Algorithmic Model]
Begins and ends an Algorithmic Model section, respectively.

Subparameter Definitions:

Executable:

Three entries follow the Executable subparameter on each line:

Platform_Compiler_Bits File_Name Parameter_File

The Platform_Compiler_Bits entry provides the name of the operating system, compiler and its version and the number of bits the shared object library is compiled for. It is a string without white spaces, consisting of three fields separated by an underscore '_'. The first field consists of the name of the operating system followed optionally by its version. The second field consists of the name of the compiler followed by optionally by its version. The third field is an integer indicating the platform architecture. If the version for either the operating system or the compiler contains an underscore, it must be converted to a hyphen '-'. This is so that an underscore is only present as a separation character in the entry.

The architecture entry can be either "32" or "64". Examples of Platform_Compiler_Bits:

```
Linux_gcc3.2.3_32
Solaris5.10_gcc4.1.1_64
Solaris_cc5.7_32
Windows_VisualStudio7.1.3088_32
HP-UX_accA.03.52_32
```

The EDA tool will check for the compiler information and verify if the shared object library is compatible with the operating system and platform.

Multiple occurrences, without duplication, of Executable are permitted to allow for providing shared object libraries for as many combinations of operating system platforms and compilers for the same algorithmic model.

The File_Name provides the name of the shared library file. The shared object library should be in the same directory as the IBIS (.ibs) file.

The Parameter_File entry provides the name of the parameter file with an extension of .ami. This must be an external file and should reside in the same directory as the .ibs file and the shared object library file. It will consist of reserved and model specific (user defined) parameters for use by the EDA tool and for passing parameter values to the model.

The model parameter file must be organized in the parameter tree format as described in section 3.1.2.6 of "NOTES ON ALGORITHMIC MODELING INTERFACE AND PROGRAMMING GUIDE", Section 10 of this document. The file must contain a distinct section or sub-tree named 'Reserved_Parameters' beginning and ending with parentheses. The file may also contain another section or sub-tree named 'Model_Specific', beginning and ending with parentheses. The sub-trees 'Reserved_Parameters' and 'Model_Specific' are branches of the root of the tree.

All leaves of the .ami file must begin with one of the following reserved words:

```
Type
Usage
Description
Default
<data_format> or Format <data_format>
```

A branch in the .ami file is an "AMI Parameter" if it contains the leaves Type, Usage, and any of the following leaves:

```
Default
<data_format> or Format <data_format>
```

and does not contain another branch. Multiple leaves containing the same reserved word are not allowed within an AMI Parameter branch. A branch which contains one or more sub-branches may only contain the (Description <string>) leaf/value pair in addition to the sub-branches. Each sub-branch of a branch must have a unique name.

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The parameter string passed in and out of the AMI executable model (described in sections 3.1.2.6, 3.1.2.7 and 3.2.2.4 of Section 10 of this document) is formatted the same way as the tree data structure in the .ami file with the following exceptions.

The EDA tool must process the content of the .ami file so that

- 1) the 'Reserved_Parameters' and 'Model_Specific' branch names and their associated open and close parentheses "(" are not included in the AMI_parameters_in string, and
- 2) the AMI Parameter branches with Usage In or Usage InOut are converted to leaf/value pairs for the AMI_parameters_in string, possibly incorporating user selections. In this conversion each AMI parameter branch name becomes a leaf name in the AMI_parameters_in string and each leaf name is followed by a white space, a value and a closing parentheses ")".

The AMI executable model must generate a parameter string that is consistent with the content of the .ami file so that

- 1) the 'Reserved_Parameters' and 'Model_Specific' branch names and their associated open and close parentheses "(" are not included in the AMI_parameters_out string, and
- 2) the AMI Parameter branches Usage Out or Usage InOut are returned as leaf/value pairs in the AMI_parameters_out string.

The EDA tool must pass a string to the AMI executable model through the AMI_parameters_in argument. This string must contain all of the leaf/value pair formatted Usage In and Usage InOut AMI parameters if there are any defined in the .ami file. No other information may be included in this string. The string must always include the root name of the parameter tree, even if there are no parameters to pass to the algorithmic model.

The AMI executable model must return a string to the EDA tool through the AMI_parameters_out argument. This string must contain all of the leaf/value pair formatted Usage InOut and Usage Out AMI parameters if there are any defined in the .ami file. No other information may be included in this string. The string must always include the root name of the parameter tree, even if there are no parameters to return to the EDA tool.

For Usage In, the value in the "AMI Parameter" leaves are determined by the EDA tool based on the "AMI Parameter" branches in the .ami file. For Usage Out, the value in the "AMI Parameter" leaves are determined by the Algorithmic Model. For Usage InOut, the value in the "AMI Parameter" leaves are first determined by the EDA tool based on the "AMI Parameter" branches in the .ami file and passed into the Algorithmic Model which may return a new value in the "AMI Parameter" leaves after some processing.

tree format as discussed in section 3.1.2.6 of "NOTES ON ALGORITHMIC MODELING INTERFACE AND PROGRAMMING GUIDE", Section 10 of this document. The file must have 2 distinct sections, or sub trees, 'Reserved_Parameters' section and 'Model_Specific' section with sections beginning and ending with parentheses. The complete tree format is described in

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~~the section 3.1.2.6 of the Section 10 of this document.~~

~~The 'Reserved_Parameter' section is required while the 'Model_Specific' section is optional. For AMI_Version 5.1 and above, the Reserved_Parameter sub-tree shall appear before the Model_Specific sub-tree. Sub-trees of these sub-trees can be in any order in the parameter file. The '|' character is the comment character. Any text after the '|' character until the end of the line will be ignored by the parser.~~

~~'Model_Specific' section is optional. The sub-trees can be in any order in the parameter file. The '|' character is the comment character. Any text after the '|' character will be ignored by the parser.~~

The Model Parameter File must be organized in the following way:

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```

(my_AMIname      | Name given to the Parameter file
(Reserved_Parameters | Required heading to start the
                    | required Reserve_Parameters
                    | section
...
    (Reserved parameter text)
...
)                | End of Reserved_Parameters
                | section
(Model_Specific  | Required heading to start the
                | optional Model_Specific section
...
    (Model specific parameter text)
...
)                | End of Model_Specific section
(Description <string> | description of the model
                    | (optional)
)                | End my_AMIname parameter file

```

All parameters must be in the following format:

```

(parameter_name (Usage <usage>
                (Type <data_type>
                ({Format} <data_format> <data>
                (Default <value>
                (Description <string>))

```

Notes:

- 1) The order of the entries is not important.
- 2) The word Format is optional as indicated by the curly braces "{" and "}" and may be ignored by the EDA tools. (The examples do not show the word Format).
- 3) Certain reserved parameter names allow only certain <data_format> selections, as described below.
- 4) The <data_format> selection of Value and Default are always mutually exclusive. Certain parameters may require Value or Default, but Value and Default are not allowed to be present together for the same parameter.
- 5) <data_format> is always required for selections other than Value.
- 6) Default is optional for <data_format> Range, List, Corner, Increment and Steps.
- 7) Default is not allowed for <data_format> Table, Gaussian, Dual-Dirac and DjRj.
- 8) Additional rules apply when <data_format> is Table. The format for <data> describes a set of rows containing data values. Each row has its set of column data values enclosed by parentheses '(' and ')'. Each row contains the same number of column values. Any or all of these columns may have different data types. For this case the <data_type> argument is either a list of data types (one for each column), or a single data type. If it is a single data type then this type shall be applied to all of the columns in each row.
- 9) Description is optional.

Reserved Parameters:

```

Init_Returns_Impulse, Use_Init_Output, GetWave_Exists,
Max_Init_Aggressors and Ignore_Bits

```

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The model parameter file must have a sub-tree with the heading 'Reserved_Parameters'. This sub-tree shall contain all the reserved parameters for the model.

The following reserved parameters are used by the EDA tool and are required if the [Algorithmic Model] keyword is present. The entries following the reserved parameter names determine their usage, type and value. Their value may be defined using either Default or Value but not both. Description is optional.

The following reserved parameters are used by the EDA tool and are required if the [Algorithmic Model] keyword is present. The entries following the reserved parameters points to its usage, type and default value. All reserved parameters must be in the following format:

```
(parameter_name (Usage <usage>)(Type <data_type>)  
(Default <values>) (Description <string>))
```

AMI_Version:

AMI_Version is of format Value, Type String and Usage Info that specifies the version of the AMI modeling language.

This parameter is required in the .ami parameter files of AMI models which are written in compliance with the IBIS Version 5.1 or later specification(s), but it is not allowed in the .ami parameter files of AMI models which are written in compliance with the IBIS Version 5.0 specification. When required, this parameter must be the first parameter defined in the Reserved_Parameter branch of the .ami file.

The value of this parameter shall be "5.1" or greater for AMI models written in compliance with the IBIS Version 5.1 or later specifications. The absence of AMI_version indicates that the AMI model was written in compliance with the IBIS Version 5.0 specification.

The version numbers of .ibs files and AMI models do not have to match. The EDA tool is expected to execute the AMI model according to the rules of the specification which corresponds to its version number.

Example:

```
(AMI_Version (Value "5.1") (Usage Info)(Type String))
```

Init_Returns_Impulse:

Init_Returns_Impulse is of usage Info and type Boolean. It tells the EDA platform whether the AMI_Init function returns a modified impulse response. When this value is set to True, the model returns the convolution of the input impulse response with the impulse response of the equalization.

GetWave_Exists:

GetWave_Exists is of usage Info and type Boolean. It tells the EDA platform whether the "AMI_GetWave" function is implemented in this model. Note that if Init_Returns_Impulse is set to "False", then Getwave_Exists MUST be set to "True".

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~~Use_Init_Output:~~

~~Use_Init_Output is of usage Info and type Boolean. When Use_Init_Output is set to "True", the EDA tool is instructed to use the output impulse response from the AMI_Init function when creating the input waveform presented to the AMI_Getwave function.~~

~~If the Reserved Parameter, Use_Init_Output, is set to "False", EDA tools will use the original (unfiltered) impulse response of the channel when creating the input waveform presented to the AMI_Getwave function.~~

~~The algorithmic model is expected to modify the waveform in place.~~

~~Use_Init_Output is optional. The default value for this parameter is "True".~~

~~If Use_Init_Output is False, GetWave_Exists must be True.~~

- The following reserved parameters are optional. If the following parameters are not present, the values are assumed as "0".

- Max_Init_Aggressors:

- Max_Init_Aggressors is of usage Info and type Integer. It tells the EDA platform how many aggressor Impulse Responses the AMI_Init function is capable of processing.

- Ignore_Bits:

- Ignore_Bits is of usage Info and type Integer. It tells the EDA platform how long the time variant model takes to complete initialization. This parameter is meant for AMI_GetWave functions that model how equalization adapts to the input stream. The value in this field tells the EDA platform how many bits of the AMI_Getwave output should be ignored.

~~The following reserved parameter provides textual description to the user defined parameters.~~

- Tx-only reserved parameters:

- Tx_Jitter and Tx_DCD

- These reserved parameters only apply to Tx models. These parameters are optional; if the parameters are not specified, the values default to "no jitter specified in the model ("0" jitter). ~~If specified, they must be in the following format:~~

~~(<parameter_name> (Usage <usage>)(Type <data_type>)
(Format <data format>) (Default <values>)
(Description <string>))~~

- Tx_Jitter:

- Tx_Jitter can of Usage Info and Out and can be of Type Float or UI. It can be of Data Format Gaussian, Dual-Dirac, DjRj or Table. It tells the EDA platform how much jitter exists

at the input to the transmitter's analog output buffer.
 Several different data formats are allowed as listed.
 Examples of Tx_Jitter declarations are:

```
(Tx_Jitter (Usage Info)(Type Float)
  (Gaussian <mean> <sigma>))
  (Format Gaussian <mean> <sigma>))
```

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```
(Tx_Jitter (Usage Info)(Type Float)
  (Dual-Dirac <mean> <mean> <sigma>))
  (Format Dual-Dirac <mean> <mean> <sigma>))
```

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```
(Tx_Jitter (Usage Info)(Type Float)
  (DjRj <minDj> <maxDj> <sigma>))
  (Format DjRj <minDj> <maxDj> <sigma>))
```

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```
(Tx_Jitter (Usage Info)(Type Integer Float Float)
  (Table
  (Labels "Row_No" "Time" "Probability"))
```

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```
(Tx_Jitter (Usage Info)(Type Float)
  (Format Table
  (Labels Row_No Time Probability)
  (-5 -5e-12 1e-10)
  (-4 -4e-12 3e-7)
  (-3 -3e-12 1e-4)
  (-2 -2e-12 1e-2)
  (-1 -1e-12 0.29)
  (0 0 0.4)
  (1 1e-12 0.29)
  (2 2e-12 1e-2)
  (3 3e-12 1e-4)
  (4 4e-12 3e-7)
  (5 5e-12 1e-10) ))
```

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Tx_DCD:

Tx_DCD (Transmit Duty Cycle Distortion) can be of Usage Info and Out. It can be of Type Float and UI and can have Data Format of Value, Range and Corner. It tells the EDA platform the maximum percentage deviation of the duration of a transmitted pulse from the nominal pulse width. Example of TX_DCD declaration is:

```
(Tx_DCD (Usage Info)(Type Float)
  (Range <typ> <min> <max>))
  (Format Range <typ> <min> <max>))
```

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Rx-only reserved parameters:

Rx_Clock_PDF and Rx_Receiver_Sensitivity

These reserved parameters only apply to Rx models. These parameters are optional; if the parameters are not specified, the values default to "0". ~~If specified, they must be in the following format:~~

```
(<parameter_name> (Usage <usage>)(Type <data_type>)
  (Format <data format>) (Default <values>))
  (Description <string>))
```

Rx_Clock_PDF:

Rx_Clock_PDF can be of Usage Info and Out and of Type Float and UI and of Data Format Gaussian, Dual-Dirac, DjRj or Table. Rx_Clock_PDF tells the EDA platform the Probability Density Function of the recovered clock. Several different data formats are allowed as listed. Examples of Rx_Clock_PDF declarations are:

```
(Rx_Clock_PDF (Usage Info)(Type Float)
              (Gaussian <mean> <sigma>))
```

~~(Format Gaussian <mean> <sigma>))~~

```
(Rx_Clock_PDF (Usage Info)(Type Float)
              (Dual-Dirac <mean> <mean> <sigma>))
```

~~(Format Dual Dirac <mean> <mean> <sigma>))~~

```
(Rx_Clock_PDF (Usage Info)(Type Float)
              (DjRj <minDj> <maxDj> <sigma>))
              (Format DjRj <minDj> <maxDj> <sigma>))
```

```
(Rx_Clock_PDF (Usage Info)(Type Integer Float Float)
              (Table
               (Labels "Row_No" "Time" "Probability")))
```

~~(Rx_Clock_PDF (Usage Info)(Type Float)~~

```
(Format Table
      (Labels Row_No Time Probability)
```

```
(-5 -5e-12 1e-10)
(-4 -4e-12 3e-7)
(-3 -3e-12 1e-4)
(-2 -2e-12 1e-2)
(-1 -1e-12 0.29)
(0 0 0.4)
(1 1e-12 0.29)
(2 2e-12 1e-2)
(3 3e-12 1e-4)
(4 4e-12 3e-7)
(5 5e-12 1e-10) ))
```

Rx_Receiver_Sensitivity:

Rx_Receiver_Sensitivity can be of Usage Info and Out and of Type Float and of Data Format Value, Range and Corner. Rx_Receiver_Sensitivity tells the EDA platform the voltage needed at the receiver data decision point to ensure proper sampling of the equalized signal. In this example, 100 mV (above +100 mV or below -100 mV) is needed to ensure the signal is sampled correctly. Examples of

~~Rx_Receiver_Sensitivity declarations are:
signal is sampled correctly. Examples of Rx_Clock_PDF
declarations are:-~~

```
(Rx_Receiver_Sensitivity (Usage Info)(Type Float)
                        (Value <value>))
                        (Format Value <value>))
```

```
(Rx_Receiver_Sensitivity (Usage Info)(Type Float)
                        (Range <typ> <min> <max>))
                        (Format Range <typ> <min> <max>))
```

```
(Rx_Receiver_Sensitivity (Usage Info)(Type Float)
                        (Corner <typ> <slow> <fast>))
```

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~~(Format Corner <slow> <fast>)~~

The general rules, allowed usage and a brief summary of the data types and data formats allowed for each reserved parameter is presented in the following tables.

Reserved Parameter	General Rules		Allowed Usage		
	Required	Default	Info	In	Out
AMI_Version (1)	Yes	--	X		
Init_Returns_Impulse	Yes	--	X		
GetWave_Exists	Yes	--	X		
Use_Init_Output (2)	No	True	X		
Ignore_Bits	No	0	X		
Init_Returns_Impulse	Yes	NA	X		
GetWave_Exists	Yes	NA	X		
Use_Init_Output	No	True	X		
Ignore_Bits	No	0	X	X	
Max_Init_Aggressors	No	0	X		
Tx_Jitter	No	No Jitter	X	X	
Tx_DCD	No	0	X	X	
Rx_Receiver_Sensitivity	No	0	X	X	
Rx_Clock_PDF	No	Clock Centered	X	X	

Table 1: General Rules and Allowed Usage for Reserved Parameters

- (1) Required for IBIS Version 5.1 and above as the first reserved parameter, and illegal for IBIS Version 5.0
- (2) Illegal for Version 5.1 and above

Reserved Parameter	Data Type				
	Float	UI	Integer	String	Boolean
AMI_Version (1)				X	
Init_Returns_Impulse					X
GetWave_Exists					X
Use_Init_Output (2)					X
Use_Init_Output					X
Ignore Bits			X		
Max_Init_Aggressors			X		
Tx_Jitter	X	X			
Tx_DCD	X	X			
Rx_Receiver_Sensitivity	X				
Rx_Clock_PDF	X	X			

Table 2: Allowed Data Types for Reserved Parameters

- (1) Required for IBIS Version 5.1 and above as the first reserved parameter, and illegal for IBIS Version 5.0
- (2) Illegal for Version 5.1 and above

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Reserved Parameter	Data Format									
	V	R	C	L	I	S	G	D	D	T
	a	a	o	i	n	a	a	u	j	a
	l	n	r	s	c	e	u	a	R	b
	u	g	n	t	r	p	s	l	j	l
	e	e	e		e	s	s	-		e
			r		m		i	D		
					e		a	i		
					n		n	r		
					t			a		
								c		
	e	e	e			s		D		e
			r					i		
								r		
								a		
								c		
AMI_Version (1)	X									
Init_Returns_Impulse	X									
GetWave_Exists	X									
Use_Init_Output (2)	X									
Use_Init_Output	X									
Ignore_Bits	X									
Max_Init_Aggressors	X									
Tx_Jitter							X	X	X	X
Tx_DCD	X	X	X							
Rx_Receiver_Sensitivity	X	X	X							
Rx_Clock_PDF							X	X	X	X

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Table 3: Allowed Data Format for Reserved Parameters

(1) Required for IBIS Version 5.1 and above as the first reserved parameter, and illegal for IBIS Version 5.0
 (2) Illegal for Version 5.1 and above

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Format	Data Type					
	Float	UI	Integer	String	Boolean	Tap
Value	X	X	X	X	X	X
Range	X	X	X			X
Corner	X	X	X	X	X	X
List	X	X	X	X	X	X
Increment	X	X	X			X
Steps	X	X	X			X
Gaussian	X	X				
Dual-Dirac	X	X				
DjRj	X	X				
Table	X	X	X	X	X	

Table 4: Allowed Data Types for Format Values

Model Specific Parameters:

The Following section describes the user defined parameters. The algorithmic model expects these parameters and their

values to function appropriately. The model maker can specify any number of user defined parameters for their model. The user defined parameter section subtree must begin with the reserved parameters 'Model_Specific'.

~~The user defined parameters must be in the following format:~~

~~(<parameter_name> (usage <usage>) (Type <data type>)
(Format <data format>) (Default <values>)
(Description <string>))~~

A tapped delay line can be described by creating a separate parameter for each tap weight and grouping all the tap weights for a given tapped delay line in a single parameter group which is given the name of the tapped delay line. If in addition the individual tap weights are each given a name which is their tap number (i.e., "-1" is the name of the first precursor tap, "0" is the name of the main tap, "1" is the name of the first postcursor tap, etc.) and the tap weights are declared to be of type Tap, then the EDA platform can assume that the individual parameters are tap weights in a tapped delay line, and use that assumption to perform tasks such as optimization. The model developer is responsible for choosing whether or not to follow this convention.

The type Tap implies that the parameter takes on floating point values. Note that if the type Tap is used and the parameter name is not a number, this is an error condition for which EDA platform behavior is not specified.

```

=====
Example of Parameter File
=====
(mySampleAMI                               | Name given to the Parameter file
 (Description "Sample AMI File")           |
 (Reserved_Parameters                      | Required heading

 (Ignore_Bits (Usage Info) (Type Integer) (Default 21)
 (Description "Ignore 21 Bits"))
 (Max_Init_Aggressors (Usage Info) (Type Integer)(Default 25))
 (Init_Returns_Impulse (Usage Info) (Type Boolean)(Default True))
 (GetWave_Exists (Usage Info) (Type Boolean) (Default True))
 )                                         | End Reserved_Parameters

 (Model_Specific                          | Required heading
 (txtaps
  (-2 (Usage InOut)(Type Tap) (Range 0.1 -0.1 0.2)(Default 0.1)
  (-2 (Usage Inout)(Type Tap) (Format Range 0.1 -0.1 0.2)(Default 0.1)
  (Description "Second Precursor Tap"))
  (-1 (Usage InOut)(Type Tap) (Range 0.2 -0.4 0.4)(Default 0.2)
  (-1 (Usage Inout)(Type Tap) (Format Range 0.2 -0.4 0.4)(Default 0.2)
  (Description "First Precursor Tap"))
  (0 (Usage InOut)(Type Tap) (Range 1 -1 2)(Default 1))
  (0 (Usage Inout)(Type Tap) (Format Range 1 -1 2)(Default 1)
  (Description "Main Tap"))
  (1 (Usage InOut)(Type Tap) (Range 0.2 -0.4 0.4)(Default2 0.2))
  (1 (Usage Inout)(Type Tap) (Format Range 0.2 -0.4 0.4)(Default2 0.2)
  (Description "First Post cursor Tap"))
  (2 (Usage InOut)(Type Tap) (Range 0.1 -0.1 0.2)(Default 0.1))
  (2 (Usage Inout)(Type Tap) (Format Range 0.1 -0.1 0.2)(Default 0.1)
  (Description "Second Post cursor Tap"))
 )                                         | End txtaps
 (tx_freq_offset (Range 1 0 150) (Type UI) (Default 0))
 (tx_freq_offset (Format Range 1 0 150) (Type UI) (Default 0))
 )                                         | End Model_Specific
 )                                         | End SampleAMI
=====
Example of RX model in [Algorithmic Model]
=====
[Algorithmic Model]
Executable Windows_VisualStudio_32 example_rx.dll example_rx_params.ami
[End Algorithmic Model]
=====
Example of TX model in [Algorithmic Model]:
=====
[Algorithmic Model]
Executable Windows_VisualStudio_32 tx_getwave.dll tx_getwave_params.ami
Executable Solaris_cc_32 libtx_getwave.so tx_getwave_params.ami
[End Algorithmic Model]
=====

```

|=====

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Section 6d

TEST LOAD AND DATA DESCRIPTION

The [Test Load] and [Test Data] keywords are top-level keywords to provide reference waveforms against which IBIS model simulation results can be compared to determine the accuracy of the IBIS data and simulator implementation.

Keyword: [Test Data]

Required: No

Description: Indicates the beginning of a set of Golden Waveforms and references the conditions under which they were derived. An IBIS file may contain any number of [Test Data] sections representing different driver and load combinations. Golden Waveforms are a set of waveforms simulated using known ideal test loads. They are useful in verifying the accuracy of behavioral simulation results against the transistor level circuit model from which the IBIS model parameters originated.

Sub-Params: Test_data_type, Driver_model, Driver_model_inv, Test_load

Usage Rules: The name following the [Test Data] keyword is required. It allows a tool to select which data to analyze.

The Test_data_type subparameter is required, and its value must be either "Single_ended" or "Differential." The value of Test_data_type must match the value of Test_load_type found in the load called by Test_load.

The Driver_model subparameter is required. Its value specifies the "device-under-test" and must be a valid [Model] name. Driver_model_inv is only legal if Test_data_type is Differential. Driver_model_inv is not required but may be used in the case in which a differential driver uses two different models for the inverting and non-inverting pins.

The Test_load subparameter is required and indicates which [Test Load] was used to derive the Golden Waveforms. It must reference a valid [Test Load] name.

[Test Data] Data1
Test_data_type Single_ended
Driver_model Buffer1
Test_load Load1

Keywords: [Rising Waveform Near], [Falling Waveform Near],
[Rising Waveform Far], [Falling Waveform Far],
[Diff Rising Waveform Near], [Diff Falling Waveform Near],
[Diff Rising Waveform Far], [Diff Falling Waveform Far]

Required: At least one Rising/Falling waveform is required under the scope of the [Test Data] keyword.

Description: Describes the shape of the rising and falling Golden Waveforms of a given driver and a given [Test Load] measured at the driver I/O pad (near) or receiver I/O pad (far). A model

developer may use the [Rising Waveform Near/Far] and [Falling Waveform Near/Far] keywords to document Golden Waveforms whose purpose is to facilitate the correlation of reference waveforms and behavioral simulations.

Usage Rules: The process, temperature, and voltage conditions under which the Golden Waveforms are generated must be identical to those used to generate the I-V and V-T tables. The Golden Waveforms must be generated using unpackaged driver and receiver models. The simulator must NOT use the Golden Waveform tables in the construction of its internal stimulus function.

The tables must conform to the format described under the [Rising Waveform] and [Falling Waveform] keywords.

Both differential and single-ended waveforms are allowed regardless of the value of Test_data_type. If Test_data_type is Single_ended then differential waveforms will be ignored. If Test_data_type is Differential, a single-ended waveform refers to the model specified by Driver_model and the non-inverting driver output.

[Rising Waveform Far]

Time	V(typ)	V(min)	V(max)
0.0000s	25.2100mV	15.2200mV	43.5700mV
0.2000ns	2.3325mV	-8.5090mV	23.4150mV
0.4000ns	0.1484V	15.9375mV	0.3944V
0.6000ns	0.7799V	0.2673V	1.3400V
0.8000ns	1.2960V	0.6042V	1.9490V
1.0000ns	1.6603V	0.9256V	2.4233V
1.2000ns	1.9460V	1.2050V	2.8130V
1.4000ns	2.1285V	1.3725V	3.0095V
1.6000ns	2.3415V	1.5560V	3.1265V
1.8000ns	2.5135V	1.7015V	3.1600V
2.0000ns	2.6460V	1.8085V	3.1695V
...			
10.0000ns	2.7780V	2.3600V	3.1670V

[Falling Waveform Far]

Time	V(typ)	V(min)	V(max)
0.0000s	5.0000V	4.5000V	5.5000V
0.2000ns	4.7470V	4.4695V	4.8815V
0.4000ns	3.9030V	4.0955V	3.5355V
0.6000ns	2.7313V	3.4533V	1.7770V
0.8000ns	1.8150V	2.8570V	0.8629V
1.0000ns	1.1697V	2.3270V	0.5364V
1.2000ns	0.7539V	1.8470V	0.4524V
1.4000ns	0.5905V	1.5430V	0.4368V
1.6000ns	0.4923V	1.2290V	0.4266V
1.8000ns	0.4639V	0.9906V	0.4207V
2.0000ns	0.4489V	0.8349V	0.4169V
...			
10.0000ns	0.3950V	0.4935V	0.3841V

=====
Keyword: [Test Load]

Required: No

Description: Defines a generic test load network and its associated electrical parameters for reference by Golden Waveforms under the [Test Data] keyword. The Golden Waveform tables correspond to a given [Test Load] which is specified by the Test_load subparameter under the [Test Data] keyword.

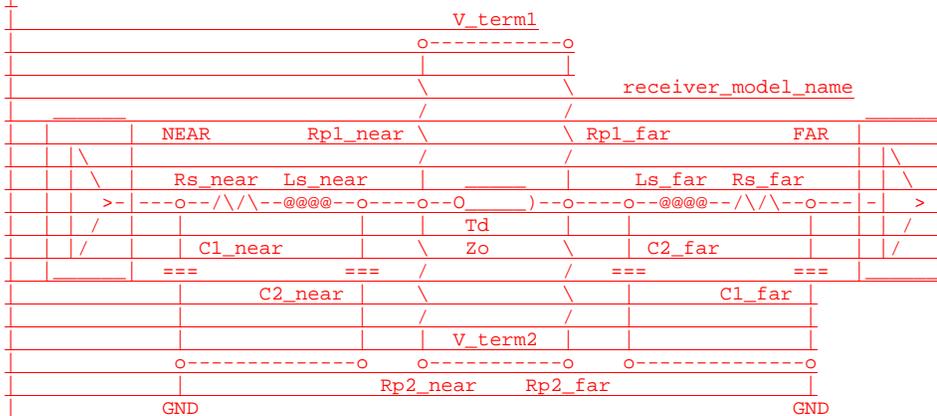
Sub-Params: Test_load_type, C1_near, Rs_near, Ls_near, C2_near, Rpl_near,

Rp2_near, Td, Zo, Rp1_far, Rp2_far, C2_far, Ls_far, Rs_far, C1_far, V_term1, V_term2, Receiver_model, Receiver_model_inv, R_diff_near, R_diff_far.

Usage Rules: The Test_load_type subparameter is required, and its value must be either "Single_ended" or "Differential."

The subparameters specify the electrical parameters associated with a fixed generic test load. The diagram below describes the single_ended test load.

All subparameters except Test_load_type are optional. If omitted, series elements are shorted and shunt elements are opened by default.



If the Td subparameter is present, then the Zo subparameter must also be present. If the Td subparameter is not present, then the simulator must remove the transmission line from the network and short the two nodes to which it was connected.

V_term1 defines the termination voltage for parallel termination resistors Rp1_near and Rp1_far. This voltage is not related to the [Voltage Range] keyword. If either Rp1_near or Rp1_far is used, then V_term1 must also be used.

V_term2 defines the termination voltage for parallel termination resistors Rp2_near and Rp2_far. If either Rp2_near or Rp2_far is used, then V_term2 must also be used.

Receiver_model is optional and indicates which, if any, receiver is connected to the far end node. If not used, the network defaults to no receiver.

Receiver_model_inv is not required but may be used in the case in which a differential receiver uses two different models for the inverting and non-inverting pins. Receiver_model_inv is ignored if Test_load_type is Single-ended.

If Test_load_type is Differential, then the test load is a pair of the above circuits. If the R_diff_near or R_diff_far subparameter is used, a resistor is connected between the near or far nodes of the two circuits. If Test_load_type is Single_ended, R_diff_near and R_diff_far are ignored.

 [Test Load] Load1

Test_load_type Single_ended

C1_near = 1p
Rs_near = 10
Rs_near = 1n
C2_near = 1p
Rp1_near = 100
Rp2_near = 100
Td = 1ns
Zo = 50
Rp1_far = 100
Rp2_far = 100
C2_far = 1p
Rs_far = 1n
Rs_far = 10
C1_far = 1p
R_diff_far = 100

Receiver_model Input1

variable	typ	min	max
<u>V_term1</u>	1.5	1.4	1.6
<u>V_term2</u>	0.0	0.0	0.0

| Example of a transmission line and receiver test load

[Test Load] Tline_rcv

Td = 1n
Zo = 50
Receiver_model Input1

=====
=====
Section 7

P A C K A G E M O D E L I N G
=====
=====

The [Package Model] keyword is optional. If more than the default RLC package model is desired, use the [Define Package Model] keyword.

Use the [Package Model] keyword within a [Component] to indicate the package model for that component. The specification permits .ibs files to contain the following additional list of package model keywords. Note that the actual package models can be in a separate <package_file_name>.pkg file or can exist in the IBIS files between the [Define Package Model] ... [End Package Model] keywords for each package model that is defined. For reference, these keywords are listed below. Full descriptions follow. EDA tools that do not support these keywords will ignore all entries between the [Define Package Model] and [End Package Model] keywords.

[Define Package Model]	Required if the [Package Model] keyword is used
[Manufacturer]	(note 1)
[OEM]	(note 1)
[Description]	(note 1)
[Number Of Sections]	(note 2)
[Number Of Pins]	(note 1)
[Pin Numbers]	(note 1)
[Model Data]	(note 2)
[Resistance Matrix]	Optional when [Model Data] is used
[Inductance Matrix]	(note 3)
[Capacitance Matrix]	(note 3)
[Bandwidth]	Required (for Banded_matrix matrices only)
[Row]	(note 3)
[End Model Data]	(note 2)
[End Package Model]	(note 1)

- (note 1) Required when the [Define Package Model] keyword is used
(note 2) Either the [Number Of Sections] or the [Model Data]/[End Model Data] keywords are required. Note that [Number of Sections] and the [Model Data]/[End Model Data] keywords are mutually exclusive.
(note 3) Required when the [Define Package Model] keyword is used and the [Number Of Sections] keyword is not used.

When package model definitions occur within a .ibs file, their scope is "local" -- they are known only within that .ibs file and no other. In addition, within that .ibs file, they override any globally defined package models that have the same name.

USAGE RULES FOR THE .PKG FILE:

Package models are stored in a file whose name looks like:

<filename>.pkg.

The <filename> provided must adhere to the rules given in Section 3, GENERAL SYNTAX RULES AND GUIDELINES. Use the ".pkg" extension to identify files containing package models. The .pkg file must contain all of the required elements of a normal .ibs file, including [IBIS Ver], [File Name], [File Rev], and the [End] keywords. Optional elements include the [Date], [Source], [Notes], [Disclaimer], [Copyright], and [Comment Char] keywords. All of the elements follow the same rules as those for a normal .ibs file.

Note that the [Component] and [Model] keywords are not allowed in the .pkg file. The .pkg file is for package models only.

=====
Keyword: [Define Package Model]

Required: Yes

Description: Marks the beginning of a package model description.

Usage Rules: If the .pkg file contains data for more than one package, each section must begin with a new [Define Package Model] keyword. The length of the package model name must not exceed 40 characters in length. Blank characters are allowed. For every package model name defined under the [Package Model] keyword, there must be a matching [Define Package Model] keyword.

[Define Package Model] QS-SMT-cer-8-pin-pkgs

=====
Keyword: [Manufacturer]

Required: Yes

Description: Declares the manufacturer of the component(s) that use this package model.

Usage Rules: The length of the manufacturer's name must not exceed 40 characters (blank characters are allowed, e.g., Texas Instruments). In addition, each manufacturer must use a consistent name in all .ibs and .pkg files.

[Manufacturer] Quality Semiconductors Ltd.

=====
Keyword: [OEM]

Required: Yes

Description: Declares the manufacturer of the package.

Usage Rules: The length of the manufacturer's name must not exceed 40 characters (blank characters are allowed). In addition, each manufacturer must use a consistent name in all .ibs and .pkg files.

Other Notes: This keyword is useful if the semiconductor vendor sells a single IC in packages from different manufacturers.

[OEM] Acme Packaging Co.

```

=====
Keyword: [Description]
Required: Yes
Description: Provides a concise yet easily human-readable description of
Usage Rules: The description must be less than 60 characters in length,
              what kind of package the [Package Model] is representing.
              must fit on a single line, and may contain spaces.
-----
[Description] 220-Pin Quad Ceramic Flat Pack
=====
Keyword: [Number Of Sections]
Required: No
Description: Defines the maximum number of sections that make up a 'package
              stub'. A package stub is defined as the connection between
              the die pad and the corresponding package pin; it can include
              (but is not limited to) the bondwire, the connection between
              the bondwire and pin, and the pin itself. This keyword must
              be used if a modeler wishes to describe any package stub as
              other than a single, lumped L/R/C. The sections of a package
              stub are assumed to connect to each other in a series fashion.
Usage Rules: The argument is a positive integer greater than zero. This
              keyword, if used, must appear in the specification before the
              [Pin Numbers] keyword. The maximum number of sections
              includes sections between the Fork and Endfork subparameters.
-----
[Number Of Sections] 3
=====
Keyword: [Number Of Pins]
Required: Yes
Description: Tells the parser how many pins to expect.
Usage Rules: The field must be a positive decimal integer. The [Number
              Of Pins] keyword must be positioned before the [Pin Numbers]
              keyword.
-----
[Number Of Pins] 128
=====
Keyword: [Pin Numbers]
Required: Yes
Description: Tells the parser the set of names that are used for the
              package pins and also defines pin ordering. If the [Number Of
              Sections] keyword is present it also lists the elements for
              each section of a pin's die to pin connection.
Sub-Params: Len, L, R, C, Fork, Endfork
Usage Rules: Following the [Pin Numbers] keyword, the names of the pins are
              listed. There must be as many names listed as there are pins
              (as given by the preceding [Number Of Pins] keyword). Pin
              names can not exceed 5 characters in length. The first pin
              name given is the "lowest" pin, and the last pin given is the
              "highest." If the [Number Of Sections] keyword is used then
              each pin name must be followed by one or more of the legal
              subparameter combinations listed below. If the [Number Of
              Sections] keyword is not present then subparameter usage is
              NOT allowed.

```

Subparameters:

The Len, L, R, and C subparameters specify the length, inductance, capacitance and resistance of each section of each stub on a package.

The Fork and Endfork subparameters are used to denote branches from the main package stub.

- Len The length of a package stub section. Lengths are given in terms of arbitrary 'units'.
- L The inductance of a package stub section, in terms of henries/unit length. For example, if the total inductance of a section is 3.0nH and the length of the section is 2 'units', the inductance would be listed as $L = 1.5\text{nH}$ (i.e. $3.0 / 2$).
- C The capacitance of a package stub section, in terms of farads/unit length.
- R The DC (ohmic) resistance of a package stub section, in terms of ohms/unit length.
- Fork This subparameter indicates that the sections following (up to the Endfork subparameter) are part of a branch off of the main package stub. This subparameter has no arguments.
- Endfork This subparameter indicates the end point of a branch. For every Fork subparameter there must be a corresponding Endfork subparameter. As with the Fork subparameter, the Endfork subparameter has no arguments.

Specifying a Len or L/R/C value of zero is allowed. If $\text{Len} = 0$ is specified, then the L/R/C values are the total for that section. If a non-zero length is specified, then the total L/R/C for a section is calculated by multiplying the value of the Len subparameter by the value of the L, R, or C subparameter. However, if a non-zero length section is specified, the L and C for that section should be treated as distributed elements.

Using The Subparameters to Describe Package Stub Sections:

A section description begins with the Len subparameter and ends with the slash (/) character. The value of the Len, L, R, and C subparameters and the subparameter itself are separated by an equals sign (=); white space around the equals sign is optional. The Fork and Endfork subparameters are placed between section descriptions (i.e., between the concluding slash of one section and the 'Len' parameter that starts another). A particular section description can contain no data (i.e., the description is given as 'Len = 0 /').

Legal Subparameter Combinations for Section Descriptions:

- A) A single $\text{Len} = 0$ subparameter, followed by a slash. This is used to describe a section with no data.

B) Len, and one or more of the L, R and C subparameters. If the Len subparameter is given as zero, then the L/R/C subparameters represent lumped elements. If the Len subparameter is non-zero, then the L/R/C subparameters represent distributed elements.

C) Single Fork or Endfork subparameter. Normally, a package stub is described as several sections, with the Fork and Endfork subparameters surrounding a group of sections in the middle of the complete package stub description. However, it is legal for the Fork/Endfork subparameters to appear at the end of a section description. The package pin is connected to the last section of a package stub description not surrounded by a Fork/Endfork statements. See the examples below.

Package Stub Boundaries:

A package stub description starts at the connection to the die and ends at the point at which the package pin interfaces with the board or substrate the IC package is mounted on. Note that in the case of a component with through-hole pins, the package stub description should include only the portion of the pin not physically inserted into the board or socket. However, it is legal for a package stub description to include both the component and socket together if this is how the component is intended to be used.

A three-section package stub description that includes a bond wire (lumped inductance), a trace (treated as a transmission line with DC resistance), and a pin modeled as a lumped L/C element.

[Pin Numbers]

A1 Len=0 L=1.2n/ Len=1.2 L=2.0n C=0.5p R=0.05/ Len=0 L=2.0n C=1.0p/

Pin A2 below has a section with no data

A2 Len=0 L=1.2n/ Len=0/ Len=1.2 L=2.0n C=0.5p R=0.05/ Len=0 L=2.0n C=1.0p/

A section description using the Fork and Endfork subparameters. Note that the indentation of the Fork and Endfork subparameters are for readability are not required.

A1 Len=0 L=2.3n /	bondwire
Len=1.2 L=1.0n C=2.5p /	first section
Fork	indicates the starting of a branch
Len=1.0 L=2.0n C=1.5p /	section
Endfork	ending of the branch
Len=0.5 L=1.0 C=2.5p/	second section
Len=0.0 L=1.5n /	pin

| Here is an example where the Fork/Endfork subparameters are at the end of a package stub description.

```
B13 Len=0 L=2.3n / | bondwire
Len=1.2 L=1.0n C=2.5p / | first section
Len=0.5 L=1.0 C=2.5/ | second section, pin connects here
Fork | indicates the starting of a branch
Len=1.0 L=2.0n C=1.5p / | section
Endfork | ending of the branch
```

```
=====
Keyword: [Model Data]
Required: Yes
Description: Indicates the beginning of the formatted package model data,
that can include the [Resistance Matrix], [Inductance Matrix],
[Capacitance Matrix], [Bandwidth], and [Row] keywords.
-----
```

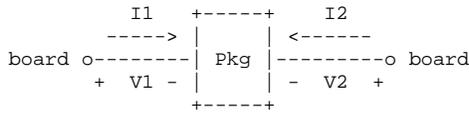
[Model Data]

```
=====
Keyword: [End Model Data]
Required: Yes
Description: Indicates the end of the formatted model data.
Other Notes: In between the [Model Data] and [End Model Data] keywords is
the package model data itself. The data is a set of three
matrices: the resistance (R), inductance (L), and capacitance
(C) matrices. Each matrix can be formatted differently (see
below). Use one of the matrix keywords below to mark the
beginning of each new matrix.
-----
```

[End Model Data]

```
=====
Keywords: [Resistance Matrix], [Inductance Matrix], [Capacitance Matrix]
Required: [Resistance Matrix] is optional. If it is not present, its
entries are assumed to be zero. [Inductance Matrix] and
[Capacitance Matrix] are required.
Sub-Params: Banded_matrix, Sparse_matrix, or Full_matrix
Description: The subparameters mark the beginning of a matrix, and specify
how the matrix data is formatted.
Usage Rules: For each matrix keyword, use only one of the subparameters.
After each of these subparameters, insert the matrix data in
the appropriate format. (These formats are described in
detail below.)
Other Notes: The resistance, inductance, and capacitance matrices are also
referred to as "RLC matrices" within this specification.
```

When measuring the entries of the RLC matrices, either with laboratory equipment or field-solver software, currents are defined as ENTERING the pins of the package from the board (General Syntax Rule #11). The corresponding voltage drops are to be measured with the current pointing "in" to the "+" sign and "out" of the "-" sign.



It is important to observe this convention in order to get the correct signs for the mutual inductances and resistances.

```

-----
[Resistance Matrix]   Banded_matrix
[Inductance Matrix]  Sparse_matrix
[Capacitance Matrix] Full_matrix

```

=====
RLC MATRIX NOTES:

For each [Resistance Matrix], [Inductance Matrix], or [Capacitance Matrix] a different format can be used for the data. The choice of formats is provided to satisfy different simulation accuracy and speed requirements.

Also, there are many packages in which the resistance matrix can have no coupling terms at all. In this case, the most concise format (Banded_matrix) can be used.

There are two different ways to extract the coefficients that are reported in the capacitance and inductance matrices. For the purposes of this specification, the coefficients reported in the capacitance matrices shall be the 'electrostatic induction coefficients' or 'Maxwell's capacitances'. The Maxwell capacitance K_{ij} is defined as the charge induced on conductor "j" when conductor "i" is held at 1 volt and all other conductors are held at zero volts. Note that K_{ij} (when $i \neq j$) will be a negative number and should be entered as such. Likewise, for the inductance matrix the coefficients for L_{ij} are defined as the voltage induced on conductor "j" when conductor "i"'s current is changed by 1 amp/sec and all other conductors have no current change.

One common aspect of all the different formats is that they exploit the symmetry of the matrices they describe. This means that the entries below the main diagonal of the matrix are identical to the corresponding entries above the main diagonal. Therefore, only roughly one-half of the matrix needs to be described. By convention, the main diagonal and the UPPER half of the matrix are provided.

In the following text, we use the notation [I, J] to refer to the entry in row I and column J of the matrix. Note that I and J are allowed to be alphanumeric strings as well as integers. An ordering of these strings is defined in the [Pin Numbers] section. In the following text, "Row 1" means the row corresponding to the first pin.

Also note that the numeric entries of the RLC matrices are standard IBIS floating point numbers. As such, it is permissible to use multiplier "suffix" notation. Thus, an entry of the C matrix could be given as 1.23e-12 or as 1.23p or 1.23pF.

Full_matrix:

When the Full_matrix format is used, the couplings between every pair of elements is specified explicitly. Assume that the matrix has N rows and N columns. The Full_matrix is specified one row at a time, starting with Row 1 and continuing down to Row N.

Each new row is identified with the Row keyword.

```
-----
Keyword: [Row]
Required:  Yes
Description: Indicates the beginning of a new row of the matrix.
Usage Rules: The argument must be one of the pin names listed under the
              [Pin Numbers] keyword.
-----
```

```
[Row]      3
```

```
-----
Following a [Row] keyword is a block of numbers that represent the entries
for that row. Suppose that the current row is number M. Then the first
number listed is the diagonal entry, [M,M]. Following this number are the
entries of the upper half of the matrix that belong to row M: [M, M+1],
[M, M+2], ... up to [M,N].
-----
```

For even a modest-sized package, this data will not all fit on one line. You can break the data up with new-line characters so that the 120 character line length limit is observed.

An example: suppose the package has 40 pins and that we are currently working on Row 19. There is 1 diagonal entry, plus $40 - 19 = 21$ entries in the upper half of the matrix to be specified, for 22 entries total. The data might be formatted as follows:

```
[Row]  19
5.67e-9  1.1e-9  0.8e-9  0.6e-9  0.4e-9  0.2e-9  0.1e-9  0.09e-9
8e-10   7e-10   6e-10   5e-10   4e-10   3e-10   2e-10   1e-10
9e-11   8e-11   7e-11   6e-11   5e-11   4e-11
```

In the above example, the entry 5.67e-9 is on the diagonal of row 19.

Observe that Row 1 always has the most entries, and that each successive row has one fewer entry than the last; the last row always has just a single entry.

Banded_matrix:

A Banded_matrix is one whose entries are guaranteed to be zero if they are farther away from the main diagonal than a certain distance, known as the "bandwidth." Let the matrix size be $N \times M$, and let the bandwidth be B . An entry $[I,J]$ of the matrix is zero if:

$$| I - J | > B$$

where $| \cdot |$ denotes the absolute value.

The Banded_matrix is used to specify the coupling effects up to B pins on either side. Two variations are supported. One allows for the coupling to circle back on itself. This is technically a simple form of a bordered block diagonal matrix. However, its data can be completely specified in terms of a Banded_matrix for an N x M matrix consisting of N rows and M = N + B columns. The second variation is just in terms of an N x N matrix where no circle back coupling needs to be specified.

The bandwidth for a Banded_matrix must be specified using the [Bandwidth] keyword:

```
=====
Keyword: [Bandwidth]
Required:  Yes (for Banded_matrix matrices only)
Description: Indicates the bandwidth of the matrix.
Usage Rules: The bandwidth field must be a non-negative integer. This
keyword must occur after the [Resistance Matrix], etc.,
keywords, and before the matrix data is given.
=====
```

```
[Bandwidth]      10
```

```
=====
Specify the banded matrix one row at a time, starting with row 1 and working
up to higher rows. Mark each row with the [Row] keyword, as above. As
before, symmetry is exploited: do not provide entries below the main
diagonal.
```

For the case where coupling can circle back on itself, consider a matrix of N pins organized into N rows 1 ... N and M columns 1 ... N, 1 ... B. The first row only needs to specify the entries [1,1] through [1,1+B] since all other entries are guaranteed to be zero. The second row will need to specify the entries [2,2] through [2,2+B], and so on. For row K the entries [K,K] through [K,K+B] are given when K + B is less than or equal to the size of the matrix N. When K + B exceeds N, the entries in the last columns 1 ... B specify the coupling to the first rows. For row K, the entries [K,K] ... [K,N] [K,1] ... [K,R] are given where $R = \text{mod}(K + B - 1, N) + 1$. All rows will contain B + 1 entries. To avoid redundant entries, the bandwidth is limited to $B \leq \text{int}((N - 1) / 2)$.

For the case where coupling does not circle back on itself, the process is modified. Only N columns need to be considered. When K + B finally exceeds the size of the matrix N, the number of entries in each row starts to decrease; the last row (row N) has only 1 entry. This construction constrains the bandwidth to $B < N$.

As in the Full_matrix, if all the entries for a particular row do not fit into a single 120-character line, the entries can be broken across several lines.

It is possible to use a bandwidth of 0 to specify a diagonal matrix (a matrix with no coupling terms.) This is sometimes useful for resistance matrices.

Sparse_matrix:

A Sparse_matrix is expected to consist mostly of zero-valued entries, except for a few nonzeros. Unlike the Banded_matrix, there is no restriction on where the nonzero entries can occur. This feature is useful in certain situations, such as for Pin Grid Arrays (PGAs).

As usual, symmetry can be exploited to reduce the amount of data by eliminating from the matrix any entries below the main diagonal.

An N x N Sparse_matrix is specified one row at a time, starting with row 1 and continuing down to row N. Each new row is marked with the [Row] keyword, as in the other matrix formats.

Data for the entries of a row is given in a slightly different format, however. For the entry [I, J] of a row, it is necessary to explicitly list the name of pin J before the value of the entry is given. This specification serves to indicate to the parser where the entry is put into the matrix.

The proper location is not otherwise obvious because of the lack of restrictions on where nonzeros can occur. Each (Index, Value) pair is listed upon a separate line. An example follows. Suppose that row 10 has nonzero entries [10,10], [10,11], [10,15], and [10,25]. The following row data would be provided:

```
[Row] 10
| Index      Value
10      5.7e-9
11      1.1e-9
15      1.1e-9
25      1.1e-9
```

Note that each of the column indices listed for any row must be greater than or equal to the row index, because they always come from the upper half of the matrix. When alphanumeric pin names are used, special care must be taken to ensure that the ordering defined in the [Pin Numbers] section is observed.

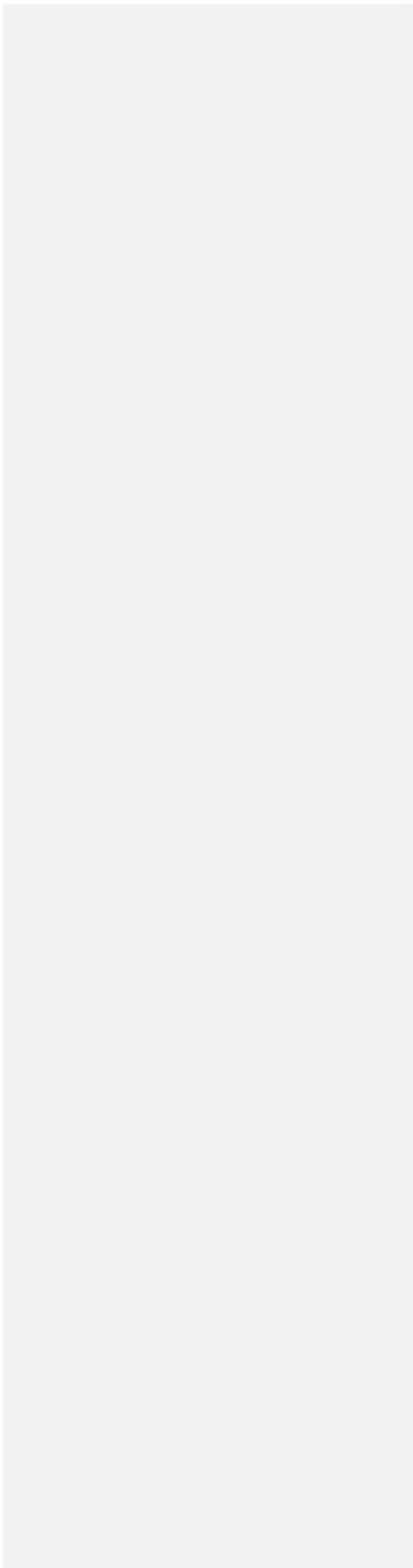
With this convention, please note that the Nth row of an N x N matrix has just a single entry (the diagonal entry).

=====

```
=====
Keyword: [End Package Model]
Required:  Yes
Description: Marks the end of a package model description.
Usage Rules: This keyword must come at the end of each complete package
              model description.

              Optionally, add a comment after the [End Package Model]
              keyword to clarify which package model has just ended. For
              example,

              [Define Package Model]  My_Model
              |
              | ... content of model ...
              |
              [End Package Model]    | end of My_Model
=====
[End Package Model]
=====
```



```

=====
                        Package Model Example

The following is an example of a package model file following the
package modeling specifications.  For the sake of brevity, an 8-pin package
has been described.  For purposes of illustration, each of the matrices is
specified using a different format.

=====

[IBIS Ver]      5.0
[File Name]    example.pkg
[File Rev]     0.1
[Date]         August 29, 2008
[Source]       Quality Semiconductors.  Data derived from Helmholtz Inc.'s
              field solver using 3-D Autocad model from Acme Packaging.
[Notes]        Example of couplings in packaging
[Disclaimer]   The models given below may not represent any physically
              realizable 8-pin package.  They are provided solely for the
              purpose of illustrating the .pkg file format.

=====

[Define Package Model] QS-SMT-cer-8-pin-pkgs
[Manufacturer]       Quality Semiconductors Ltd.
[OEM]                Acme Package Co.
[Description]        8-Pin ceramic SMT package
[Number Of Pins]     8

[Pin Numbers]
1
2
3
4
5
6
7
8

[Model Data]
The resistance matrix for this package has no coupling

[Resistance Matrix]  Banded_matrix
[Bandwidth]          0
[Row] 1
10.0
[Row] 2
15.0
[Row] 3
15.0
[Row] 4
10.0
[Row] 5
10.0

```

```

[Row] 6
15.0
[Row] 7
15.0
[Row] 8
10.0

```

| The inductance matrix has loads of coupling

```

[Inductance Matrix]      Full_matrix
[Row] 1
3.04859e-07      4.73185e-08      1.3428e-08      6.12191e-09
1.74022e-07      7.35469e-08      2.73201e-08      1.33807e-08
[Row] 2
3.04859e-07      4.73185e-08      1.3428e-08      7.35469e-08
1.74022e-07      7.35469e-08      2.73201e-08
[Row] 3
3.04859e-07      4.73185e-08      2.73201e-08      7.35469e-08
1.74022e-07      7.35469e-08
[Row] 4
3.04859e-07      1.33807e-08      2.73201e-08      7.35469e-08
1.74022e-07
[Row] 5
4.70049e-07      1.43791e-07      5.75805e-08      2.95088e-08
[Row] 6
4.70049e-07      1.43791e-07      5.75805e-08
[Row] 7
4.70049e-07      1.43791e-07
[Row] 8
4.70049e-07

```

| The capacitance matrix has sparse coupling

```

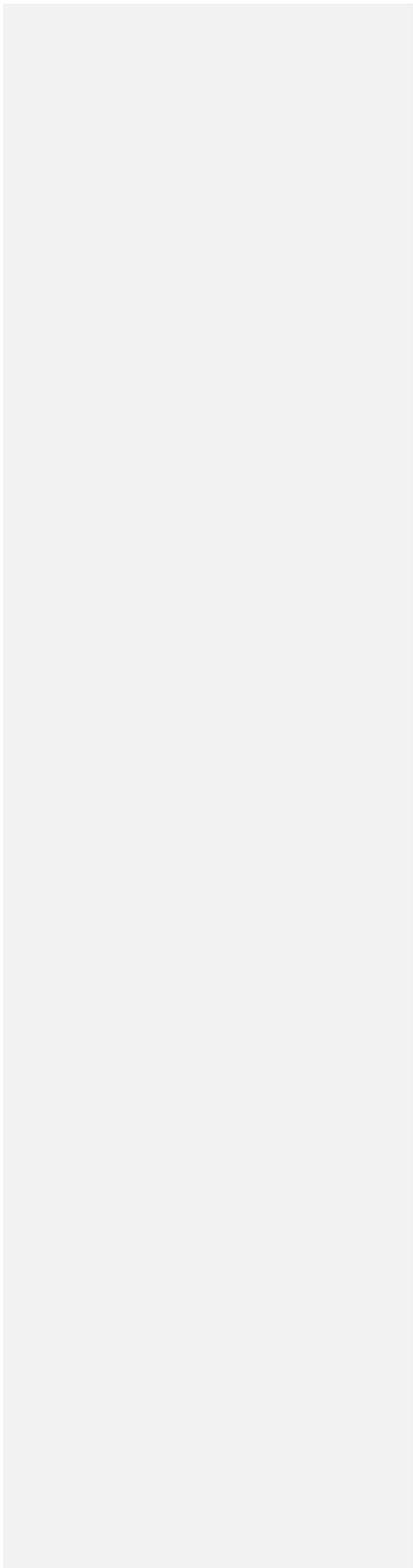
[Capacitance Matrix]      Sparse_matrix
[Row] 1
1      2.48227e-10
2      -1.56651e-11
5      -9.54158e-11
6      -7.15684e-12
[Row] 2
2      2.51798e-10
3      -1.56652e-11
5      -6.85199e-12
6      -9.0486e-11
7      -6.82003e-12
[Row] 3
3      2.51798e-10
4      -1.56651e-11
6      -6.82003e-12
7      -9.0486e-11
8      -6.85199e-12
[Row] 4
4      2.48227e-10
7      -7.15684e-12
8      -9.54158e-11

```

```
[Row] 5
5      1.73542e-10
6      -3.38247e-11
[Row] 6
6      1.86833e-10
7      -3.27226e-11
[Row] 7
7      1.86833e-10
8      -3.38247e-11
[Row] 8
8      1.73542e-10
```

```
|
[End Model Data]
[End Package Model]
```

```
|=====
|=====
```



=====
=====
Section 8

E L E C T R I C A L B O A R D D E S C R I P T I O N
=====
=====

A "board level component" is the generic term to be used to describe a printed circuit board (PCB) or substrate which can contain components or even other boards, and which can connect to another board through a set of user visible pins. The electrical connectivity of such a board level component is referred to as an "Electrical Board Description". For example, a SIMM module is a board level component that is used to attach several DRAM components on the PCB to another board through edge connector pins. An electrical board description file (a .ebd file) is defined to describe the connections of a board level component between the board pins and its components on the board.

A fundamental assumption regarding the electrical board description is that the inductance and capacitance parameters listed in the file are derived with respect to well-defined reference plane(s) within the board. Also, this current description does not allow one to describe electrical (inductive or capacitive) coupling between paths. It is recommended that if coupling is an issue, then an electrical description be extracted from the physical parameters of the board.

What is, and is not, included in an Electrical Board Description is defined by its boundaries. For the definition of the boundaries, see the Description section under the [Path Description] Keyword.

USAGE RULES:

A .ebd file is intended to be a stand-alone file, not referenced by or included in any .ibs or .pkg file. Electrical Board Descriptions are stored in a file whose name looks like <filename>.ebd, where <filename> must conform to the naming rules given in the General Syntax Section of this specification. The .ebd extension is mandatory.

CONTENTS:

A .ebd file is structured similar to a standard IBIS file. It must contain the following keywords, as defined in the IBIS specification: [IBIS Ver], [File Name], [File Rev], and [End]. It may also contain the following optional keywords: [Comment Char], [Date], [Source], [Notes], [Disclaimer], and [Copyright]. The actual board description is contained between the keywords [Begin Board Description] and [End Board Description], and includes the keywords listed below:

```
[Begin Board Description]
[Manufacturer]
[Number Of Pins]
[Pin List]
[Path Description]
[Reference Designator Map]
[End Board Description]
```

More than one [Begin Board Description]/[End Board Description] keyword pair is allowed in a .ebd file.

```
=====
Keyword: [Begin Board Description]
Required: Yes
Description: Marks the beginning of an Electrical Board Description.
Usage Rules: The keyword is followed by the name of the board level
              component. If the .ebd file contains more than one [Begin
              Board Description] keyword, then each name must be unique.
              The length of the component name must not exceed 40 characters
              in length, and blank characters are allowed. For every
              [Begin Board Description] keyword there must be a matching
              [End Board Description] keyword.
=====
```

```
[Begin Board Description] 16Meg X 8 SIMM Module
```

```
=====
Keyword: [Manufacturer]
Required: Yes
Description: Declares the manufacturer of the component(s) that use this
              .ebd file.
Usage Rules: Following the keyword is the manufacturer's name. It must not
              exceed 40 characters, and can include blank characters. Each
              manufacturer must use a consistent name in all .ebd files.
=====
```

```
[Manufacturer] Quality SIMM Corp.
```

```
=====
Keyword: [Number Of Pins]
Required: Yes
Description: Tells the parser the number of pins to expect. Pins are any
              externally accessible electrical connection to the component.
Usage Rules: The field must be a positive decimal integer. Note: The
              simulator must not limit the Number Of Pins to any value less
              than 1,000. The [Number Of Pins] keyword must be positioned
              before the [Pin List] keyword.
=====
```

```
[Number Of Pins] 128
```

```

=====
Keyword: [Pin List]
Required: Yes
Description: Tells the parser the pin names of the user accessible pins.
             It also informs the parser which pins are connected to power
             and ground.
Sub-Params: signal_name
Usage Rules: Following the [Pin List] keyword are two columns. The first
             column lists the pin name while the second lists the data book
             name of the signal connected to that pin. There must be as
             many pin_name/signal_name rows as there are pins given by the
             preceding [Number Of Pins] keyword. Pin names must be the
             alphanumeric external pin names of the part. The pin names
             cannot exceed eight characters in length. Any pin associated
             with a signal name that begins with "GND" or "POWER" will be
             interpreted as connecting to the boards ground or power plane.
             In addition, NC is a legal signal name and indicates that the
             Pin is a 'no connect'. As per the IBIS standard "GND",
             "POWER" and "NC" are case insensitive.
=====

```

A SIMM Board Example:

```

[Pin List] signal_name
A1         GND
A2         data1
A3         data2
A4         POWER5   | This pin connects to 5 V
A5         NC       | a no connect pin
.
.
A22        POWER3.3 | This pin connects to 3.3 V
B1         casa
.
.
etc.

```

```

=====
Keyword: [Path Description]
Required: Yes
Description: This keyword allows the user to describe the connection
             between the user accessible pins of a board level component
             and other pins or pins of the ICs mounted on that board. Each
             pin to node connection is divided into one or more cascaded
             "sections", where each section is described in terms of its
             L/R/C per unit length. The Fork and Endfork subparameters
             allow the path to branch to multiple nodes, or another pin. A
             path description is required for each pin whose signal name is
             not "GND", "POWER" or "NC".
=====

```

Board Description and IC Boundaries:

In any system, each board level component interfaces with another board level component at some boundary. Every electrical board description must contain the components necessary to represent the behavior of the board level component being described within its boundaries. The boundary definition depends upon the board level component being described.

For CARD EDGE CONNECTIONS such as a SIMM or a PC Daughter Card plugged into a SIMM Socket or Edge Connector, the boundary should be at the end of the board card edge pads as they emerge from the connector.

For any THROUGH-HOLE MOUNTED COMPONENT, the boundary will be at the surface of the board on which the component is mounted.

SURFACE MOUNTED COMPONENT models end at the outboard end of their recommended surface mount pads.

If the board level component contains an UNMATED CONNECTOR, the unmated connector will be described in a separate file, with its boundaries being as described above for the through-hole or surface mounted component.

Sub-Params: Len, L, R, C, Fork, Endfork, Pin, Node
Usage Rules: Each individual connection path (user pin to node(s)) description begins with the [Path Description] keyword and a path name, followed by the subparameters used to describe the path topology and the electrical characteristics of each section of the path. The path name must not exceed 40 characters, blanks are not allowed, and each occurrence of the [Path Description] keyword must be followed by a unique path name. Every signal pin (pins other than POWER, GND or NC) must appear in one and only one path description per [Begin Board Description]/[End Board Description] pair. Pin names do not have to appear in the same order as listed in the [Pin List] table. The individual subparameters are broken up into those that describe the electrical properties of a section, and those that describe the topology of a path.

Section Description Subparameters:

The Len, L, R, and C subparameters specify the length, the series inductance, resistance, and the capacitance to ground of each section in a path description.

Len The physical length of a section. Lengths are given in terms of arbitrary 'units'. Any non-zero length requires that the parameters that follow must be interpreted as distributed elements by the simulator.
L The series inductance of a section, in terms of henries/unit length. For example, if the total inductance of a section is 3.0 nH and the length of the section is 2 'units', the inductance would be listed as L = 1.5nH (i.e. 3.0 / 2).

- C The capacitance to ground of a section, in terms of farads/unit length.
- R The series DC (ohmic) resistance of a section, in terms of ohms/unit length.

Topology Description Subparameters:

The Fork and Endfork subparameters denote branches from the main pin-to-node or pin-to-pin connection path. The Node subparameter is used to reference the pin of a component or board as defined in a .ibs or .ebd file. The Pin subparameter is used to indicate the point at which a path connects to a user visible pin.

- Fork This subparameter indicates that the sections following (up to the Endfork subparameter) are part of a branch off of the main connection path. This subparameter has no arguments.
- Endfork This subparameter indicates the end point of a branch. For every Fork subparameter there must be a corresponding Endfork subparameter. As with the Fork subparameter, the Endfork subparameter has no arguments. The Fork and Endfork parameters must appear on separate lines.
- Node reference_designator.pin
This subparameter is used when the connection path connects to a pin of another, externally defined component. The arguments of the Node subparameter indicate the pin and reference designator of the external component. The pin and reference designator portions of the argument are separated by a period ("."). The reference designator is mapped to an external component description (another .ebd file or .ibs file) by the [Reference Designator Map] Keyword. Note that a Node MUST reference a model of a passive or active component. A Node is not an arbitrary connection point between two elements or paths.
- Pin This subparameter is used to mark the point at which a path description connects to a user accessible pin. Every path description must contain at least one occurrence of the Pin subparameter. It may also contain the reserved word NC. The value of the Pin subparameter must be one of the pin names listed in the [Pin List] section.

Note: The reserved word NC can also be used in path descriptions in a similar manner as the subparameters in order to terminate paths. This usage is optional.

Using The Subparameters to Describe Paths:

A section description begins with the Len subparameter and ends with the slash (/) character. The value of the Len, L, R, and C subparameters and the subparameter itself are separated by an equals sign (=); white space around the equals sign is optional. The Fork, Endfork, Node and Pin subparameters are placed between section descriptions (i.e., between the concluding slash of one section and the 'Len' parameters that starts another). The arguments of the Pin and Node subparameter are separated by white space.

Specifying a Len or L/R/C value of zero is allowed. If

Len = 0 is specified, then the L/R/C values are the total for that section. If a non-zero length is specified, then the total L/R/C for a section is calculated by multiplying the value of the Len subparameter by the value of the L, R, or C subparameter. However, as noted below, if a non-zero length is specified, that section MUST be interpreted as distributed elements.

Legal Subparameter Combinations for Section Descriptions:

A) Len, and one or more of the L, R and C subparameters. If the Len subparameter is given as zero, then the L/R/C subparameters represent lumped elements. If the Len subparameter is non-zero, then the L/R/C subparameters represent distributed elements and both L and C must be specified, R is optional. The segment Len .../ must not be split; the whole segment must be on one line.

B) The first subparameter following the [Path Description] keyword must be 'Pin', followed by one or more section descriptions. The path description can terminate in a Node, another pin or the reserved word, NC. However, NC may be optionally omitted.

Dealing With Series Elements:

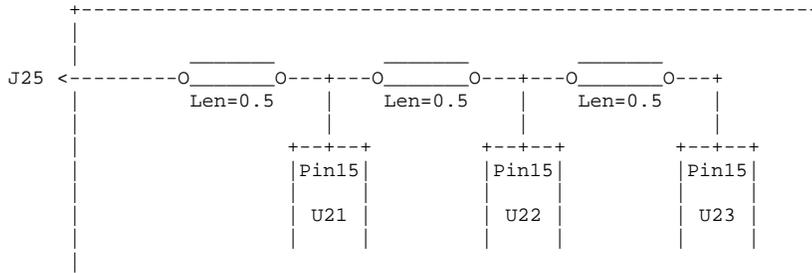
A discrete series R or L component can be included in a path description by defining a section with Len=0 and the proper R or L value. A discrete series component can also be included in a path description

~~by writing node statements that reference the same component. This can be done as two back to back node statements for a series component within a single [Path Description]. It is also allowed to insert a series component between two branches of a single [Path Description], or even between two separate [Path Description]s (see the examples below).~~

~~When a series component is modeled with node statements and reference designator.pin arguments, the referenced pin models can be Series or Series_switch. The following models are supported: [R Series], [L Series], [C Series], [Rl Series], [Lc Series], [Rc Series], [Series Current], and [Series MOSFET]. ~~by writing two back to back node statements that reference the same component (see the example below). Note that both ends of a discrete, two terminal component MUST be contained in a single [Path Description]. Connecting two separate [Path Description]s with a series component is not allowed.~~~~

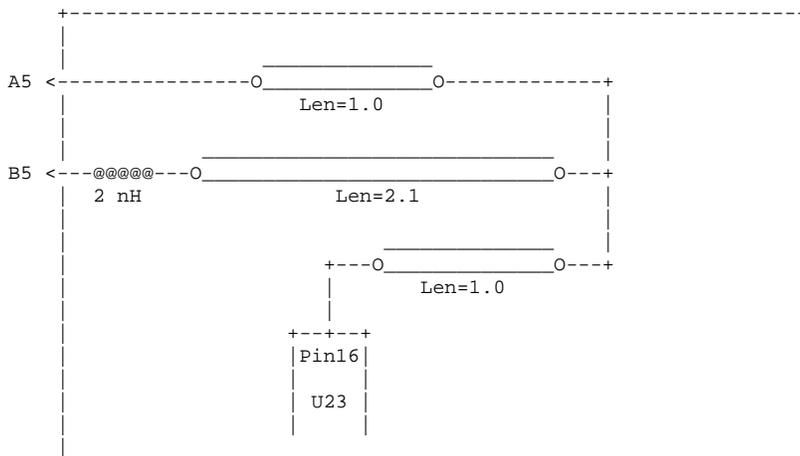
An Example Path For a SIMM Module:

```
[Path Description] CAS_2
Pin J25
Len = 0.5 L=8.35n C=3.34p R=0.01 /
Node u21.15
Len = 0.5 L=8.35n C=3.34p R=0.01 /
Node u22.15
Len = 0.5 L=8.35n C=3.34p R=0.01 /
Node u23.15
```



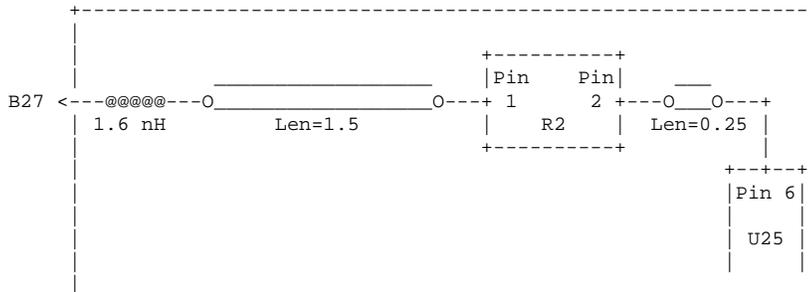
A Description Using The Fork and Endfork Subparameters:

```
[Path Description] PassThru1
Pin B5
Len = 0 L=2.0n /
Len = 2.1 L=6.0n C=2.0p /
Fork
Len = 1.0 L = 1.0n C= 2.0p /
Node u23.16
Endfork
Len = 1.0 L = 6.0n C=2.0p /
Pin A5
```



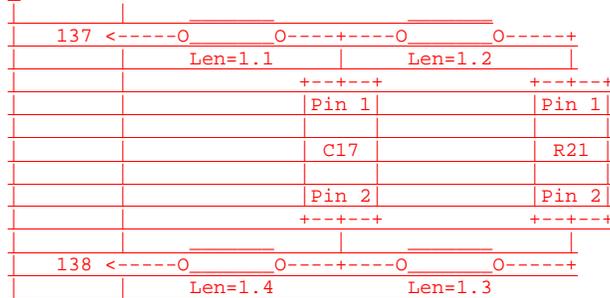
A Description Including a Discrete Series Element:

[Path Description] sig1
Pin B27
Len = 0 L=1.6n /
Len = 1.5 L=6.0n C=2.0p /
Node R2.1
Node R2.2
Len = 0.25 L=6.0n C=2.0p /
Node U25.6



A path including series passive components (C17, R21) between branches forming a differential termination

[Path Description] CLK
Pin 137
Len=1.1 L=1n C=0.4p /
Node C17.1 | Pin 1 of Series C17
Len=1.2 L=1n C=0.4p /
Node R21.1 | Series R21 Pin 1 and 2 connections
Node R21.2
Len=1.3 L=1n C=0.4p /
Node C17.2 | Pin 2 of Series C17
Len=1.4 L=1n C=0.4p
Pin 138



Two paths connected by series resistors (R8, R9) used as differential termination between components

[Path Description] DP+
Pin 20

```

Len=1 L=1n C=0.4p /
Fork
  Len=1.1 L=1n C=0.4p /
  Fork
    Node P8.D7
  Endfork
  Len=1.2 L=1n C=0.4p /
  Node R8.1 | Pin 1 of Series R8
Endfork
Len=1.3 L=1n C=0.4p /
Fork
  Len=1.4 L=1n C=0.4p /
  Node P8.D5
Endfork
Len=1.5 L=1n C=0.4p /
Node R9.1 | Pin 1 of Series R9

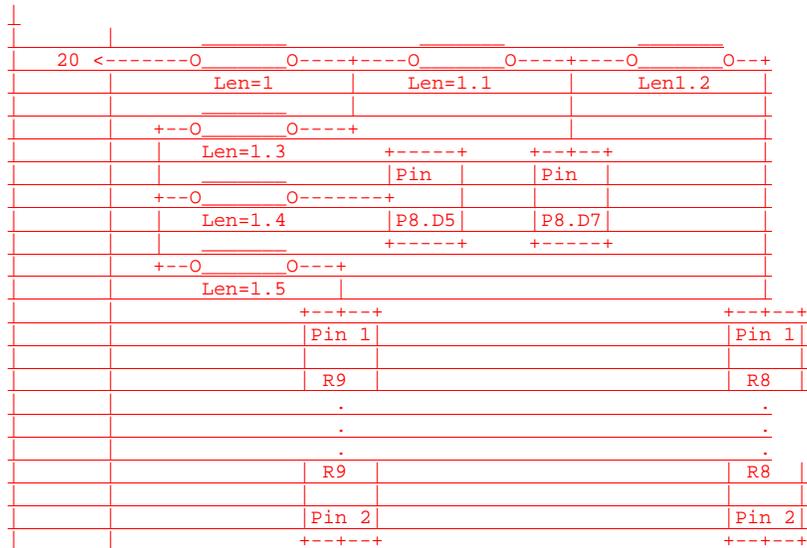
```

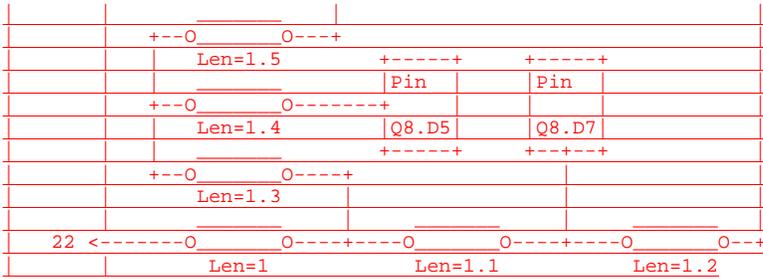
| ... Other Path(s)

```

[Path Description] DP-
Pin 22
Len=1 L=1n C=0.4p /
Fork
  Len=1.1 L=1n C=0.4p /
  Fork
    Node Q8.D7
  Endfork
  Len=1.2 L=1n C=0.4p /
  Node R8.2 | Pin 2 of Series R8
Endfork
Len=1.3 L=1n C=0.4p /
Fork
  Len=1.4 L=1n C=0.4p /
  Node Q8.D5
Endfork
Len=1.5 L=1n C=0.4p /
Node R9.2 | Pin 2 of Series R9

```





=====
Keyword: [Reference Designator Map]

Required: Yes, if any of the path descriptions use the Node subparameter
Description: Maps a reference designator to a component or electrical board description contained in an .ibs or .ebd file.
Usage Rules: The [Reference Designator Map] keyword must be followed by a list of all of the reference designators called out by the Node subparameters used in the various path descriptions. Each reference designator is followed by the name of the .ibs or .ebd file containing the electrical description of the component or board, then the name of the component itself as given by the .ibs or .ebd file's [Component] or [Begin Board Description] keyword respectively. The reference designator, file name and component name terms are separated by white space. By default the .ibs or .ebd files are assumed to exist in the same directory as the calling .ebd file. It is legal for a reference designator to point to a component that is contained in the calling .ebd file.

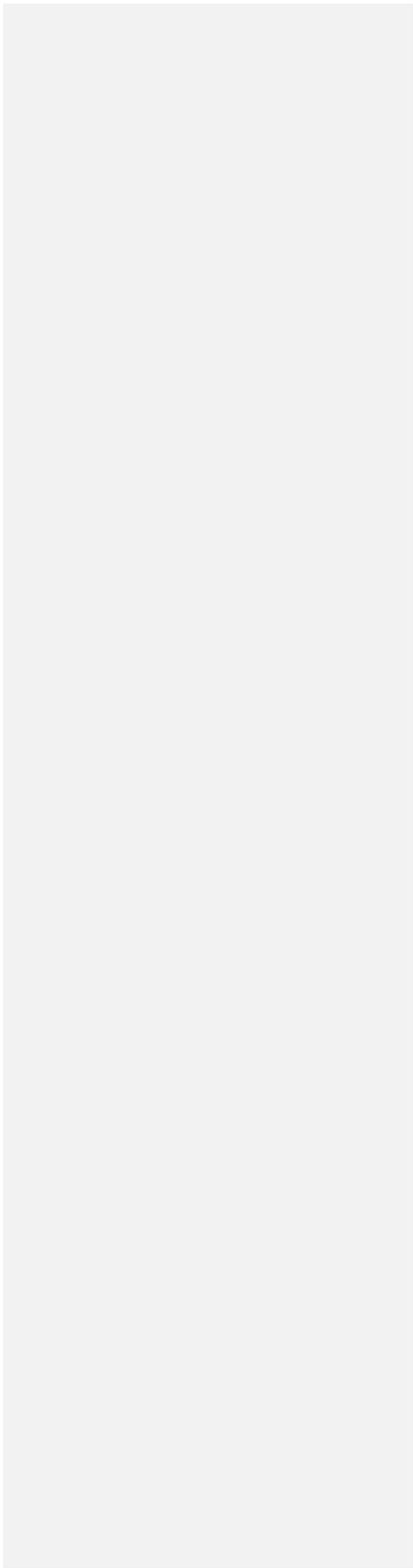
The reference designator is limited to ten characters.

[Reference Designator Map]

External Part References:

Ref Des	File name	Component name
u23	pp100.ibs	Pentium(R)___Pro_Processor
u24	simm.ebd	16Meg X 36 SIMM Module
u25	ls244.ibs	National 74LS244a
u26	rl0K.ibs	My_10K_Pullup

```
=====  
Keyword: [End Board Description]  
Required: Yes  
Description: Marks the end of an Electrical Interconnect Description.  
Usage Rules: This keyword must come at the end of each complete electrical  
interconnect model description.  
  
Optionally, a comment may be added after the [End Electrical  
Description] keyword to clarify which board model has  
ended.  
-----  
[End Board Description] | End: 16Meg X 8 SIMM Module  
=====  
Keyword: [End]  
Required: Yes  
Description: Defines the end of the .ibs, .pkg, or .ebd file.  
-----  
[End]  
=====  
=====
```



=====
=====
Section 9
=====

NOTES ON DATA DERIVATION METHOD
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This section explains how data values are derived. It describes certain assumed parameter and table extraction conditions if they are not explicitly specified. It also describes the allocation of data into the "typ", "min", and "max" columns under variations of voltage, temperature, and process.

The required "typ" column for all data represents typical operating conditions. For most [Model] keyword data, the "min" column describes slow, weak performance, and the "max" column describes the fast, strong performance. It is permissible to use slow, weak components or models to derive the data for the "min" column, and to use fast, strong components or models to derive the data in the "max" columns under the corresponding voltage and temperature derating conditions for these columns. It is also permissible to use typical components or models derated by voltage and temperature and optionally apply proprietary "X%" and "Y%" factors described later for further derating. This methodology has the nice feature that the data can be derived either from semiconductor vendor proprietary models, or typical component measurement over temperature/voltage.

The voltage and temperature keywords and optionally the process models control the conditions that define the "typ", "min", and "max" column entries for all I-V table keywords [Pulldown], [Pullup], [GND Clamp], and [POWER Clamp]; all [Ramp] subparameters dV/dt_r and dV/dt_f; and all waveform table keywords and subparameters [Rising Waveform], [Falling Waveform], V_fixture, V_fixture_min, and V_fixture_max.

The voltage keywords that control the voltage conditions are [Voltage Range], [Pulldown Reference], [Pullup Reference], [GND Clamp Reference], and [POWER Clamp Reference]. The entries in the "min" columns contain the smallest magnitude voltages, and the entries in the "max" columns contain the largest magnitude voltages.

The optional [Temperature Range] keyword will contain the temperature which causes or amplifies the slow, weak conditions in the "min" column and the temperature which causes or amplifies the fast, strong conditions in the "max" column. Therefore, the "min" column for [Temperature Range] will contain the lowest value for bipolar models (TTL and ECL) and the highest value for CMOS models. Default values described later are assumed if temperature is not specified.

The "min" and "max" columns for all remaining keywords and subparameters will contain the smallest and largest magnitude values. This applies to the [Model] subparameter C_comp as well even if the correlation to the voltage, temperature, and process variations are known because information about such correlation is not available in all cases.

C_comp is considered an independent variable. This is because C_comp includes bonding pad capacitance, which does not necessarily track fabrication process variations. The conservative approach to using IBIS data will associate large C_comp values with slow, weak models, and the small C_comp values with fast, strong models.

The default temperatures under which all I-V tables are extracted are

provided below. The same defaults also are stated for the [Ramp] subparameters, but they also apply for the waveform keywords.

The stated voltage ranges for I-V tables cover the most common, single supply cases. When multiple supplies are specified, the voltages shall extend similarly to values that handle practical extremes in reflected wave simulations.

For the [Ramp] subparameters, the default test load and voltages are provided. However, the test load can be entered directly by the R_load subparameter. The allowable test loads and voltages for the waveform keywords are stated by required and optional subparameters; no defaults are needed. Even with waveform keywords, the [Ramp] keyword continues to be required so that the IBIS model remains functional in situations which do not support waveform processing.

The following discussion lists test details and default conditions.

1) I-V Tables:

I-V tables for CMOS models:

typ = typical voltage, typical temp deg C, typical process
min = minimum voltage, max temp deg C, typical process, minus "X%"
max = maximum voltage, min temp deg C, typical process, plus "X%"

I-V tables for bipolar models:

typ = typical voltage, typical temp deg C, typical process
min = minimum voltage, min temp deg C, typical process, minus "X%"
max = maximum voltage, max temp deg C, typical process, plus "X%"

Nominal, min, and max temperature are specified by the semiconductor vendor. The default range is 50 deg C nom, 0 deg C min, and 100 deg C max temperatures.

X% should be statistically determined by the semiconductor vendor based on numerous fab lots, test chips, process controls, etc.. The value of X need not be published in the IBIS file, and may decrease over time as data on the I/O buffers and silicon process increases.

Temperatures are junction temperatures.

2) Voltage Ranges:

Points for each table must span the voltages listed below:

Table	Low Voltage	High Voltage
[Pulldown]	GND - POWER	POWER + POWER
[Pullup]	GND - POWER	POWER + POWER
[GND Clamp]	GND - POWER	GND + POWER
[POWER Clamp]	POWER	POWER + POWER
[Series Current]	GND - POWER	GND + POWER
[Series MOSFET]	GND	GND + POWER

As described in the [Pulldown Reference] keyword section, the I-V tables of the [Pullup] and the [POWER Clamp] structures are 'Vcc relative', using the equation: $V_{table} = V_{cc} - V_{output}$.

For example, a model with a 5 V power supply voltage should be characterized between $(0 - 5) = -5$ V and $(5 + 5) = 10$ V; and a model with a 3.3 V power supply should be characterized between $(0 - 3.3) = -3.3$ V and $(3.3 + 3.3) = 6.6$ V for the [Pulldown] table.

When tabulating output data for ECL type models, the voltage points must span the range of Vcc to Vcc - 2.2 V. This range applies to both the [Pullup] and [Pulldown] tables. Note that this range applies ONLY when characterizing an ECL output.

These voltage ranges must be spanned by the IBIS data. Data derived from lab measurements may not be able to span these ranges as such and so may need to be extrapolated to cover the full range. This data must not be left for the simulator to provide.

3) Ramp Rates:

The following steps assume that the default load resistance of 50 ohms is used. There may be models that will not drive a load of only 50 ohms into any useful level of dynamics. In these cases, use the semiconductor vendor's suggested (nonreactive) load and add the load subparameter to the [Ramp] specification.

The ramp rate does not include packaging but does include the effects of the C_comp parameter; it is the intrinsic output stage rise and fall time only.

The ramp rates (listed in AC characteristics below) should be derived as follows:

- a. If starting with the silicon model, remove all packaging. If starting with a packaged model, perform the measurements as outlined below. Then use whatever techniques are appropriate to derive the actual, unloaded rise and fall times.
- b. If: The Model_type is one of the following: Output, I/O, or 3-state (not open or ECL types);
Then: Attach a 50 ohm resistor to GND to derive the rising edge ramp. Attach a 50 ohm resistor to POWER to derive the falling edge ramp.

If: The Model_type is Output_ECL, I/O_ECL, 3-state_ECL;
Then: Attach a 50 ohm resistor to the termination voltage ($V_{term} = V_{CC} - 2$ V). Use this load to derive both the rising and falling edges.

If: The Model_type is either an Open_sink type or Open_drain type;
Then: Attach either a 50 ohm resistor or the semiconductor vendor suggested termination resistance to either POWER or the suggested termination voltage. Use this load to derive both the rising and falling edges.

If: The Model_type is an Open_source type;
Then: Attach either a 50 ohm resistor or the semiconductor vendor suggested termination resistance to either GND or the suggested termination voltage. Use this load to derive both the rising and falling edges.

- c. Due to the resistor, output swings will not make a full transition as expected. However the pertinent data can still be collected as follows:
 - 1) Determine the 20% to 80% voltages of the 50 ohm swing.
 - 2) Measure this voltage change as "dV".
 - 3) Measure the amount of time required to make this swing "dt".
- d. Post the value as a ratio "dV/dt". The simulator extrapolates this value to span the required voltage swing range in the final model.
- e. Typ, Min, and Max must all be posted, and are derived at the same extremes as the I-V tables, which are:

Ramp rates for CMOS models:

typ = typical voltage, typical temp deg C, typical process
min = minimum voltage, max temp deg C, typical process, minus "Y%"
max = maximum voltage, min temp deg C, typical process, plus "Y%"

Ramp rates for bipolar models:

typ = typical voltage, typical temp deg C, typical process
min = minimum voltage, min temp deg C, typical process, minus "Y%"
max = maximum voltage, max temp deg C, typical process, plus "Y%"

where nominal, min, and max temp are specified by the semiconductor vendor. The preferred range is 50 deg C nom, 0 deg C min, and 100 deg C max temperatures.

Note that the derate factor, "Y%", may be different than that used for the I-V table data. This factor is similar to the X% factor described above. As in the case of I-V tables, temperatures are junction temperatures.

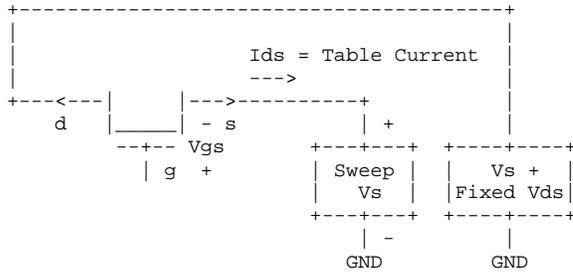
- f. During the I-V measurements, the driving waveform should have a rise/fall time fast enough to avoid thermal feedback. The specific choice of sweep time is left to the modeling engineer.

4) Transit Time Extractions:

The transit time parameter is indirectly derived to be the value that produces the same effect as that extracted by the reference measurement or reference simulation.

The test circuit consists of the following:

- a) A pulse source (10 ohms, 1 ns at full duration ramp) or equivalent and transitioning between Vcc and 0 V,
- b) A 50 ohm, 1 ns long trace or transmission line,
- c) A 500 ohm termination to the ground clamp reference voltage for TTgnd extraction and to the power clamp reference voltage for TTPower extraction (to provide a convenient, minimum loading 450 ohm - 50 ohm divider for high-speed sampling equipment observation of the component denoted as the device under test), and
- d) The device under test (DUT).



Example of Series MOSFET Table Extraction

It is expected that this data will be created from semiconductor vendor proprietary silicon models, and later correlated with actual component measurement.

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Section 10

NOTES ON
ALGORITHMIC MODELING INTERFACE
AND PROGRAMMING GUIDE

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INTRODUCTION:

This section is organized as an interface and programming guide for writing the executable code to be interfaced by the [Algorithmic Model] keyword described in Section 6c. Section 10 is structured as a reference document for the software engineer.

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- 1 OVERVIEW
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 - 2.3 Reference system analysis flow
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1 OVERVIEW

The algorithmic model of a Serializer-Deserializer (SERDES) transmitter or receiver consists of three functions: 'AMI_Init', 'AMI_GetWave' and 'AMI_Close'. The interfaces to these functions are designed to support three different phases of the simulation process: initialization, simulation of a segment of time, and termination of the simulation.

These functions ('AMI_Init', 'AMI_GetWave' and 'AMI_Close') should all be supplied in a single shared library, and their names and signatures must be as described in this section. If they are not supplied in the shared library named by the Executable sub-parameter, then they shall be ignored. This is acceptable so long as

1. The entire functionality of the model is supplied in the shared library.
2. All termination actions required by the model are included in the shared library.

The three functions can be included in the shared object library in one of the ~~three~~ following two combinations:

- Case 1: Shared library has AMI_Init, ~~AMI_Getwave-GetWave~~ and AMI_Close.
- Case 2: shared library has AMI_Init and AMI_Close.

~~Case 3: Shared library has only AMI_Init.~~

Please note that the functions 'AMI_Init' and 'AMI_Close' ~~is-are~~ always required.

The interfaces to these functions are defined from three different perspectives. In addition to specifying the signature of the functions to provide a software coding perspective, anticipated application scenarios provide a functional and dynamic execution perspective, and a specification of the software infrastructure provides a software architecture perspective. Each of these perspectives is required to obtain interoperable software models.

2 APPLICATION SCENARIOS

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The next two sections provide an overview of the two simulation types supported by the IBIS-AMI specification. Statistical simulations require that the algorithm in the [Algorithmic Model] is linear and time-invariant (LTI). Time domain simulations do not have this requirement, therefore [Algorithmic Model]s used in time domain simulations may also contain non-linear and/or time-variant (non-LTI) algorithms.

System simulations will commonly involve a transmitter (Tx) and a receiver (Rx) [Algorithmic Model], each of which may perform filtering in the AMI_Init function, the AMI_GetWave function, or both (i.e., a "dual" algorithmic model). In the case of a "dual" algorithmic model, the filtering functionality in the AMI_Init and AMI_GetWave functions are each intended to be independent representations of the device's equalization. Users of a dual model can elect to use either the AMI_Init or AMI_GetWave filtering functionality, but not combine both simultaneously.

While the primary purpose of the AMI_Init function is to perform the required initialization steps, it may also include LTI signal

| processing algorithms. Therefore, statistical simulations may be
| performed using the AMI_Init function alone.

| Even though time domain simulations may also be performed with the LTI
| AMI_Init and/or LTI AMI_GetWave functions, AMI_GetWave functions containing
| non-LTI algorithms may only be simulated in the time domain.

| 2.1 Statistical simulations
| =====

| 1. From the system netlist, the EDA platform determines that a given buffer
| is described by an IBIS [Model].

| 2. From the IBIS [Model], the EDA platform determines that the buffer
| is described in part by an [Algorithmic Model].

| 3. The EDA platform loads the shared library or shared object file
| containing the [Algorithmic Model], and obtains the addresses of the
| AMI_Init, AMI_GetWave, and AMI_Close functions.

| 4. The EDA platform loads the corresponding parameter file (.ami file)
| and assembles the arguments for the AMI_Init function. These arguments
| include an impulse response matrix, a memory handle for the dynamic
| memory used by the [Algorithmic Model], the parameters for configuring
| the [Algorithmic Model], and optionally the impulse response(s) of any
| crosstalk interferers.

| 5. The EDA platform calls the AMI_Init function with the arguments
| previously prepared. The AMI_Init function of the transmitter and
| receiver [Algorithmic Model]s are called separately as described in
| the reference flow below.

| 6. The AMI_Init function parses the configuration parameters, allocates
| dynamic memory, places the address of the start of the dynamic memory
| into the memory handle and modifies the impulse response by the filter
| response of the [Algorithmic Model].

| 7. The EDA platform completes the rest of the simulation/analysis using
| the impulse response calculated by the AMI_Init function which is a
| complete representation of the behavior of a given [Algorithmic Model]
| combined with the channel.

| 8. Before exiting, the EDA platform calls the AMI_Close function, giving
| it the address in the memory handle for the [Algorithmic Model].

| 9. The AMI_Close function de-allocates the dynamic memory used by the
| [Algorithmic Model] and performs whatever other clean-up actions are
| required.

| 10. The EDA platform terminates execution.

| 2.2 Time domain simulations
| =====

1. From the system netlist, the EDA platform determines that a given buffer is described by an IBIS [Model].
2. From the IBIS [Model], the EDA platform determines that the buffer is described in part by an [Algorithmic Model].
3. The EDA platform loads the shared library or shared object file containing the [Algorithmic Model], and obtains the addresses of the AMI_Init, AMI_GetWave, and AMI_Close functions.
4. The EDA platform loads the corresponding parameter file (.ami file) and assembles the arguments for the AMI_Init function. These arguments include an impulse response matrix, a memory handle for the dynamic memory used by the [Algorithmic Model], the parameters for configuring the [Algorithmic Model], and optionally the impulse response(s) of any crosstalk interferers.
5. The EDA platform calls the AMI_Init function with the arguments previously prepared. The AMI_Init function of the transmitter and receiver [Algorithmic Models] are called separately as described in the reference flow below.
6. The AMI_Init function parses the configuration parameters, allocates dynamic memory, places the address of the start of the dynamic memory into the memory handle and (optionally) modifies the impulse response by the filter response of the [Algorithmic Model]. The EDA platform may make use of the impulse response returned by the AMI_Init function in its further analysis if needed.
7. The EDA platform generates a time domain digital input waveform bit pattern (stimulus). A long bit pattern (and simulation) may be broken up into multiple time segments by the EDA platform. For example, if one million bits are to be simulated, there can be 1000 segments of 1000 bits each, i.e., one time segment comprises 1000 bits. The segments are not required to be equally sized and are not required to contain an integer number of bits.
8. For each time segment, the EDA platform calls the AMI_GetWave function of the transmitter (if it exists), giving it the digital input waveform and the address in the memory handle for the [Algorithmic Model].
9. For the AMI_GetWave function of the receiver, the EDA platform takes the output from the transmitter AMI_GetWave function (if it exists) and combines it (for example by convolution) with the channel impulse response to produce an analog waveform and passes this result to the receiver AMI_GetWave function for each time segment of the simulation. If the transmitter AMI_GetWave function doesn't exist, the EDA platform takes the output of the transmitter AMI_Init function and combines that (for example by convolution) with the digital stimulus bit pattern to produce the analog waveform for the receiver AMI_GetWave function.
10. The output waveform of the receiver AMI_GetWave function represents the voltage waveform at the decision point of the receiver. The EDA platform completes the simulation/analysis with this waveform.
11. Before exiting, the EDA platform calls the AMI_Close function, giving

it the address in the memory handle for the [Algorithmic Model].

12. The AMI_Close function de-allocates the dynamic memory used by the [Algorithmic Model] and performs whatever other clean-up actions are required.

13. The EDA platform terminates execution.

3 Reference Flows

=====

The next two sections define a reference simulation flow for statistical and time domain system analysis simulations. Other methods of calling models and processing results may be employed, but the final simulation waveforms are expected to match the waveforms produced by this reference simulation flow.

A system simulation usually involves a transmitter (Tx) and a receiver (Rx) model with a passive channel placed between them.

3.1 Statistical simulation reference flow

=====

Step 1. The simulation platform obtains the impulse response for the analog channel. This represents the combined impulse response of the transmitter's analog output, the channel and the receiver's analog front end. The transmitter's output or receiver's input characteristics must not include any filtering effects, for example equalization, in this impulse response, although it may include any parasitics which are included in the Tx or Rx analog model.

Step 2. The output of Step 1 is presented to the Tx model's AMI_Init function and the Tx AMI_Init function is executed. The impulse response returned by the Tx AMI_Init function is passed onto Step 3.

Step 3. The output of Step 2 is presented to the Rx model's AMI_Init function and the Rx AMI_Init function is executed. The impulse response returned by the Rx AMI_Init function is passed onto Step 4.

Step 4. The EDA platform completes the rest of the simulation/analysis using the impulse response calculated in Step 3 by the Rx model's AMI_Init function which is a complete representation of the behavior of a given [Algorithmic Model] combined with the channel.

3.2 Time domain simulation reference flow

=====

Step 1. The simulation platform obtains the impulse response for the analog channel. This represents the combined impulse response of the transmitter's analog output, the channel and the receiver's analog front end. The transmitter's output or receiver's input characteristics must not include any filtering effects, for example equalization, in this impulse response, although it may include any parasitics which are included in the Tx or Rx analog model.

Step 2. The output of Step 1 is presented to the Tx model's AMI_Init function and the Tx AMI_Init function is executed. The Tx AMI_Init function may modify the impulse response or choose to leave it unchanged.

Step 3. The output of Step 2 is presented to the Rx model's AMI_Init function and the Rx AMI_Init function is executed. The Rx AMI_Init function may modify the impulse response or choose to leave it unchanged.

Under certain circumstances, for example when the Rx_AMI_Init function includes an optimization algorithm, the impulse response presented to the Rx_AMI_Init function must include the Tx equalization effects for the optimization to work correctly. However, when the Tx AMI model contains an AMI_GetWave function that performs a similar or better equalization than the Tx AMI_Init function, there is a possibility for 'double-counting' the equalization effects in the Tx model. To allow for such models to work correctly, the EDA tool can operate in one of several ways, two of which are documented here:

- not utilize the Tx AMI_GetWave functionality, by treating the Tx AMI model as if the Tx GetWave_Exists was False.
- use deconvolution to obtain the impulse response of the Rx filter. Since the AMI_Init function contains a linear and time invariant algorithm, the Rx equalization can be represented as an impulse response. Since the output of the Rx AMI_Init function (output of Step 3) is an impulse response modified by the Rx equalization (e.g. by convolving the input of the Rx AMI_Init function with the impulse response of the Rx filter), the impulse response of the Rx filter can be obtained by deconvolving the output of Step 3 with the input presented to Step 3.

Note: The Rx Model writer should keep in mind that it is not guaranteed that the impulse response that is presented to the Rx AMI_init function will always include the effects of the Tx filter. Therefore the Rx AMI_Init function may not be able to perform accurate optimization under all circumstances. For this reason, the parameters of the Rx AMI_Init function should always default to valid values or have a mechanism to accept user defined coefficients and allow the user to turn off any automatic optimization routines to ensure successful simulations.

Step 4. The simulation platform produces a digital stimulus waveform. A digital stimulus waveform is 0.5 when the stimulus is "high", -0.5 when the stimulus is "low", and may have a value between -0.5 and 0.5 such that transitions occur when the stimulus crosses 0.

Step 5. If Tx GetWave_Exists is True the output of Step 4 is presented to the Tx model's AMI_GetWave function and the Tx AMI_GetWave function is executed. The output of the Tx AMI_GetWave function is passed on to Step 6.

Step 6a. If Tx GetWave_Exists is True and Rx GetWave_Exists is True, the output of Step 5 is convolved with the output of Step 1 by the simulation platform and the result is passed on to Step 7.

Step 6b. If Tx GetWave_Exists is False and Rx GetWave_Exists is True, the output of Step 4 is convolved with the output of Step 2 by the simulation platform and the result is passed on to Step 7.

Step 6c. If Tx GetWave_Exists is False and Rx GetWave_Exists is False, the output of Step 4 is convolved with the output of Step 3 by the simulation platform and the result is passed on to Step 8.

Step 6d. If Tx GetWave_Exists is True and Rx GetWave_Exists is False, the output of Step 5 is convolved with the output of Step 1 and the Impulse Response of the Rx filter by the simulation platform and the result is passed on to Step 8. (The Impulse Response of the Rx filter may be obtained by deconvolving the output of Step 3 by the input of Step 3).

Note: For the scenario where the Tx AMI_Init function does NOT include equalization effects (i.e. does not modify the impulse response of the channel), Step 6d is functionally equivalent to simply convolving the output of Step 5 with the output of Step 3.

Step 7. If Rx GetWave_Exists is True the output of Step 6 is presented to the Rx model's AMI_GetWave function and the Rx AMI_GetWave function is executed. The output of the Rx AMI_GetWave function is passed on to Step 8.

Step 8. The output of Step 6c, 6d or 7 becomes the simulation waveform output at the Rx decision point. Step 7 optionally may also return clock ticks, which may be post-processed by the simulation tool or presented to the user as is.

Steps 4 through 8 can be called once or can be called multiple times to process the full analog waveform. Splitting up the full analog waveform into multiple calls reduces the memory requirements when doing long simulations, and allows AMI_GetWave to return model status every so many bits. Once all blocks of the input waveform have been processed, Tx AMI_Close and Rx AMI_Close are called to perform any final processing and release allocated memory.

~~2 APPLICATION SCENARIOS~~

~~2.1 Linear, Time-invariant Equalization Model~~

- ~~1. From the system netlist, the EDA platform determines that a given [Model] is described by an IBIS file.~~
- ~~2. From the IBIS file, the EDA platform determines that the [Model] is described at least in part by an algorithmic model, and that the AMI_Init function of that model returns an impulse response for that [Model].~~
- ~~3. The EDA platform loads the shared library containing the algorithmic model, and obtains the addresses of the AMI_Init, AMI_GetWave, and AMI_Close functions.~~
- ~~4. The EDA platform assembles the arguments for AMI_Init. These arguments include the impulse response of the channel driving the [Model], a handle for the dynamic memory used by the [Model], the parameters for configuring the [Model], and optionally the impulse responses of any crosstalk interferers.~~
- ~~5. The EDA platform calls AMI_Init with the arguments previously prepared.~~

- +
~~6. AMI_Init parses the configuration parameters, allocates dynamic memory, places the address of the start of the dynamic memory in the memory handle, computes the impulse response of the block and passes the modified impulse response to the EDA tool. The new impulse response is expected to represent the filtered response.~~
- +
~~7. The EDA platform completes the rest of the simulation/analysis using the impulse response from AMI_Init as a complete representation of the behavior of the given [Model].~~
- +
~~8. Before exiting, the EDA platform calls AMI_Close, giving it the address in the memory handle for the [Model].~~
- +
~~9. AMI_Close de-allocates the dynamic memory for the block and performs whatever other clean up actions are required.~~
- +
~~10. The EDA platform terminates execution.~~

~~2.2 Nonlinear, and / or Time variant Equalization Model~~

- +
~~1. From the system netlist, the EDA platform determines that a given block is described by an IBIS file.~~
- +
~~2. From the IBIS file, the EDA platform determines that the block is described at least in part by an algorithmic model.~~
- +
~~3. The EDA platform loads the shared library or shared object file containing the algorithmic model, and obtains the addresses of the AMI_Init, AMI_GetWave, and AMI_Close functions.~~
- +
~~4. The EDA platform assembles the arguments for AMI_Init. These arguments include the impulse response of the channel driving the block, a handle for the dynamic memory used by the block, the parameters for configuring the block, and optionally the impulse responses of any crosstalk interferers.~~
- +
~~5. The EDA platform calls AMI_Init with the arguments previously prepared.~~
- +
~~6. AMI_Init parses the configuration parameters, allocates dynamic memory and places the address of the start of the dynamic memory in the memory handle. AMI_Init may also compute the impulse response of the block and pass the modified impulse response to the EDA tool. The new impulse response is expected to represent the filtered response.~~

- ~~7. A long time simulation may be broken up into multiple time segments. For each time segment, the EDA platform computes the input waveform to the [Model] for that time segment. For example, if a million bits are to be run, there can be 1000 segments of 1000 bits each, i.e. one time segment comprises 1000 bits.~~
- ~~8. For each time segment, the EDA platform calls the AMI_GetWave function, giving it the input waveform and the address in the dynamic memory handle for the block.~~
- ~~9. The AMI_GetWave function computes the output waveform for the block. In the case of a transmitter, this is the Input voltage to the receiver. In the case of the receiver, this is the voltage waveform at the decision point of the receiver.~~
- ~~10. The EDA platform uses the output of the receiver AMI_GetWave function to complete the simulation/analysis.~~
- ~~11. Before exiting, the EDA platform calls AMI_Close, giving it the address in the memory handle for the block.~~
- ~~12. AMI_Close de-allocates the dynamic memory for the block and performs whatever other clean up actions are required.~~
- ~~13. The EDA platform terminates execution.~~

~~2.3 Reference system analysis flow~~

~~System simulations will commonly involve both TX and RX algorithmic models, each of which may perform filtering in the AMI_Init call, the AMI_Getwave call, or both. Since both LTI and non LTI behavior can be modeled with algorithmic models, the manner in which models are evaluated can affect simulation results. The following steps are defined as the reference simulation flow. Other methods of calling models and processing results may be employed, but the final simulation waveforms are expected to match the waveforms produced by the reference simulation flow.~~

~~The steps in this flow are chained, with the input to each step being the output of the step that preceded it.~~

~~Step 1. The simulation platform obtains the impulse response for the analog channel. This represents the combined impulse response of the transmitter's analog output, the channel and the receiver's analog front end. This impulse response represents the transmitter's output characteristics without filtering, for example, equalization.~~

~~Step 2. The output of Step 1 is presented to the TX model's AMI_Init call. If Use_Init_Output for the TX model is set to True, the impulse response returned by the TX AMI_Init call is passed onto Step 3. If Use_Init_Output for the TX model is set to False, the same impulse response passed into Step 2 is passed on to step 3.~~

~~Step 3. The output of Step 2 is presented to the RX model's AMI_Init call. If Use_Init_Output for the RX model is set to True, the impulse response returned by the RX AMI_Init call is passed onto Step 4. If Use_Init_Output for the RX model is set to False, the same impulse response passed into Step 3 is passed on to step 4.~~

~~Step 4. The simulation platform takes the output of step 3 and combines (for example by convolution) the input bitstream and a unit pulse to produce an analog waveform.~~

~~Step 5. The output of step 4 is presented to the TX model's AMI_Getwave call. If the TX model does not include an AMI_Getwave call, this step is a pass-through step, and the input to step 5 is passed directly to step 6.~~

~~Step 6. The output of step 5 is presented to the RX model's AMI_Getwave call. If the RX model does not include an AMI_Getwave call, this step is a pass-through step, and the input to step 6 is passed directly to step 7.~~

~~Step 7. The output of step 6 becomes the simulation waveform output at the RX decision point, which may be post processed by the simulation tool.~~

~~Steps 4 through 7 can be called once or can be called multiple times to process the full analog waveform. Splitting up the full analog waveform into multiple calls minimized the memory requirement when doing long simulations, and allows AMI_Getwave to return model status every so many bits. Once all blocks of the input waveform have been processed, TX AMI_Close and RX AMI_close are called to perform any final processing and release allocated memory.~~

3 FUNCTION SIGNATURES

3.1 AMI_Init

3.1.1 Declaration

```
long AMI_Init (double *impulse_matrix,  
              long number_of_rows  
              long row_size,  
              long aggressors,  
              double sample_interval,  
              double bit_time,  
              char *AMI_parameters_in,  
              char **AMI_parameters_out,  
              void **AMI_memory_handle,  
              char **msg)
```

3.1.2 Arguments

3.1.2.1 impulse_matrix

'impulse_matrix' points to a memory location where the collection of channel voltage impulse responses, called the "impulse response matrix", is stored in the form of a single dimensional array of floating point numbers. The impulse responses pointed to by the 'impulse_matrix' argument are both input and output. The EDA platform provides the impulse responses. The algorithmic model is expected to modify the impulse responses in place by applying a filtering behavior, for example, an equalization function, if modeled in the AMI_Init function. The impulse response values are uniformly spaced in time. The sample spacing is determined by the EDA tool and passed to the algorithmic model through the AMI_Init function's 'sample_interval' argument.

The first column of the impulse response matrix is the impulse response for a through channel, a channel that serves as a communication path between a transmitter/receiver pair. The rest of the columns contain the impulse responses of crosstalk channels. Crosstalk channels describe the paths between aggressor transmitters and victim receiver(s). Transmitters which are not part of a through channel between a certain transmitter/receiver pair are all considered aggressor transmitters with respect to that through channel. The receiver of the through channel in consideration is referred to as the victim receiver. The crosstalk impulse responses may be placed into the impulse response matrix in any order.

The single dimensional array of 'impulse_matrix' is formed by concatenating the columns of an impulse response matrix, starting with the first column and ending with the last column. The matrix elements can be retrieved or identified using the following relationships:

```
impulse_matrix[idx] = impulse response matrix element (row, col)  
idx = col * number_of_rows + row  
row: row index          ranges from 0 to number_of_rows-1  
col: column index       ranges from 0 to aggressors
```

Each impulse response in the impulse response matrix must have the same sample spacing and the same length.

To include any crosstalk effects in the Reference Flows described in

| this section of this specification, the crosstalk impulse responses
| must be included in the 'impulse_matrix' and passed to the transmitter and
| receiver AMI_Init functions. If present, any filtering in the transmitter
| and/or receiver AMI_Init function(s) must also be applied to the crosstalk
| impulse responses to properly account for the crosstalk effects.

| Note that the 'impulse_matrix' will contain a different set of crosstalk
| impulse responses for the transmitter and receiver AMI_Init calls, even for
| a transmitter/receiver pair of the same through channel. A transmitter's
| AMI_Init function operates on those impulse responses which originate from
| that transmitter, including the through channel and crosstalk channel
| impulse responses. A victim receiver's AMI_Init function, on the other
| hand, operates on all of those impulse responses which are received by
| that victim receiver, including the through channel and crosstalk channel
| impulse responses.

| As an illustration, consider a crosstalk analysis with five channels
| numbered 1 through 5, where channel 3 in the center is the through
| channel of the transmitter/receiver pair Tx3/Rx3, and Rx3 is the
| victim receiver. In this case channels 1, 2 and 4, 5 are the aggressor
| channels with the aggressor transmitters Tx1, Tx2, Tx4 and Tx5. If the
| five 'impulse_matrix'-es of the five transmitters' AMI_Init functions
| contain the following data:

```
| *****  
|           impulse_matrix impulse_matrix  
|           column 1      column 2  
|-----  
| Tx1      IR1_1          IR1_3  
| Tx2      IR2_2          IR2_3  
| Tx3      IR3_3  
| Tx4      IR4_4          IR4_3  
| Tx5      IR5_5          IR5_3  
| *****
```

| then the 'impulse_matrix' passed into the victim receiver's (Rx3) AMI_Init
| function will contain the following data:

```
| *****  
|           impulse_matrix impulse_matrix impulse_matrix impulse_matrix impulse_matrix  
|           column 1      column 2      column 3      column 4      column 5  
|-----  
| Rx3 Tx3Init(IR3_3) Tx1Init(IR1_3) Tx2Init(IR2_3) Tx4Init(IR4_3) Tx5Init(IR5_3)  
| *****
```

| where "IRi_j" represents the impulse response from the transmitter on
| channel i to the receiver on channel j, Tx1Init() .. Tx5Init() represents
| the output of a transmitter's AMI_Init function which modified the impulse
| response denoted inside the parentheses. Note that while in this example
| the 'impulse_matrix' of each transmitter's AMI_Init function contains at
| most one crosstalk impulse response, the victim receiver's 'impulse_matrix'
| contains four crosstalk impulse responses. Also, using the above notation
| note that the first index number of each impulse response passed to the
| transmitter's AMI_Init function matches the transmitter's channel number,
| and the second index number of each impulse response passed to the
| receiver's AMI_Init function matches the receiver's channel number.

| It is the EDA tool's responsibility to rearrange the content of the
| 'impulse_matrix' between the transmitter and receiver AMI_Init calls.

| The EDA tool is also responsible to limit the number of crosstalk channel
| impulse responses in 'impulse_matrix' so that they shall not exceed

~~'Max_Init_Aggressors' as specified in the corresponding .ami parameter file of the algorithmic model. Consequently, the 'aggressors' parameter of the AMI_Init function shall never contain a greater value than the value provided in 'Max_Init_Aggressors' of the corresponding .ami parameter file. While the allocated memory space for 'impulse_matrix' may be larger, it is assumed that there is no meaningful data in that space beyond the last column of the impulse response matrix that is stored in it.~~

~~The AMI_Init function must not change the size or organization of 'impulse_matrix' that it was given in any way.~~

~~'impulse_matrix' is the channel impulse response matrix. The impulse values are in volts and are uniformly spaced in time. The sample spacing is given by the parameter 'sample_interval'.~~

~~The impulse_matrix is stored in a single dimensional array of floating point numbers which is formed by concatenating the columns of the impulse response matrix, starting with the first column and ending with the last column. The matrix elements can be retrieved/identified using~~

~~impulse_matrix[idx] = element (row, col)
idx = col * number_of_rows + row
row row index, ranges from 0 to row_size - 1
col column index, ranges from 0 to aggressors~~

~~The first column of the impulse_matrix is the impulse response for the primary channel. The rest are the impulse responses from aggressor drivers to the victim receiver.~~

~~The AMI_Init function may return a modified impulse response by modifying the first column of impulse_matrix. If the impulse response is modified, the new impulse response is expected to represent the filtered response. The number of items in the matrix should remain unchanged.~~

~~The aggressor columns of the matrix should not be modified.~~

3.1.2.2 number of rows_size

The number of rows in the impulse_matrix.

3.1.2.3 aggressors

The number of aggressors in the impulse_matrix.

3.1.2.4 sample_interval

This is the sampling interval of the 'impulse_matrix' passed into the AMI_Init function and the 'wave' passed into the AMI_GetWave function. The sample_interval is determined by the EDA tool and it is usually a fraction of the bit_time. The 'impulse_matrix' and 'wave' returned by the algorithmic model must have the same 'sample_interval' as the original 'impulse_matrix' and 'wave' that was passed into the algorithmic model.

Impulse responses in 'impuse_matrix' and waveforms in 'wave' should be treated as continuous analog waveforms by the algorithmic models. For this reason, algorithmic models must be able to produce valid results at any sample_interval. Any internal analog to digital conversion or resampling is the responsibility of the algorithmic model. In case the algorithmic model is unable to operate at a given sample_interval, it should abort gracefully with an exit code 0 (failure) and appropriate messaging.

Example:

~~This is the sampling interval of the impulse_matrix. Sample_interval is usually a fraction of the highest data rate (lowest bit_time) of the device. Example:~~

```
Sample_interval = (lowest_bit_time/64)
```

3.1.2.5 bit_time

The bit time or unit interval (UI) of the current data, e.g., 100 ps, 200 ps etc. The shared library may use this information along with the impulse_matrix to initialize the filter coefficients.

3.1.2.6 AMI_parameters_in

=====

The AMI_parameters_in argument is a pointer to a string. Memory for the string is allocated and de-allocated by the EDA platform. All the input from the IBIS AMI parameter file are passed to the algorithmic model using a string that has been formatted as a parameter tree.

The AMI_parameters_in argument must always be present in the AMI_Init function call and it must always contain the address of a valid string. The string must always contain at least the root name of the parameter tree, even if there are no parameters to pass to the algorithmic model.

Examples of the tree parameter passing:

```
(mySampleAMI_1)
```

```
(mySampleAMI_2
  (tx
    (taps 4)
    (spacing sync)
  )
)
```

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```

| (mySampleAMI_3
|   (branch1
|     (leaf1 value1)
|     (leaf2 value2)
|   (branch2
|     (leaf3 value3)
|     (leaf4 value4)
|   )
|   (leaf5 value5 value6 value7)
| )
| )
| )

```

The syntax for the parameter string is:

1. The parameter and message strings passed through the `AMI_parameters_in`, `AMI_parameters_out` and `msg` arguments must not be enclosed in double quotes.
2. Neither names nor individual values except for string literals may contain white space characters.

~~3.1.2.6 AMI parameters (`_in` and `_out`)~~

~~Memory for `AMI_parameters_in` is allocated and de-allocated by the EDA platform. The memory pointed to by `AMI_parameters_out` is allocated and de-allocated by the model. This is a pointer to a string. All the input from the IBIS AMI parameter file are passed using a string that been formatted as a parameter tree.~~

~~Examples of the tree parameter passing is:~~

```

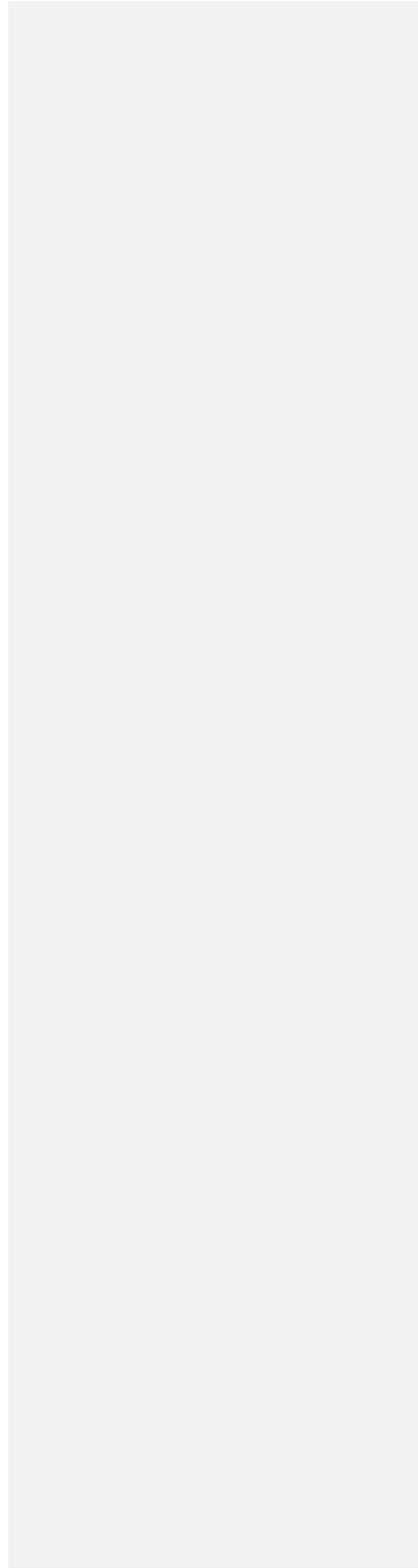
+
+ (dll
+   (tx
+     (taps 4)
+     (spacing sync)
+   )
+ )
+
+ and
+
+ (root
+   (branch1
+     (leaf1 value1)
+     (leaf2 value2)
+   (branch2
+     (leaf3 value3)
+     (leaf4 value4)
+   )
+   (leaf5 value5 value6 value7)
+ )
+ )
+

```

~~The syntax for this string is:~~

- ~~1. Neither names nor individual values can contain white space characters.~~
23. Parameter name/value pairs are always enclosed in parentheses, with the value separated from the name by white space.
34. A parameter value in a name/value pair can be either a single value or a list of values separated by whitespace.
45. Parameter name/value pairs can be grouped together into parameter groups by starting with an open parenthesis followed by the group name followed by the concatenation of one or more name/value pairs followed by a close

| parenthesis.



- 56. Parameter name/values pairs and parameter groups can be freely intermixed inside a parameter group.
- 67. The top level parameter string must be a parameter group.
- 78. White space is ignored, except as a delimiter between the parameter name and value.
- 9. ~~Parameter values can be expressed either as a string literal, Boolean literal (True or False), decimal number, or a floating point number in the standard ANSI 'C' notation (e.g., 2.0e-9). String literal values are delimited using a double quote (") and no double quotes are allowed inside the string literals. Empty string literals are denoted by two successive double quote characters.~~
- 8. ~~Parameter values can be expressed either as a string literal, decimal number or in the standard ANSI 'C' notation for floating point numbers (e.g., 2.0e-9). String literal values are delimited using a double quote (") and no double quotes are allowed inside the string literals.~~
- 910. A parameter can be assigned an array of values by enclosing the parameter name and the array of values inside a single set of parentheses, with the parameter name and the individual values all separated by white space.

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The modified BNF specification for the syntax is:

```

<tree>:
  <branch>

<branch>:
  ( <branch name> <leaf list> )

<leaf list>:
  <branch>
  <leaf>
  <leaf list> <branch>
  <leaf list> <leaf>

<leaf>:
  ( <parameter name> whitespace <value list> )

<value list>:
  <value>
  <value list> whitespace <value>
<value>:
  <string literal>
  <Boolean literal>
  <string literals>
  <decimal number>
  <decimal number>e<exponent>
  <decimal number>E<exponent>

```

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3.1.2.7 AMI_parameters_out

=====

The AMI_parameters_out argument is a pointer to a string pointer. Memory for the string is allocated and de-allocated by the algorithmic model. The model returns a pointer to the string as the contents of this argument. The string must be formatted as a parameter tree, as described in 3.1.2.6. The AMI_Init function may use this string to return parameters to the EDA platform.

While the AMI_parameters_out argument must always be present in the AMI_Init function call and the EDA platform must always provide a valid (non-zero) address value in it, algorithmic models are not required to

return anything at that address to the EDA platform. For this reason, the EDA platform must also initialize the memory content at that address to zero (null pointer) prior to calling the AMI_Init function, so that after the execution of the function it can determine whether or not the function returned a valid string pointer at that address. If the AMI_Init function does not have any parameters to return to the EDA platform, it must return a pointer at the address provided in this argument to a string which contains nothing but the root name. Note that the root name must always be included in the string.

3.1.2.7-8 AMI_memory_handle

Used to point to local storage for the algorithmic block being modeled and shall be passed back during the AMI_GetWave calls. e.g. a code snippet may look like the following:

```
my_space = allocate_space( sizeof_space );
status = store_all_kinds_of_things( my_space );
*serdes_memory_handle = my_space;
```

The memory pointed to by AMI_handle is allocated and de-allocated by the model.

3.1.2.9 msg

=====

The msg argument is a pointer to a string pointer. Memory for the string is allocated and de-allocated by the algorithmic model. The model returns a pointer to the string as the contents of this argument. The AMI_Init function may use this string to send a descriptive, textual message to the EDA platform to be displayed in the user interface and/or to be saved in a log file.

While the msg argument must always be present in the AMI_Init function call and the EDA platform must always provide a valid (non-zero) address value in it, algorithmic models are not required to return anything at that address to the EDA platform. For this reason, the EDA platform must also initialize the memory content at that address to zero (null pointer) prior to calling the AMI_Init function, so that after the execution of the function it can determine whether or not the function returned a valid string pointer at that address. If the AMI_Init function does not have a message string to return to the EDA platform, it may take the following actions:

- ignore the address provided in this argument (leaving the EDA tool provided null pointer at that address)
- return a null pointer at the address provided in this argument (redundantly rewriting the EDA tool provided null pointer at that address)

3.1.2.8 msg (optional)

~~Provides descriptive, textual message from the algorithmic model to the EDA platform. It must provide a character string message that can be used by EDA platform to update log file or display in user interface.~~

3.1.3 Return Value

1 for success
0 for failure

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Algorithmic models shall return a failure code (0) if and only if the function call fails due to a program execution error. In all other cases the return code shall be "success" (1), even if the function cannot operate properly due to some functional problems. For example, if a function includes a CDR which is unable to get into a stable mode, the function shall still return a success code (1). Examples for returning a failure code (0) may include an invalid data type, a null pointer during run time, or anything that prevents the successful execution of the model's code.

The authors of Algorithmic Models are encouraged to provide feedback to the EDA tool's users through the various available messaging options about any difficulties the model encounters during execution, regardless of what the value of the function's return code is.

3.2 AMI_GetWave

3.2.1 Declaration

```
long AMI_GetWave (double *wave,  
                 long wave_size,  
                 double *clock_times,  
                 char **AMI_parameters_out,  
                 void *AMI_memory);
```

3.2.2 Arguments

3.2.2.1 wave

'wave' points to a memory location where a uniformly sampled vector of a time domain waveform is stored. The waveform pointed to by the 'wave' argument is both input and output. The EDA platform provides the wave. The algorithmic model is expected to modify the waveform in place by applying a filtering behavior, for example, an equalization function, if modeled in the AMI_Getwave function. The sample spacing is determined by the EDA tool and passed to the algorithmic model through the AMI_Init function's 'sample_interval' argument.

~~A vector of a time domain waveform, sampled uniformly at an interval specified by the 'sample_interval' specified during the init call. The wave is both input and output. The EDA platform provides the wave. The algorithmic model is expected to modify the waveform in place by applying a filtering behavior, for example, an equalization function, being modeled in the AMI_Getwave call.~~

Depending on the EDA platform and the analysis/simulation method chosen, the input waveform could include many components. For example, the input waveform could include:

- The waveform for the primary channel only.
- The waveform for the primary channel plus crosstalk and amplitude noise.
- The output of a time domain circuit simulator such as SPICE.

It is assumed that the electrical interface to either the driver or the receiver is differential. Therefore, the sample values are assumed to be differential voltages centered nominally around zero volts. The algorithmic model's logic threshold may be non-zero, for example to model the differential offset of a receiver; however that offset will usually be small compared to the input or output differential voltage.

The output waveform is expected to be the waveform at the decision point of

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the receiver (that is, the point in the receiver where the choice is made as to whether the data bit is a "1" or a "0"). It is understood that for some receiver architectures, there is no one circuit node which is the decision point for the receiver. In such a case, the output waveform is expected to be the equivalent waveform that would exist at such a node were it to exist.

3.2.2.2 wave_size

This is the number of samples in the waveform vector that is in the AMI_GetWave function argument 'wave'. The length of this waveform is determined by the EDA tool. The value of 'wave_size' may be different between GetWave calls within the same simulation. The 'wave' returned by the algorithmic model must have the same number of samples as the original 'wave' that was passed into the algorithmic model. Algorithmic models must be able to produce valid results with any wave_size. In case the algorithmic model is unable to operate with a given wave_size, it should abort gracefully with an exit code 0 (failure) and appropriate messaging.
~~Number of samples in the waveform vector.~~

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3.2.2.3 clock_times

Vector to return clock times. The clock times are referenced to the start of the simulation (the first AMI_GetWave call). The clock_times vector is allocated by the EDA platform and is guaranteed to be greater than the number of clocks expected during the AMI_GetWave call. The clock times are exactly bit_time/2 before the input data signal is sampled. The DLL will return non-negative clock_times values, and place -1 after the last valid clock tick in the clock_times vector during each AMI_GetWave call. If there are no valid clock ticks for the duration of a AMI_GetWave call a single entry of -1 will be returned in the clock_times vector.

The clock ticks represented by clock times should be strictly monotonic, both within the clock_times vector returned from a single call to AMI_GetWave and between successive calls to AMI_GetWave. That is, within a given clock_times vector each successive valid value is greater than the value that preceded it, and the first valid value from a given call to AMI_GetWave must be greater than the last valid value from the preceding call to AMI_GetWave. Any non-strict-monotonic behavior of clock times (including two identical values) should be considered by EDA platform as a DLL failure.

Each valid value in the clock_times vector shall be used to sample the output waveform by adding to it bit_time/2, regardless whether that waveform sample occurs in the waveform segment being returned by the current call to AMI_GetWave, or in the waveform segment to be returned by the next AMI_GetWave call. Care should be taken in implementation of clock_times to insure that the calculations used always maintain full double-precision floating point accuracy across multi-million bit simulations.

Although clock_times will generally be related to the UI interval for the primary SerDes channel being simulated, there is no requirement that there be any relationship between the clock ticks generated by clock_times and the actual waveform returned in the primary channel. It is possible for the CDR to go out of lock, resulting in clock ticks that have no definite relationship to the output wave. It is possible for the CDR to be suppressed for an undefined number of bits until the output of the 1st clock tick. In the case of a receiver without a CDR, it is possible for only -1 to ever be output during all AMI_GetWave calls.

~~of the simulation (the first AMI_GetWave call). The time is always greater or equal to zero. The last clock is indicated by putting a value of -1 at the end of clocks for the current wave sample. The clock_time vector is allocated by the EDA platform and is guaranteed to be greater than the number of clocks expected during the AMI_GetWave call. The clock times are the times at which clock signal at the output of the clock recovery loop crosses the logic threshold. It is to be assumed that the input data signal is sampled at exactly one half clock period after a clock time.~~

3.2.2.4 AMI_parameters_out

The AMI_parameters_out argument is a pointer to a string pointer. Memory for the string is allocated and de-allocated by the algorithmic model. The model returns a pointer to the string as the contents of this argument. The string must be formatted as a parameter tree, as described in 3.1.2.6. The AMI_GetWave function may use this string to return parameters to the EDA platform.

While the AMI_parameters_out argument must always be present in the

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AMI_GetWave function call and the EDA platform must always provide a valid (non-zero) address value in it, algorithmic models are not required to return anything at that address to the EDA platform. For this reason, the EDA platform must also initialize the memory content at that address to zero (null pointer) prior to calling the AMI_GetWave function, so that after the execution of the function it can determine whether or not the function returned a valid string pointer at that address. If the AMI_GetWave function does not have any parameters to return to the EDA platform, it must return a pointer at the address provided in this argument to a string which contains nothing but the root name. Note that the root name must always be included in the string.

~~3.2.2.4 AMI_parameters_out (optional)~~

~~A handle to a 'tree string' as described in 1.3.1.2.6. This is used by the algorithmic model to return dynamic information and parameters. The memory for this string is to be allocated and deleted by the algorithmic model.~~

3.2.2.5 AMI_memory

This is the memory which was allocated during the init call.

3.2.2.6 Return Value

1 for success
0 for failure

3.3 AMI_Close

3.3.1 Declaration

```
long AMI_Close(void * AMI_memory);
```

3.3.2 Arguments

3.3.2.1 AMI_memory

Same as for AMI_GetWave. See section 3.2.2.5.

3.3.3 Return Value

1 for success
0 for failure

4 CODE SEGMENT EXAMPLES

```
extern long AMI_GetWave (wave, wave_size, clock_times, AMI_parameters_out,  
AMI_memory);  
extern long AMI_GetWave (wave, wave_size, clock_times, AMI_memory);  
  
my_space = AMI_memory;  
  
clk_idx=0;  
time = my_space->prev_time + my_space->sample_interval;  
for(i=0; i<wave_size; i++)  
{  
    wave = filterandmodify(wave, my_space);  
    if (clock_times && found_clock (my_space, time))  
        clock_times[clk_idx++] = getclocktime (my_space, time);  
    time += my_space->sample_interval;  
}  
clock_times[clk_idx] = -1; //terminate the clock vector  
Return 1;  
  
=====
```

=====
=====
Section 11

E M I P A R A M E T E R S
=====
=====

There are two sections here: one for a [Component] and one for a [Model].
=====

This section describes the structure of the EMI parameters under a top-level [Component] keyword. It is used to describe the EMI parameters associated with a [Component]. The parameters must be surrounded by the [Begin EMI Component] and [End EMI Component] keywords.

The following set of keywords are defined:

[Begin EMI Component]
[End EMI Component]
[Pin EMI]
[Pin Domain EMI]

The following set of subparameters are defined:

Domain
Cpd
C_Heatsink_gnd
C_Heatsink_float

=====
Keyword: [Begin EMI Component]
Required: No
Description: Marks the beginning of the Component EMI parameters.
Sub-Params: Domain, Cpd, C_Heatsink_gnd, C_Heatsink_float

Domain indicates whether the component is a digital, analog or part digital part analog. Analog circuits are more susceptible to low-level noise. Analog circuits operate at very low signal levels (mV or uV) and can contain high gain amplifiers. In contrast, digital circuits operate at relatively large signal levels (compared to analog circuits).

The syntax for Domain is:
Domain Domain_value

Where Domain_value is an enumerated argument, and is one of:
Digital, Analog, Digital_analog

This subparameter is optional. If not entered the default is Digital.

Cpd is the power dissipation capacitance parameter.
Cpd (Power Dissipation Capacitance) is the internal parasitic capacitance (e.g., gate-to-source and gate-to-drain capacitance) plus the equivalent capacitance associated with the through currents when both transistors (n-channel and p-channel) are momentarily conducting.

It is typically for CMOS devices, and helps provide a more accurate estimation of the power bus current, and therefore the noise voltage on the power bus. Knowing the high frequency noise on the power bus (due to switching of digital circuits) the radiation can be calculated.

Sometimes Iccd (Dynamic power supply current) is found in databooks. It is normally given for FACT families. Iccd is specified in units of mA/MHz.

Cpd can be calculated from Iccd by the equation
$$\text{Cpd (nF)} = \text{Iccd (mA/MHz)} / \text{Vcc (V)}.$$

The syntax for Cpd is:
Cpd = capacitance_value

The units of capacitance_value are Farads.

This subparameter is optional. If not entered the default is 0.0F.

C_Heatsink_Float and C_Heatsink_Gnd define the heatsink capacitance and connection conditions.
C_Heatsink_Float indicates that the heatsink is floating, and C_Heatsink_Gnd indicates that the heatsink is grounded.

Internal currents inside a (high speed) IC can be closely coupled onto a heatsink. As the heatsink is physically much larger than the IC silicon chip and bond wires it is a more efficient radiator. Knowing the capacitance of the heatsink the radiated electric field can be estimated.

Only one of these subparameters can be defined. It is not legal to define both. It is legal to omit both. In this case it means that a heatsink is not present.

The subparameter takes one argument: the heatsink capacitance

The syntax for Heatsink_cap is:
C_Heatsink_float = capacitance_value
C_Heatsink_gnd = capacitance_value

The units for capacitance_value are Farads.

This subparameter is optional. If not entered the default is that the component does not have a heatsink.

```

=====
Keyword: [End EMI Component]
Required: No
Description: Marks the end of the Component EMI parameters.
-----
Example:

[Begin EMI Component]
Domain      Digital
Cpd         = 6.4pF
C_Heatsink_gnd = 3.4pF
[End EMI Component]

=====
Keyword: [Pin EMI]
Required: No
Description: Specifies the EMI parameters for a Pin.
Sub-Params: domain_name, clock_div
Usage Rules: Each line must contain three columns.
              The first column must contain the pin name. This pin name
              must match a pin name in the [Pin] keyword. (The pin name
              is the first column in the [Pin] record.)

              The second column is the domain name. This specifies the
              clock domain for that pin. This is used by [Pin Domain EMI].
              The field should be set to NA if unused.

              The default for domain_name is that the percentage of power
              used is 100%.

              The third column is the clock division. This is the ratio
              of the frequency at this pin to the reference pin. The
              reference pin is always set to "1.0". The ratio is a
              floating point number. The choice of the reference in does
              not matter as this information is pin to pin ratios. It is
              suggested that the pin with the maximum frequency is chosen
              as the reference.

              The field should be set to NA if unused.

              The default for clock_div is 1.0

              Column length limits are:
                pin_name      5 characters max
                domain_name   20 characters max
                clock_div     5 characters max

              It is not a requirement to specify every pin. An undefined
              pin will default to 100% power usage for Domain_name,
              and 1.0 for clock_div.
=====

```

```

=====
Keyword: [Pin Domain EMI]
Required: No
Description: Specifies the percentage of power used in each clock domain.
Sub-Params: percentage
Usage Rules: Each line must contain two columns.
              The first column must contain the domain_name. This name
              must match a domain name in the [Pin EMI] keyword. (The
              domain name is the second column in that record.)

              The percentage represents a user definable percentage of the
              power used by that domain. It is an integer in the range
              0 < percentage =< 100

              Column length limits are:
                domain_name 20 characters max
                percentage  5 characters max
=====
Example:

[Begin EMI Component]
Domain      Digital
Cpd         = 6.4pF
|
[Pin EMI]   domain_name  clock_div
4          MEM          0.5
5          MEM          0.5
7          NA           0.5      | domain_name defaults to 100%
8          RIOG         NA       | clock_div defaults to 1.0
14         CPU          1.0
15         RIOG         0.5
|
[Pin Domain EMI]  percentage
CPU              40
MEM              30
RIOG             30
|
[End EMI Component]
=====
=====

```

```
=====
=====
This section describes the structure of the EMI parameters under a
top-level [Model] keyword. It is used to describe the EMI parameters
associated with a [Model]. The parameters must be surrounded by
the [Begin EMI Model] and [End EMI Model] keywords.
```

The following ~~set of~~ keywords are defined:

```
[Begin EMI Model]
[End EMI Model]
```

The following ~~set of~~ subparameters are defined:

```
Model_emi_type
Model_Domain
```

```
=====
Keyword: [Begin EMI Model]
Required: No
Description: Marks the beginning of the Model EMI parameters.
Sub-Params: Model_emi_type, Domain
```

Model_emi_type indicates whether the model (for this pin) is a ferrite or not.

The syntax for Model_emi_type is:
Model_emi_type Model_emi_type_value

Where Model_emi_type_value is an enumerated argument, and is one of:

Ferrite, Not_a_ferrite

If not entered (the default) the model is Not_a_ferrite.

Model_Domain indicates whether the model is digital or analog. This is only used if the [Component EMI] Domain is set to Digital_analog. If the [Component EMI] Domain is set to anything else Model_Domain is ignored.

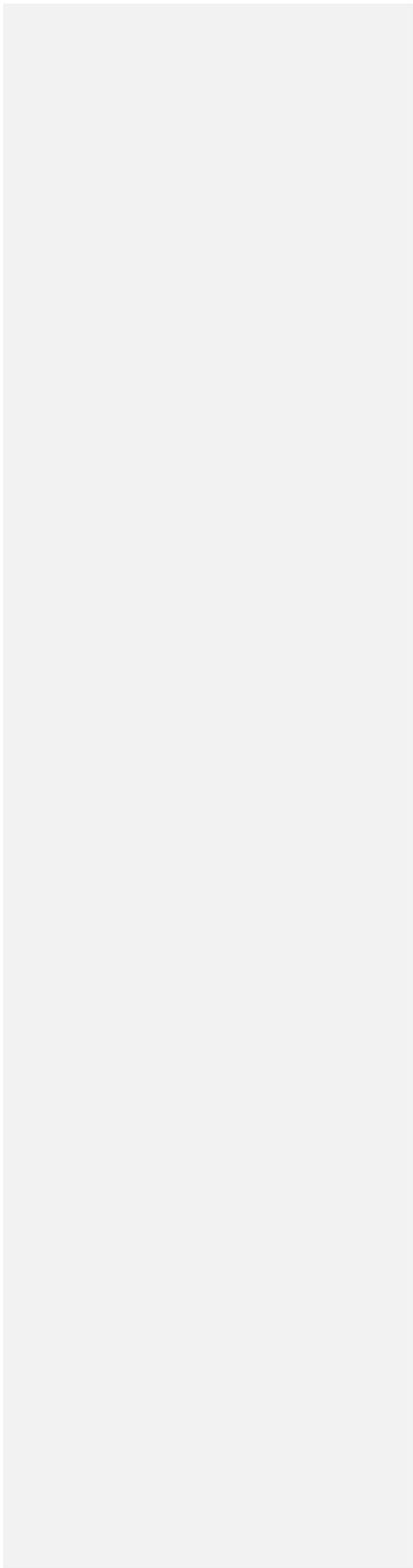
The syntax for Domain is:
Model_Domain Domain_value

Where Domain_value is one of:
Digital, Analog

If not entered the default is to use the [Component EMI] Domain setting and it's default.

```
=====
```

```
=====
| Keyword: [End EMI Model]
| Required: No
| Description: Marks the end of the Model EMI parameters.
|-----
| Example:
|
| [Begin EMI Model]
| Domain          Analog
| Model_emi_type  Ferrite
| [End EMI Model]
|
|=====
|=====
```



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